



# SILEGO

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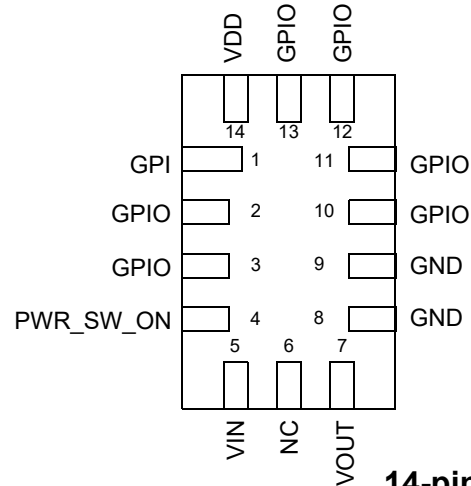
### General Description

The SLG46116 GreenPAK combines the functionality and versatility of a GreenPAK Programmable Mixed-signal Matrix with the capabilities of Silego's CuFET technology. Capable of integrating a number common discrete ICs and passive components into a single device, the GreenPAK family's SLG46116V enables high power switching with a soft-start 1.25 A P-Ch MOSFET with slew rate control.

### Features

- Logic & Mixed Signal Circuits
- Highly Versatile Macrocells
- Read Back Protection (Read Lock)
- 1.8V ( $\pm 5\%$ ) to 5V ( $\pm 10\%$ ) Supply
- Operating Temperature Range  $-40\text{ }^{\circ}\text{C}$  to  $85\text{ }^{\circ}\text{C}$
- Soft-Start 1.25 A P-FET Power Switch
- Package
  - 1.6 x 2.5 x 0.55 mm STQFN 14L package
  - Pb-Free / Halogen-Free / RoHS compliant

### Pin Configuration

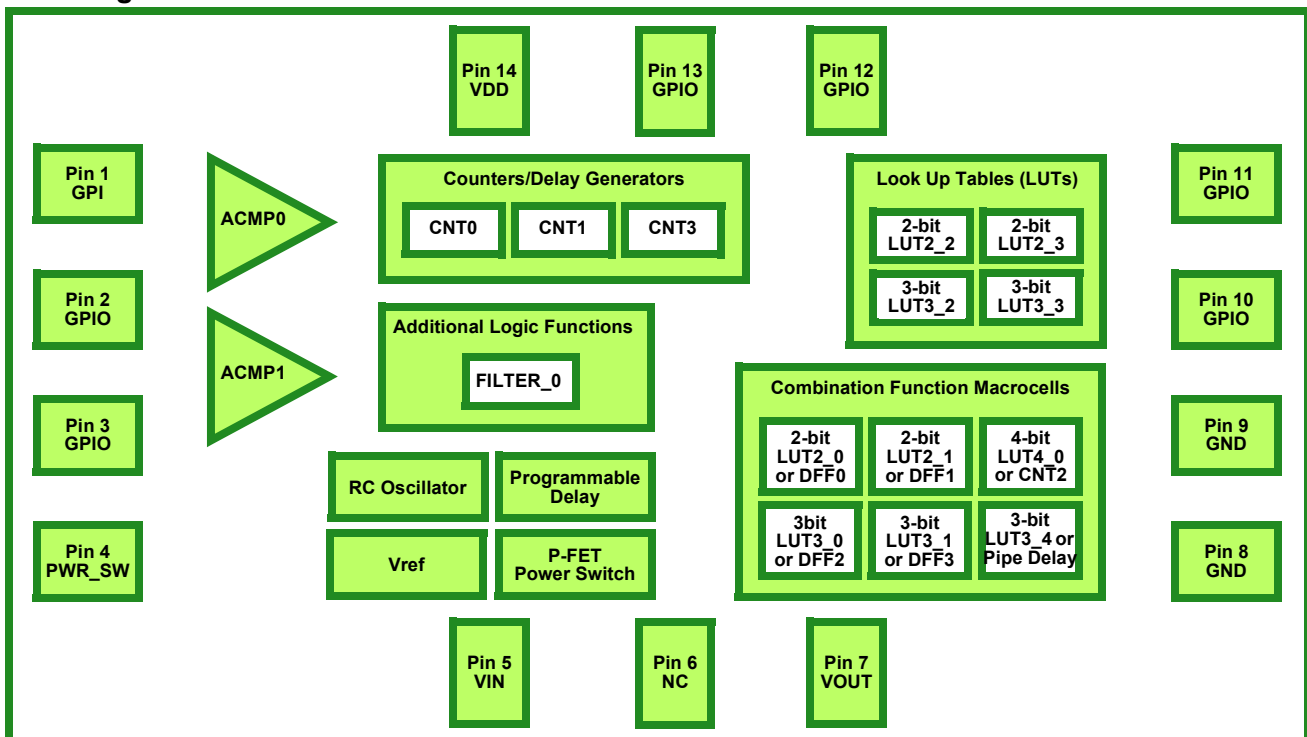


**14-pin STQFN**  
(Top View)

### Applications

- Power Sequencing with complex analog control
- Power Plane component size reduction project
- LED Driver
- Haptic Motor Driver
- System RESET with Power Switch

### Block Diagram





## 1.0 Overview

The SLG46116 provides a small, low power component for commonly used mixed-signal functions. The user creates their circuit design by programming the one time Non-Volatile Memory (NVM) to configure the interconnect logic, the I/O Pins and the macrocells of the SLG46116. This highly versatile device allows a wide variety of mixed-signal functions to be designed within a very small, low power single integrated circuit. The SLG46116 includes the following:

- Two Analog Comparators (ACMP)
- Voltage References (Vref)
- Four Combinatorial Look Up Tables (LUTs)
  - Two 2-bit LUTs
  - Two 3-bit LUTs
- Seven Combination Function Macrocell
  - Two Selectable DFF/Latch or 2-bit LUTs
  - Two Selectable DFF/Latch or 3-bit LUTs
  - One Selectable Pipe Delay or 3-bit LUT
    - Pipe Delay – 8 stage / 2 output
  - One Selectable Counter/Delay or 4-bit LUT
  - One Programmable Delay/ Deglitch Filter
- Three Counter / Delay Generators (CNT/DLY)
  - Three 8-bit counter/delays with external clock/reset
- Four D Flip-Flop / Latches (DFF) (Part of Combination Function Macrocell)
- Pipe Delay – 8 stage/2 output (Part of Combination Function Macrocell)
- Trimmed RC Oscillator (RC OSC)
- Power On Reset (POR)
- One Bandgap
- Soft-Start P-FET Power Switch
  - Power Switch IDS: 1.25 A
  - Slew Rate Control
  - VIN: 1.5 V to 5.5 V
  - Low RDSON
    - 28.5 mΩ @ 5.0 V
    - 36.4 mΩ @ 3.3 V
    - 44.3 mΩ @ 2.5 V
    - 60.8 mΩ @ 1.8 V
    - 77.6 mΩ @ 1.5 V



## 2.0 Pin Description

### 2.1 Functional Pin Description

| Pin # | Pin Name  | Function                                       |
|-------|-----------|--|
| 1     | GPI       | General Purpose Input                          |
| 2     | GPIO      | General Purpose I/O or Analog Comparator 0 (+) |
| 3     | GPIO      | General Purpose I/O or Analog Comparator 0 (-) |
| 4     | PWR_SW_ON | Input/Output                                   |
| 5     | VIN       | P-FET Power Switch Input                       |
| 6     | NC        | No Connect                                     |
| 7     | VOUT      | P-FET Power Switch Output                      |
| 8     | GND       | Ground   |
| 9     | GND       | Ground   |
| 10    | GPIO      | General Purpose I/O                            |
| 11    | GPIO      | General Purpose I/O or POR Output              |
| 12    | GPIO      | General Purpose I/O with OE and Vref output    |
| 13    | GPIO      | General Purpose I/O or External Clock Input    |
| 14    | VDD       | Power Supply                                   |



### 3.0 User Programmability

Non-volatile memory (NVM) is used to configure the SLG46116's connection matrix routing and macrocells. The NVM is One-Time-Programmable (OTP). However, Silego's GreenPAK development tools can be used to configure the connection matrix and macrocells, without programming the NVM, to allow on-chip emulation. This configuration will remain active on the device as long as it remains powered and can be re-written as needed to facilitate rapid design changes.

When a design is ready for in-circuit testing, the same GreenPAK development tools can be used to program the NVM and create samples for small quantity builds. Once the NVM is programmed, the device will retain this configuration for the duration of its lifetime.

Once the design is finalized, the design file can be forwarded to Silego to integrate into the production process.

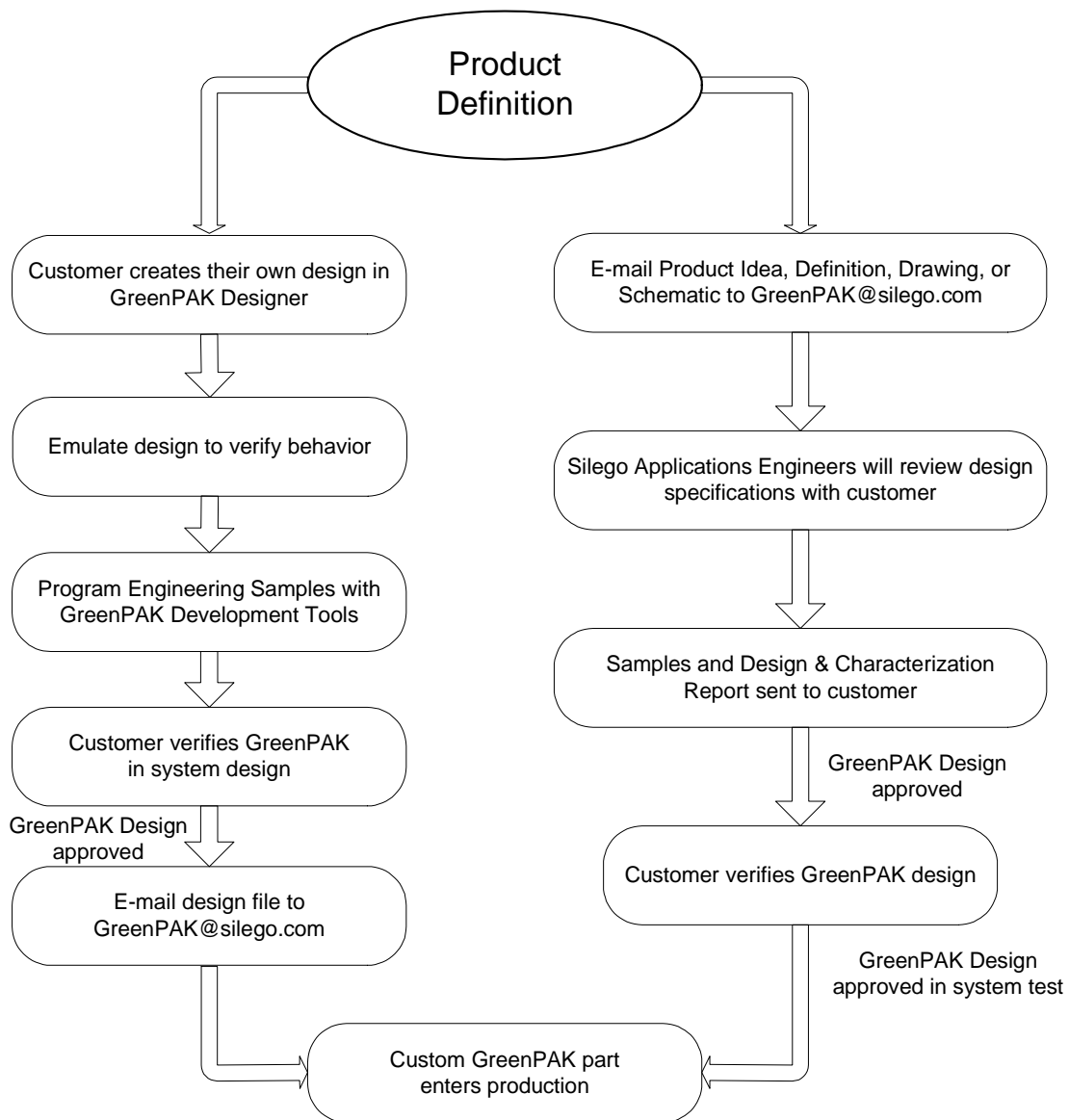


Figure 1. Steps to create a custom Silego GreenPAK device



**4.0 Ordering Information**

| Part Number | Type                                 |
|-------------|--------------------------------------|
| SLG46116V   | STQFN 14L                            |
| SLG46116VTR | STQFN 14L - Tape and Reel (3k units) |



## 5.0 Electrical Specifications

### 5.1 Absolute Maximum Conditions

| Parameter                                   | Condition                                | Min.      | Max.      | Unit |
|---|--|-----------|-----------|------|
| Supply voltage on VDD relative to GND       |  | -0.5      | 7         | V    |
| DC Input voltage                            |  | GND - 0.5 | VDD + 0.5 | V    |
| Maximum Average or DC Current (Through pin) | Push-Pull 1x                             | --        | 12        | mA   |
|   | Push-Pull 2x                             | --        | 17        |      |
|   | OD 1x                                    | --        | 18        |      |
|   | OD 2x                                    | --        | 28        |      |
| Current at Input Pin                        |  | -1.0      | 1.0       | mA   |
| Storage Temperature Range                   |  | -65       | 150       | °C   |
| Junction Temperature                        |  | --        | 150       | °C   |
| ESD Protection (Human Body Model)           |  | 2000      | --        | V    |
| ESD Protection (Charged Device Model)       |  | 1000      | --        | V    |
| Moisture Sensitivity Level                  |  | 1         |           |      |
| P-FET Power Switch $IDS_{PK}$               | For no more than 1 ms with 1% duty cycle | --        | 1.5       | A    |

### 5.2 Electrical Characteristics (1.8V ±5% V<sub>DD</sub>)

| Symbol           | Parameter                  | Condition/Note   | Min.  | Typ.  | Max.            | Unit |
|------------------|----------------------------|--|-------|-------|-----------------|------|
| V <sub>DD</sub>  | Supply Voltage             |  | 1.71  | 1.80  | 1.89            | V    |
| I <sub>Q</sub>   | Quiescent Current          | Static Inputs and Outputs                                  | --    | 0.5   | --              | µA   |
| T <sub>A</sub>   | Operating Temperature      |  | -40   | 25    | 85              | °C   |
| V <sub>PP</sub>  | Programming Voltage        |  | 7.25  | 7.50  | 7.75            | V    |
| V <sub>AIR</sub> | Analog Input Voltage Range | Positive Input   | 0     | --    | V <sub>DD</sub> | V    |
|                  |                            | Negative Input   | 0     | --    | 1.1             | V    |
| V <sub>IH</sub>  | HIGH-Level Input Voltage   | Logic Input  | 1.100 | --    | V <sub>DD</sub> | V    |
|                  |                            | Logic Input with Schmitt Trigger                           | 1.270 | --    | V <sub>DD</sub> | V    |
|                  |                            | Low-Level Logic Input                                      | 0.980 | --    | V <sub>DD</sub> | V    |
| V <sub>IL</sub>  | LOW-Level Input Voltage    | Logic Input  | --    | --    | 0.690           | V    |
|                  |                            | Logic Input with Schmitt Trigger                           | --    | --    | 0.440           | V    |
|                  |                            | Low-Level Logic Input                                      | --    | --    | 0.520           | V    |
| I <sub>IH</sub>  | HIGH-Level Input Current   | Logic Input Pins; V <sub>IN</sub> = 1.8 V                  | -1.0  | --    | 1.0             | µA   |
| I <sub>IL</sub>  | LOW-Level Input Current    | Logic Input Pins; V <sub>IN</sub> = 0 V                    | -1.0  | --    | 1.0             | µA   |
| V <sub>OH</sub>  | HIGH-Level Output Voltage  | Push-Pull 1X, Open Drain PMOS 1X, I <sub>OH</sub> = 100 µA | 1.680 | 1.790 | --              | V    |
|                  |                            | Push-Pull 2X, Open Drain PMOS 2X, I <sub>OH</sub> = 100 µA | 1.702 | 1.800 | --              | V    |



| Symbol              | Parameter   | Condition/Note   | Min.  | Typ.  | Max.  | Unit |
|---------------------|---|--|-------|-------|-------|------|
| V <sub>OL</sub>     | LOW-Level Output Voltage  | Push-Pull 1X,<br>I <sub>OL</sub> = 100 μA                                    | --    | 0.020 | 0.030 | V    |
|                     |   | Push-Pull 2X,<br>I <sub>OL</sub> = 100 μA                                    | --    | 0.010 | 0.020 | V    |
|                     |   | Open Drain NMOS 1X,<br>I <sub>OL</sub> = 100 μA                              | --    | 0.010 | 0.020 | V    |
|                     |   | Open Drain NMOS 2X,<br>I <sub>OL</sub> = 100 μA                              | --    | 0.010 | 0.010 | V    |
| I <sub>OH</sub>     | HIGH-Level Output Current<br>(see Note 1)                                       | Push-Pull 1X, Open Drain PMOS 1X,<br>V <sub>OH</sub> = V <sub>DD</sub> - 0.2 | 1.040 | 1.400 | --    | mA   |
|                     |   | Push-Pull 2X, Open Drain PMOS 2X,<br>V <sub>OH</sub> = V <sub>DD</sub> - 0.2 | 2.150 | 2.710 | --    | mA   |
| I <sub>OL</sub>     | LOW-Level Output Current<br>(see Note 1)  | Push-Pull 1X,<br>V <sub>OL</sub> = 0.15 V                                    | 0.760 | 1.340 | --    | mA   |
|                     |   | Push-Pull 2X,<br>V <sub>OL</sub> = 0.15 V                                    | 1.520 | 2.660 | --    | mA   |
|                     |   | Open Drain NMOS 1X,<br>V <sub>OL</sub> = 0.15 V                              | 1.530 | 2.670 | --    | mA   |
|                     |   | Open Drain NMOS 2X,<br>V <sub>OL</sub> = 0.15 V                              | 3.060 | 5.130 | --    | mA   |
| I <sub>VDD</sub>    | Maximum Average or DC<br>Current Through VDD Pin<br>(Per chip side, see Note 2) | T <sub>J</sub> = 85°C  | --    | --    | 73    | mA   |
|                     |   | T <sub>J</sub> = 110°C   | --    | --    | 35    | mA   |
| I <sub>GND</sub>    | Maximum Average or DC<br>Current Through GND Pin<br>(Per chip side, see Note 2) | T <sub>J</sub> = 85°C  | --    | --    | 92    | mA   |
|                     |   | T <sub>J</sub> = 110°C   | --    | --    | 44    | mA   |
| T <sub>SU</sub>     | Startup Time  | from VDD rising past 1.35 V  | --    | 0.27  | --    | ms   |
| PON <sub>THR</sub>  | Power On Threshold  | V <sub>DD</sub> Level Required to Start Up the Chip                          | 1.182 | 1.346 | 1.505 | V    |
| POFF <sub>THR</sub> | Power Off Threshold   | V <sub>DD</sub> Level Required to Switch Off the Chip                        | 0.752 | 0.918 | 1.110 | V    |
| V <sub>IN</sub>     | Power Switch Input Voltage  | -40 °C to 85 °C  | 1.5   | --    | 5.0   | V    |
| I <sub>IN</sub>     | Power Switch Current (PIN 5)  | when Off, V <sub>IN</sub> = 5.0 V  | --    | 0.02  | 0.1   | μA   |
|                     |   | when PWR_SW_ON = V <sub>IN</sub> , No load                                   | --    | 0.05  | 0.5   | μA   |
| I <sub>DS_LKG</sub> | Leakage Measured from<br>PIN 5 to PIN 7   | when Off, V <sub>IN</sub> = 5.0 V  | --    | 0.05  | 1     | μA   |
| I <sub>ON_LKG</sub> | PWR_SW_ON Pin Input<br>Leakage  |  | --    | --    | 0.1   | μA   |
| RDS <sub>ON</sub>   | Static Drain to Source<br>ON Resistance @ T <sub>A</sub> 25°C                   | @ V <sub>IN</sub> = 5.5 V  | --    | 28.5  | 32.0  | mΩ   |
|                     |   | @ V <sub>IN</sub> = 3.3 V  | --    | 36.4  | 40.0  | mΩ   |
|                     |   | @ V <sub>IN</sub> = 2.5 V  | --    | 44.3  | 49.0  | mΩ   |
|                     |   | @ V <sub>IN</sub> = 1.8 V  | --    | 60.8  | 65.0  | mΩ   |
|                     |   | @ V <sub>IN</sub> = 1.5 V  | --    | 77.6  | 82.0  | mΩ   |





| Symbol                    | Parameter  | Condition/Note   | Min. | Typ. | Max.                               | Unit |
|---------------------------|--|--|------|------|------------------------------------|------|
| RDS <sub>ON</sub>         | Static Drain to Source ON Resistance @ T <sub>A</sub> 85°C | @ V <sub>IN</sub> = 5.5 V  | --   | 34.0 | 36.0                               | mΩ   |
|                           |  | @ V <sub>IN</sub> = 3.3 V  | --   | 43.8 | 46.0                               | mΩ   |
|                           |  | @ V <sub>IN</sub> = 2.5 V  | --   | 53.3 | 56.0                               | mΩ   |
|                           |  | @ V <sub>IN</sub> = 1.8 V  | --   | 72.2 | 76.0                               | mΩ   |
|                           |  | @ V <sub>IN</sub> = 1.5 V  | --   | 90.7 | 94.0                               | mΩ   |
| IDS                       | Operating Current  | V <sub>IN</sub> = 1.5 V to 5.0 V   | --   | --   | 1.25                               | A    |
| T <sub>On_Delay</sub>     | PWR_SW_ON pin Delay Time                                   | 50% PWR_SW_ON to Ramp Begin, V <sub>IN</sub> = 5 V, V <sub>OUT_Cap</sub> = 0.1 μF, R <sub>L</sub> = 10 Ω                     | 12.0 | 15.0 | 18.5                               | μs   |
|                           |  | 50% PWR_SW_ON to Ramp Begin, V <sub>IN</sub> = 3.3 V, V <sub>OUT_Cap</sub> = 0.1 μF, R <sub>L</sub> = 10 Ω                   | 17.0 | 22.0 | 30.0                               | μs   |
|                           |  | 50% PWR_SW_ON to Ramp Begin, V <sub>IN</sub> = 1.5 V, V <sub>OUT_Cap</sub> = 0.1 μF, R <sub>L</sub> = 10 Ω                   | 44.0 | 55.0 | 76.0                               | μs   |
| T <sub>Total_On</sub>     | Total Turn On Time   | 50% PWR_SW_ON to 90% V <sub>OUT</sub> , V <sub>IN</sub> = 5 V, V <sub>OUT_Cap</sub> = 0.1 μF, R <sub>L</sub> = 10 Ω          | 114  | 122  | 134                                | μs   |
|                           |  | 50% PWR_SW_ON to 90% V <sub>OUT</sub> , V <sub>IN</sub> = 3.3 V, V <sub>OUT_Cap</sub> = 0.1 μF, R <sub>L</sub> = 10 Ω        | 146  | 156  | 176                                | μs   |
|                           |  | 50% PWR_SW_ON to 90% V <sub>OUT</sub> , V <sub>IN</sub> = 1.5 V, V <sub>OUT_Cap</sub> = 0.1 μF, R <sub>L</sub> = 10 Ω        | 292  | 332  | 399                                | μs   |
| T <sub>RISE</sub>         | Rise Time  | 10% V <sub>OUT</sub> to 90% V <sub>OUT</sub> , V <sub>IN</sub> = 5.0 V, V <sub>OUT_Cap</sub> = 0.1 μF, R <sub>L</sub> = 10 Ω | 92   | 97   | 107                                | μs   |
|                           |  | 10% V <sub>OUT</sub> to 90% V <sub>OUT</sub> , V <sub>IN</sub> = 3.3 V, V <sub>OUT_Cap</sub> = 0.1 μF, R <sub>L</sub> = 10 Ω | 116  | 120  | 131                                | μs   |
|                           |  | 10% V <sub>OUT</sub> to 90% V <sub>OUT</sub> , V <sub>IN</sub> = 1.5 V, V <sub>OUT_Cap</sub> = 0.1 μF, R <sub>L</sub> = 10 Ω | 228  | 253  | 296                                | μs   |
| PWR_SW_ON_V <sub>IH</sub> | Initial Turn On Voltage                                    |  | 0.85 | --   | V <sub>IN</sub> or V <sub>DD</sub> | V    |
| PWR_SW_ON_V <sub>IL</sub> | Low Input Voltage on PWR_SW_ON pin                         |  | -0.3 | 0    | 0.3                                | V    |
| T <sub>Delay_Off</sub>    | Off Delay Time   | 50% PWR_SW_ON to V <sub>OUT</sub> Fall, V <sub>IN</sub> = 5 V, R <sub>L</sub> = 10 Ω   | 6.2  | 6.5  | 7.0                                | μs   |

Note 1: DC or average current through any pin should not exceed value given in Absolute Maximum Conditions.  
 Note 2: The GreenPAK's power rails are divided in two sides. Pins 1, 2 and 3 are connected to one side, pins 10, 11, 12 and 13 to another.



### 5.3 Electrical Characteristics (3.3V ±10% V<sub>DD</sub>)

| Symbol           | Parameter   | Condition/Note  | Min.   | Typ.   | Max.            | Unit |
|------------------|---|---|--------|--------|-----------------|------|
| V <sub>DD</sub>  | Supply Voltage  |   | 3.0    | 3.3    | 3.6             | V    |
| I <sub>Q</sub>   | Quiescent Current   | Static Inputs and Outputs                                 | --     | 0.75   | --              | μA   |
| T <sub>A</sub>   | Operating Temperature   |   | -40    | 25     | 85              | °C   |
| V <sub>PP</sub>  | Programming Voltage   |   | 7.25   | 7.50   | 7.75            | V    |
| V <sub>AIR</sub> | Analog Input Voltage Range  | Positive Input  | 0      | --     | V <sub>DD</sub> | V    |
|                  |   | Negative Input  | 0      | --     | 1.2             | V    |
| V <sub>IH</sub>  | HIGH-Level Input Voltage  | Logic Input   | 1.780  | --     | V <sub>DD</sub> | V    |
|                  |   | Logic Input with Schmitt Trigger                          | 2.130  | --     | V <sub>DD</sub> | V    |
|                  |   | Low-Level Logic Input                                     | 1.130  | --     | V <sub>DD</sub> | V    |
| V <sub>IL</sub>  | LOW-Level Input Voltage   | Logic Input   | --     | --     | 1.210           | V    |
|                  |   | Logic Input with Schmitt Trigger                          | --     | --     | 0.950           | V    |
|                  |   | Low-Level Logic Input                                     | --     | --     | 0.690           | V    |
| I <sub>IH</sub>  | HIGH-Level Input Current  | Logic Input Pins; V <sub>IN</sub> = 3.3 V                 | -1.0   | --     | 1.0             | μA   |
| I <sub>IL</sub>  | LOW-Level Input Current   | Logic Input Pins; V <sub>IN</sub> = 0 V                   | -1.0   | --     | 1.0             | μA   |
| V <sub>OH</sub>  | HIGH-Level Output Voltage   | Push-Pull 1X, Open Drain PMOS 1X, I <sub>OH</sub> = 3 mA  | 2.710  | 3.090  | --              | V    |
|                  |   | Push-Pull 2X, Open Drain PMOS 2X, I <sub>OH</sub> = 3 mA  | 2.870  | 3.190  | --              | V    |
| V <sub>OL</sub>  | LOW-Level Output Voltage  | Push-Pull 1X, I <sub>OL</sub> = 3 mA                      | --     | 0.180  | 0.280           | V    |
|                  |   | Push-Pull 2X, I <sub>OL</sub> = 3 mA                      | --     | 0.090  | 0.130           | V    |
|                  |   | Open Drain NMOS 1X, I <sub>OL</sub> = 3 mA                | --     | 0.090  | 0.130           | V    |
|                  |   | Open Drain NMOS 2X, I <sub>OL</sub> = 3 mA                | --     | 0.050  | 0.070           | V    |
| I <sub>OH</sub>  | HIGH-Level Output Current (see Note 1)                                    | Push-Pull 1X, Open Drain PMOS 1X, V <sub>OH</sub> = 2.4 V | 5.830  | 10.180 | --              | mA   |
|                  |   | Push-Pull 2X, Open Drain PMOS 2X, V <sub>OH</sub> = 2.4 V | 11.264 | 19.660 | --              | mA   |
| I <sub>OL</sub>  | LOW-Level Output Current (see Note 1)                                     | Push-Pull 1X, V <sub>OL</sub> = 0.4 V                     | 4.060  | 6.440  | --              | mA   |
|                  |   | Push-Pull 2X, V <sub>OL</sub> = 0.4 V                     | 8.130  | 12.360 | --              | mA   |
|                  |   | Open Drain NMOS 1X, V <sub>OL</sub> = 0.4 V               | 8.130  | 12.410 | --              | mA   |
|                  |   | Open Drain NMOS 2X, V <sub>OL</sub> = 0.4 V               | 16.260 | 22.900 | --              | mA   |
| I <sub>VDD</sub> | Maximum Average or DC Current Through VDD Pin (Per chip side, see Note 2) | T <sub>J</sub> = 85°C                                     | --     | --     | 73              | mA   |
|                  |   | T <sub>J</sub> = 110°C                                    | --     | --     | 35              | mA   |
| I <sub>GND</sub> | Maximum Average or DC Current Through GND Pin (Per chip side, see Note 2) | T <sub>J</sub> = 85°C                                     | --     | --     | 92              | mA   |
|                  |   | T <sub>J</sub> = 110°C                                    | --     | --     | 44              | mA   |
| T <sub>SU</sub>  | Startup Time  | from VDD rising past 1.35 V                               | --     | 0.27   | -               | ms   |



| Symbol                | Parameter  | Condition/Note   | Min.  | Typ.  | Max.  | Unit |
|-----------------------|--|--|-------|-------|-------|------|
| PON <sub>THR</sub>    | Power On Threshold   | V <sub>DD</sub> Level Required to Start Up the Chip  | 1.182 | 1.346 | 1.505 | V    |
| POFF <sub>THR</sub>   | Power Off Threshold  | V <sub>DD</sub> Level Required to Switch Off the Chip  | 0.752 | 0.918 | 1.110 | V    |
| V <sub>IN</sub>       | Power Switch Input Voltage                                 | -40 °C to 85 °C  | 1.5   | --    | 5.0   | V    |
| I <sub>IN</sub>       | Power Switch Current (PIN 5)                               | when Off, V <sub>IN</sub> = 5.0 V  | --    | 0.02  | 0.1   | μA   |
|                       |  | when PWR_SW_ON = V <sub>IN</sub> , No load   | --    | 0.05  | 0.5   | μA   |
| I <sub>DS_LKG</sub>   | Leakage Measured from PIN 5 to PIN 7                       | when Off, V <sub>IN</sub> = 5.0 V  | --    | 0.05  | 1     | μA   |
| I <sub>ON_LKG</sub>   | PWR_SW_ON Pin Input Leakage                                |  | --    | --    | 0.1   | μA   |
| RDS <sub>ON</sub>     | Static Drain to Source ON Resistance @ T <sub>A</sub> 25°C | @ V <sub>IN</sub> = 5.5 V  | --    | 28.5  | 32.0  | mΩ   |
|                       |  | @ V <sub>IN</sub> = 3.3 V  | --    | 36.4  | 40.0  | mΩ   |
|                       |  | @ V <sub>IN</sub> = 2.5 V  | --    | 44.3  | 49.0  | mΩ   |
|                       |  | @ V <sub>IN</sub> = 1.8 V  | --    | 60.8  | 65.0  | mΩ   |
|                       |  | @ V <sub>IN</sub> = 1.5 V  | --    | 77.6  | 82.0  | mΩ   |
| RDS <sub>ON</sub>     | Static Drain to Source ON Resistance @ T <sub>A</sub> 85°C | @ V <sub>IN</sub> = 5.5 V  | --    | 34.0  | 36.0  | mΩ   |
|                       |  | @ V <sub>IN</sub> = 3.3 V  | --    | 43.8  | 46.0  | mΩ   |
|                       |  | @ V <sub>IN</sub> = 2.5 V  | --    | 53.3  | 56.0  | mΩ   |
|                       |  | @ V <sub>IN</sub> = 1.8 V  | --    | 72.2  | 76.0  | mΩ   |
|                       |  | @ V <sub>IN</sub> = 1.5 V  | --    | 90.7  | 94.0  | mΩ   |
| IDS                   | Operating Current  | V <sub>IN</sub> = 1.5 V to 5.0 V   | --    | --    | 1.25  | A    |
| T <sub>On_Delay</sub> | PWR_SW_ON pin Delay Time                                   | 50% PWR_SW_ON to Ramp Begin, V <sub>IN</sub> = 5 V, V <sub>OUT_Cap</sub> = 0.1 μF, R <sub>L</sub> = 10 Ω                     | 12.0  | 15.0  | 18.5  | μs   |
|                       |  | 50% PWR_SW_ON to Ramp Begin, V <sub>IN</sub> = 3.3 V, V <sub>OUT_Cap</sub> = 0.1 μF, R <sub>L</sub> = 10 Ω                   | 17.0  | 22.0  | 30.0  | μs   |
|                       |  | 50% PWR_SW_ON to Ramp Begin, V <sub>IN</sub> = 1.5 V, V <sub>OUT_Cap</sub> = 0.1 μF, R <sub>L</sub> = 10 Ω                   | 44.0  | 55.0  | 76.0  | μs   |
| T <sub>Total_On</sub> | Total Turn On Time   | 50% PWR_SW_ON to 90% V <sub>OUT</sub> , V <sub>IN</sub> = 5 V, V <sub>OUT_Cap</sub> = 0.1 μF, R <sub>L</sub> = 10 Ω          | 114   | 122   | 134   | μs   |
|                       |  | 50% PWR_SW_ON to 90% V <sub>OUT</sub> , V <sub>IN</sub> = 3.3 V, V <sub>OUT_Cap</sub> = 0.1 μF, R <sub>L</sub> = 10 Ω        | 146   | 156   | 176   | μs   |
|                       |  | 50% PWR_SW_ON to 90% V <sub>OUT</sub> , V <sub>IN</sub> = 1.5 V, V <sub>OUT_Cap</sub> = 0.1 μF, R <sub>L</sub> = 10 Ω        | 292   | 332   | 399   | μs   |
| T <sub>RISE</sub>     | Rise Time  | 10% V <sub>OUT</sub> to 90% V <sub>OUT</sub> , V <sub>IN</sub> = 5.0 V, V <sub>OUT_Cap</sub> = 0.1 μF, R <sub>L</sub> = 10 Ω | 92    | 97    | 107   | μs   |
|                       |  | 10% V <sub>OUT</sub> to 90% V <sub>OUT</sub> , V <sub>IN</sub> = 3.3 V, V <sub>OUT_Cap</sub> = 0.1 μF, R <sub>L</sub> = 10 Ω | 116   | 120   | 131   | μs   |
|                       |  | 10% V <sub>OUT</sub> to 90% V <sub>OUT</sub> , V <sub>IN</sub> = 1.5 V, V <sub>OUT_Cap</sub> = 0.1 μF, R <sub>L</sub> = 10 Ω | 228   | 253   | 296   | μs   |



| Symbol                    | Parameter                          | Condition/Note  | Min. | Typ. | Max.                                  | Unit |
|---------------------------|------------------------------------|---|------|------|---------------------------------------|------|
| PWR_SW_ON_V <sub>IH</sub> | Initial Turn On Voltage            |   | 0.85 | --   | V <sub>IN</sub><br>or V <sub>DD</sub> | V    |
| PWR_SW_ON_V <sub>IL</sub> | Low Input Voltage on PWR_SW_ON pin |   | -0.3 | 0    | 0.3                                   | V    |
| T <sub>Delay_Off</sub>    | Off Delay Time                     | 50% PWR_SW_ON to VOUT Fall,<br>V <sub>IN</sub> = 5 V, R <sub>L</sub> = 10 Ω | 6.2  | 6.5  | 7.0                                   | μs   |

Note 1: DC or average current through any pin should not exceed value given in Absolute Maximum Conditions.  
Note 2: The GreenPAK's power rails are divided in two sides. Pins 1, 2 and 3 are connected to one side, pins 10, 11, 12 and 13 to another.



## 5.4 Electrical Characteristics (5V ±10% V<sub>DD</sub>)

| Symbol           | Parameter   | Condition/Note  | Min.   | Typ.   | Max.            | Unit |
|------------------|---|---|--------|--------|-----------------|------|
| V <sub>DD</sub>  | Supply Voltage  |   | 4.5    | 5.0    | 5.5             | V    |
| I <sub>Q</sub>   | Quiescent Current   | Static Inputs and Outputs                                 | --     | 1.0    | --              | μA   |
| T <sub>A</sub>   | Operating Temperature   |   | -40    | 25     | 85              | °C   |
| V <sub>PP</sub>  | Programming Voltage   |   | 7.25   | 7.50   | 7.75            | V    |
| V <sub>AIR</sub> | Analog Input Voltage Range  | Positive Input  | 0      | --     | V <sub>DD</sub> | V    |
|                  |   | Negative Input  | 0      | --     | 1.2             | V    |
| V <sub>IH</sub>  | HIGH-Level Input Voltage  | Logic Input   | 2.640  | --     | V <sub>DD</sub> | V    |
|                  |   | Logic Input with Schmitt Trigger                          | 3.160  | --     | V <sub>DD</sub> | V    |
|                  |   | Low-Level Logic Input                                     | 1.230  | --     | V <sub>DD</sub> | V    |
| V <sub>IL</sub>  | LOW-Level Input Voltage   | Logic Input   | --     | --     | 1.840           | V    |
|                  |   | Logic Input with Schmitt Trigger                          | --     | --     | 1.510           | V    |
|                  |   | Low-Level Logic Input                                     | --     | --     | 0.780           | V    |
| I <sub>IH</sub>  | HIGH-Level Input Current  | Logic Input Pins; V <sub>IN</sub> = 5 V                   | -1.0   | --     | 1.0             | μA   |
| I <sub>IL</sub>  | LOW-Level Input Current   | Logic Input Pins; V <sub>IN</sub> = 0 V                   | -1.0   | --     | 1.0             | μA   |
| V <sub>OH</sub>  | HIGH-Level Output Voltage   | Push-Pull 1X, Open Drain PMOS 1X, I <sub>OH</sub> = 5 mA  | 4.150  | 4.730  | --              | V    |
|                  |   | Push-Pull 2X, Open Drain PMOS 2X, I <sub>OH</sub> = 5 mA  | 4.300  | 4.860  | --              | V    |
| V <sub>OL</sub>  | LOW-Level Output Voltage  | Push-Pull 1X, I <sub>OL</sub> = 5 mA                      | --     | 0.230  | 0.330           | V    |
|                  |   | Push-Pull 2X, I <sub>OL</sub> = 5 mA                      | --     | 0.120  | 0.160           | V    |
|                  |   | Open Drain NMOS 1X, I <sub>OL</sub> = 5 mA                | --     | 0.120  | 0.160           | V    |
|                  |   | Open Drain NMOS 2X, I <sub>OL</sub> = 5 mA                | --     | 0.070  | 0.090           | V    |
| I <sub>OH</sub>  | HIGH-Level Output Current (see Note 1)                                    | Push-Pull 1X, Open Drain PMOS 1X, V <sub>OH</sub> = 2.4 V | 21.808 | 29.100 | --              | mA   |
|                  |   | Push-Pull 2X, Open Drain PMOS 2X, V <sub>OH</sub> = 2.4 V | 40.598 | 56.080 | --              | mA   |
| I <sub>OL</sub>  | LOW-Level Output Current (see Note 1)                                     | Push-Pull 1X, V <sub>OL</sub> = 0.4 V                     | 6.010  | 9.730  | --              | mA   |
|                  |   | Push-Pull 2X, V <sub>OL</sub> = 0.4 V                     | 11.590 | 19.460 | --              | mA   |
|                  |   | Open Drain NMOS 1X, V <sub>OL</sub> = 0.4 V               | 11.760 | 19.460 | --              | mA   |
|                  |   | Open Drain NMOS 2X, V <sub>OL</sub> = 0.4 V               | 19.120 | 35.621 | --              | mA   |
| I <sub>VDD</sub> | Maximum Average or DC Current Through VDD Pin (Per chip side, see Note 2) | T <sub>J</sub> = 85°C                                     | --     | --     | 73              | mA   |
|                  |   | T <sub>J</sub> = 110°C                                    | --     | --     | 35              | mA   |
| I <sub>GND</sub> | Maximum Average or DC Current Through GND Pin (Per chip side, see Note 2) | T <sub>J</sub> = 85°C                                     | --     | --     | 92              | mA   |
|                  |   | T <sub>J</sub> = 110°C                                    | --     | --     | 44              | mA   |
| T <sub>SU</sub>  | Startup Time  | from VDD rising past 1.35 V                               | --     | 0.27   | -               | ms   |



| Symbol                | Parameter  | Condition/Note   | Min.  | Typ.  | Max.  | Unit |
|-----------------------|--|--|-------|-------|-------|------|
| PON <sub>THR</sub>    | Power On Threshold   | V <sub>DD</sub> Level Required to Start Up the Chip  | 1.182 | 1.346 | 1.505 | V    |
| POFF <sub>THR</sub>   | Power Off Threshold  | V <sub>DD</sub> Level Required to Switch Off the Chip  | 0.752 | 0.918 | 1.110 | V    |
| V <sub>IN</sub>       | Power Switch Input Voltage                                 | -40 °C to 85 °C  | 1.5   | --    | 5.0   | V    |
| I <sub>IN</sub>       | Power Switch Current (PIN 5)                               | when Off, V <sub>IN</sub> = 5.0 V  | --    | 0.02  | 0.1   | μA   |
|                       |  | when PWR_SW_ON = V <sub>IN</sub> , No load   | --    | 0.05  | 0.5   | μA   |
| I <sub>DS_LKG</sub>   | Leakage Measured from PIN 5 to PIN 7                       | when Off, V <sub>IN</sub> = 5.0 V  | --    | 0.05  | 1     | μA   |
| I <sub>ON_LKG</sub>   | PWR_SW_ON Pin Input Leakage                                |  | --    | --    | 0.1   | μA   |
| RDS <sub>ON</sub>     | Static Drain to Source ON Resistance @ T <sub>A</sub> 25°C | @ V <sub>IN</sub> = 5.5 V  | --    | 28.5  | 32.0  | mΩ   |
|                       |  | @ V <sub>IN</sub> = 3.3 V  | --    | 36.4  | 40.0  | mΩ   |
|                       |  | @ V <sub>IN</sub> = 2.5 V  | --    | 44.3  | 49.0  | mΩ   |
|                       |  | @ V <sub>IN</sub> = 1.8 V  | --    | 60.8  | 65.0  | mΩ   |
|                       |  | @ V <sub>IN</sub> = 1.5 V  | --    | 77.6  | 82.0  | mΩ   |
| RDS <sub>ON</sub>     | Static Drain to Source ON Resistance @ T <sub>A</sub> 85°C | @ V <sub>IN</sub> = 5.5 V  | --    | 34.0  | 36.0  | mΩ   |
|                       |  | @ V <sub>IN</sub> = 3.3 V  | --    | 43.8  | 46.0  | mΩ   |
|                       |  | @ V <sub>IN</sub> = 2.5 V  | --    | 53.3  | 56.0  | mΩ   |
|                       |  | @ V <sub>IN</sub> = 1.8 V  | --    | 72.2  | 76.0  | mΩ   |
|                       |  | @ V <sub>IN</sub> = 1.5 V  | --    | 90.7  | 94.0  | mΩ   |
| IDS                   | Operating Current  | V <sub>IN</sub> = 1.5 V to 5.0 V   | --    | --    | 1.25  | A    |
| T <sub>On_Delay</sub> | PWR_SW_ON pin Delay Time                                   | 50% PWR_SW_ON to Ramp Begin<br>V <sub>IN</sub> = 5 V, V <sub>OUT_Cap</sub> = 0.1 μF,<br>R <sub>L</sub> = 10 Ω                    | 12.0  | 15.0  | 18.5  | μs   |
|                       |  | 50% PWR_SW_ON to Ramp Begin<br>V <sub>IN</sub> = 3.3 V, V <sub>OUT_Cap</sub> = 0.1 μF,<br>R <sub>L</sub> = 10 Ω                  | 17.0  | 22.0  | 30.0  | μs   |
|                       |  | 50% PWR_SW_ON to Ramp Begin<br>V <sub>IN</sub> = 1.5 V, V <sub>OUT_Cap</sub> = 0.1 μF,<br>R <sub>L</sub> = 10 Ω                  | 44.0  | 55.0  | 76.0  | μs   |
| T <sub>Total_On</sub> | Total Turn On Time   | 50% PWR_SW_ON to 90% V <sub>OUT</sub><br>V <sub>IN</sub> = 5 V, V <sub>OUT_Cap</sub> = 0.1 μF,<br>R <sub>L</sub> = 10 Ω          | 114   | 122   | 134   | μs   |
|                       |  | 50% PWR_SW_ON to 90% V <sub>OUT</sub><br>V <sub>IN</sub> = 3.3 V, V <sub>OUT_Cap</sub> = 0.1 μF,<br>R <sub>L</sub> = 10 Ω        | 146   | 156   | 176   | μs   |
|                       |  | 50% PWR_SW_ON to 90% V <sub>OUT</sub><br>V <sub>IN</sub> = 1.5 V, V <sub>OUT_Cap</sub> = 0.1 μF,<br>R <sub>L</sub> = 10 Ω        | 292   | 332   | 399   | μs   |
| T <sub>RISE</sub>     | Rise Time  | 10% V <sub>OUT</sub> to 90% V <sub>OUT</sub><br>V <sub>IN</sub> = 5.0 V, V <sub>OUT_Cap</sub> = 0.1 μF,<br>R <sub>L</sub> = 10 Ω | 92    | 97    | 107   | μs   |
|                       |  | 10% V <sub>OUT</sub> to 90% V <sub>OUT</sub><br>V <sub>IN</sub> = 3.3 V, V <sub>OUT_Cap</sub> = 0.1 μF,<br>R <sub>L</sub> = 10 Ω | 116   | 120   | 131   | μs   |
|                       |  | 10% V <sub>OUT</sub> to 90% V <sub>OUT</sub><br>V <sub>IN</sub> = 1.5 V, V <sub>OUT_Cap</sub> = 0.1 μF,<br>R <sub>L</sub> = 10 Ω | 228   | 253   | 296   | μs   |



| Symbol                    | Parameter                          | Condition/Note  | Min. | Typ. | Max.                                  | Unit |
|---------------------------|------------------------------------|---|------|------|---------------------------------------|------|
| PWR_SW_ON_V <sub>IH</sub> | Initial Turn On Voltage            |   | 0.85 | --   | V <sub>IN</sub><br>or V <sub>DD</sub> | V    |
| PWR_SW_ON_V <sub>IL</sub> | Low Input Voltage on PWR_SW_ON pin |   | -0.3 | 0    | 0.3                                   | V    |
| T <sub>Delay_Off</sub>    | Off Delay Time                     | 50% PWR_SW_ON to VOUT Fall,<br>V <sub>IN</sub> = 5 V, R <sub>L</sub> = 10 Ω | 6.2  | 6.5  | 7.0                                   | μs   |

Note 1: DC or average current through any pin should not exceed value given in Absolute Maximum Conditions.  
Note 2: The GreenPAK's power rails are divided in two sides. Pins 1, 2 and 3 are connected to one side, pins 10, 11, 12 and 13 to another.



## 5.5 IDD Estimator

Table 1. Typical Current estimated for each macrocell.

| Symbol | Parameter | Note                          | V <sub>DD</sub> = 1.8 V | V <sub>DD</sub> = 3.3V | V <sub>DD</sub> = 5.0V | Unit |
|--------|-----------|-------------------------------|-------------------------|------------------------|------------------------|------|
| I      | Current   | Chip Quiescent                | 0.5                     | 0.8                    | 1.0                    | μA   |
|        |           | Vref                          | 56.9                    | 56.9                   | 63.3                   | μA   |
|        |           | Vref Buffer (each)            | 2.7                     | 13.0                   | 13.7                   | μA   |
|        |           | OSC 25 kHz, predivide = 1     | 3.1                     | 4.8                    | 6.4                    | μA   |
|        |           | OSC 25 kHz, predivide = 8     | 3.0                     | 4.5                    | 6.0                    | μA   |
|        |           | OSC 2 MHz, predivide = 1      | 27.4                    | 45.4                   | 67.4                   | μA   |
|        |           | OSC 2 MHz, predivide = 8      | 17.5                    | 23.7                   | 29.5                   | μA   |
|        |           | 1st ACMP used (includes Vref) | 60.6                    | 62.0                   | 68.4                   | μA   |
|        |           | Each additional ACMP add      | 3.7                     | 4.9                    | 5.1                    | μA   |

## 5.6 Timing Estimator

Table 2. Typical Delay estimated for each macrocell.

| Symbol | Parameter | Note   | V <sub>DD</sub> = 1.8 V |         | V <sub>DD</sub> = 3.3V |         | V <sub>DD</sub> = 5.0V |         | Unit |
|--------|-----------|--|-------------------------|---------|------------------------|---------|------------------------|---------|------|
|        |           |  | rising                  | falling | rising                 | falling | rising                 | falling |      |
| tpd    | Delay     | Digital Input without Schmitt Trigger - Push Pull        | 35.3                    | 34.4    | 14.5                   | 14.3    | 10.3                   | 10.5    | ns   |
| tpd    | Delay     | Digital Input with Schmitt Trigger - Push Pull           | 34.8                    | 32.9    | 14.2                   | 13.8    | 10.0                   | 10.1    | ns   |
| tpd    | Delay     | Low Voltage Digital input - Push Pull                    | 37.8                    | 450.0   | 15.0                   | 208.2   | 10.5                   | 142.3   | ns   |
| tpd    | Delay     | Digital Input without Schmitt Trigger -- NMOS            | —                       | 73.5    | —                      | 26.0    | —                      | 16.3    | ns   |
| tpd    | Delay     | Output enable from pin, OE Hi-Z to 1                     | 44.6                    | —       | 17.9                   | —       | 12.4                   | —       | ns   |
| tpd    | Delay     | Output enable from pin, OE Hi-Z to 0                     | —                       | 43.0    | —                      | 17.6    | —                      | 12.5    | ns   |
| tpd    | Delay     | 2-bit LUT (Latch shared macrocell inputs)                | 29.6                    | 24.8    | 11.5                   | 10.1    | 8.2                    | 6.9     | ns   |
| tpd    | Delay     | Latch (2-bit LUT shared macrocell inputs)                | 29.2                    | 31.5    | 11.8                   | 12.5    | 8.4                    | 8.4     | ns   |
| tpd    | Delay     | 3-bit LUT (LATCH shared macrocell inputs)                | 33.0                    | 27.4    | 12.8                   | 11.1    | 9.1                    | 7.5     | ns   |
| tpd    | Delay     | Latch with nRST/nSET (3-bit LUT shared macrocell inputs) | 29.9                    | 32.4    | 12.1                   | 13.0    | 8.7                    | 8.7     | ns   |
| tpd    | Delay     | 4-bit LUT (shared macrocell inputs)                      | 29.2                    | 27.2    | 11.2                   | 10.8    | 8.0                    | 7.3     | ns   |
| tpd    | Delay     | 2-bit LUT  | 19.4                    | 18.8    | 7.2                    | 7.4     | 5.1                    | 5.0     | ns   |
| tpd    | Delay     | 3-bit LUT  | 22.3                    | 22.7    | 8.3                    | 8.9     | 6.0                    | 5.9     | ns   |
| tpd    | Delay     | CNT/DLY  | 38.4                    | 36.0    | 15.2                   | 15.1    | 10.8                   | 10.4    | ns   |
| tpd    | Delay     | CNT/DLY (shared macrocell inputs)                        | 41.0                    | 36.2    | 16.3                   | 15.6    | 11.5                   | 10.9    | ns   |
| tpd    | Delay     | CNT3/DLY3 Rising Edge Detect (shared macrocell inputs)   | 39.7                    | —       | 15.7                   | —       | 11.1                   | —       | ns   |
| tpd    | Delay     | CNT3/DLY3 Falling Edge Detect (shared macrocell inputs)  | —                       | 41.5    | —                      | 16.9    | —                      | 11.6    | ns   |
| tpd    | Delay     | CNT3/DLY3 Both Edge Detect (shared macrocell inputs)     | 39.7                    | 41.5    | 15.7                   | 16.9    | 11.1                   | 11.6    | ns   |
| tpd    | Delay     | Filter   | 183.1                   | 186.2   | 73.5                   | 75.7    | 47.9                   | 50.2    | ns   |





## 5.7 Typical Counter/Delay Offset Measurements

Table 3. Typical Counter/Delay Offset Measurements.

| Parameter               | RC OSC Freq | RC OSC Power | V <sub>DD</sub> = 1.8 V | V <sub>DD</sub> = 3.3V | V <sub>DD</sub> = 5.0V | Unit |
|-------------------------|-------------|--------------|-------------------------|------------------------|------------------------|------|
| offset                  | 25kHz       | auto         | 19                      | 14                     | 12                     | μs   |
| offset                  | 2MHz        | auto         | 7                       | 4                      | 4                      | μs   |
| frequency settling time | 25kHz       | auto         | 19                      | 14                     | 12                     | μs   |
| frequency settling time | 2MHz        | auto         | 14                      | 14                     | 14                     | μs   |
| variable (CLK period)   | 25kHz       | forced       | 0-40                    | 0-40                   | 0-40                   | μs   |
| variable (CLK period)   | 2MHz        | forced       | 0-0.5                   | 0-0.5                  | 0-0.5                  | μs   |
| tpd (non-delayed edge)  | 25kHz/2MHz  | either       | 35                      | 14                     | 10                     | ns   |

## 5.8 Expected Delays and Widths

Table 4. Expected Delays and Widths for Programmable Delay(typical).

| Symbol | Parameter     | Note  | V <sub>DD</sub> = 1.8 V | V <sub>DD</sub> = 3.3V | V <sub>DD</sub> = 5.0V | Unit |
|--------|---------------|---|-------------------------|------------------------|------------------------|------|
| time1  | Width, 1 cell | PDLY mode:(any)edge detect, edge detect output          | 272.4                   | 128.8                  | 97.5                   | ns   |
| time1  | Width, 2 cell | PDLY mode:(any)edge detect, edge detect output          | 582.7                   | 272.6                  | 205.1                  | ns   |
| time1  | Width, 3 cell | PDLY mode:(any)edge detect, edge detect output          | 893.4                   | 416.6                  | 312.9                  | ns   |
| time1  | Width, 4 cell | PDLY mode:(any)edge detect, edge detect output          | 1203.4                  | 560.6                  | 420.9                  | ns   |
| time2  | Delay, 1 cell | PDLY mode:(any)edge detect, edge detect output          | 39.3                    | 15.7                   | 10.9                   | ns   |
| time2  | Delay, 2 cell | PDLY mode:(any)edge detect, edge detect output          | 39.3                    | 15.7                   | 10.9                   | ns   |
| time2  | Delay, 3 cell | PDLY mode:(any)edge detect, edge detect output          | 39.3                    | 15.7                   | 10.9                   | ns   |
| time2  | Delay, 4 cell | PDLY mode:(any)edge detect, edge detect output          | 39.3                    | 15.7                   | 10.9                   | ns   |
| time1  | Delay, 1 cell | PDLY mode: both edge delay (shared macrocell inputs)    | 354                     | 161.5                  | 120.1                  | ns   |
| time1  | Delay, 2 cell | PDLY mode: both edge delay (shared macrocell inputs)    | 664.2                   | 305.2                  | 227.8                  | ns   |
| time1  | Delay, 3 cell | PDLY mode: both edge delay (shared macrocell inputs)    | 974.9                   | 449.1                  | 335.7                  | ns   |
| time1  | Delay, 4 cell | PDLY mode: both edge delay (shared macrocell inputs)    | 1284.8                  | 593.1                  | 443.6                  | ns   |
| time1  | Width         | CNT3/DLY3 Rising Edge Detect (shared macrocell inputs)  | 63.6                    | 32.4                   | 22.9                   | ns   |
| time1  | Width         | CNT3/DLY3 Falling Edge Detect (shared macrocell inputs) | 61.3                    | 31.1                   | 22.5                   | ns   |
| time1  | Width         | CNT3/DLY3 Both Edge Detect (shared macrocell inputs)    | 62.2                    | 31.6                   | 22.7                   | ns   |

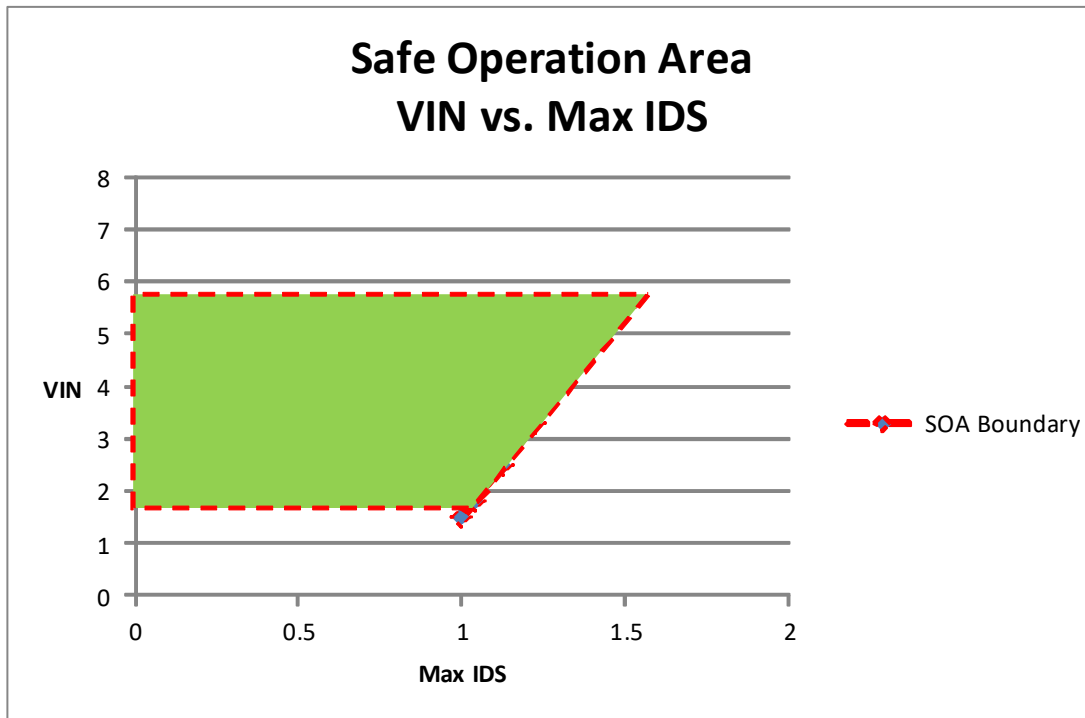


5.9 Typical Pulse Width Performance

Table 5. Typical Pulse Width Performance.

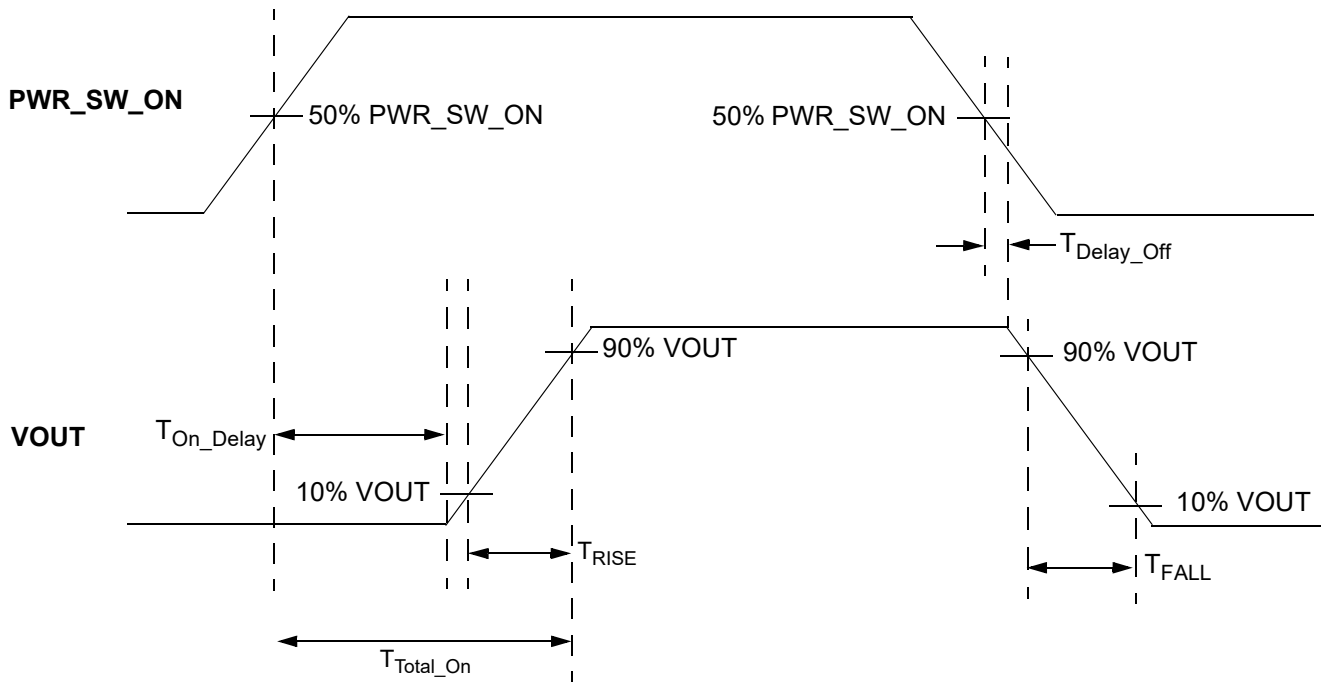
| Parameter            | V <sub>DD</sub> = 1.8 V | V <sub>DD</sub> = 3.3V | V <sub>DD</sub> = 5.0V | Unit |
|----------------------|-------------------------|------------------------|------------------------|------|
| Filtered Pulse Width | < 150                   | < 55                   | < 35                   | ns   |

5.10 VIN vs. Max IDS, Safe Operation Area





## 5.11 $T_{Total\_On}$ , $T_{On\_Delay}$ and Slew Rate Measurement





## 6.0 Summary of Macrocell Function

### 6.1 I/O Pins

- Digital Input (low voltage or normal voltage, with or without Schmitt Trigger)
- Open Drain Outputs
- Push Pull Outputs
- Analog I/O
- 10 k $\Omega$ /100 k $\Omega$ /1 M $\Omega$  pull-up/pull-down resistors

### 6.2 Connection Matrix

- Digital matrix for circuit connections based on user design

### 6.3 Analog Comparators (2 total)

- Selectable hysteresis 0 mV/25 mV/50 mV/200 mV

### 6.4 Voltage Reference

- Used for references on Analog Comparators
- Can also be driven to external pins

### 6.5 Combinational Logic Look Up Tables (LUTs – 4 total)

- Two 2-bit Lookup Tables
- Two 3-bit Lookup Tables

### 6.6 Combination Function Macrocells (7 total)

- Two Selectable DFF/Latch or 2-bit LUTs
- Two Selectable DFF/Latch or 3-bit LUTs
- One Selectable Pipe Delay or 3-bit LUT
- One Selectable CNT/DLY or 4-bit LUT
- One Programmable Delay/ Deglitch Filter

### 6.7 Delays/Counters (3 total)

- Three 8-bit delays/counters with external clock/reset: Range 1-255 clock cycles

### 6.8 Pipe Delay (Part of Combination Function Macrocell)

- 8 stage / 2 output
- Two 1-8 stage selectable outputs.

### 6.9 Programmable Delay

- 125 ns/250 ns/375 ns/500 ns @ 3.3 V
- Includes Edge Detection function



### 6.10 RC Oscillator

- 25 kHz and 2 MHz selectable frequency
- First stage divider (4): OSC/1, OSC/2, OSC/4, and OSC/8
- Second stage divider (8): selectable (OSC/1, OSC/2, OSC/3, OSC/4, OSC/8, OSC/12, OSC/24, or OSC/64)

### 6.11 Power On Reset (POR)



### 7.0 I/O Pins

The SLG46116 has a total of 7 multi-function I/O pins which can function as either a user defined Input or Output, as well as serving as a special function (such as outputting the voltage reference). Refer to Section 2.0 Pin Description for pin definitions.

Of the 7 user defined I/O pins on the SLG46116, all but one of the pins (Pin 1) can serve as both digital input and digital output. Pin 1 can only serve as a digital input pin.

#### 7.1 Input Modes

Each I/O pin can be configured as a digital input pin with/without buffered Schmitt trigger, or can also be configured as a low voltage digital input. Pins 2 and 3 can also be configured to serve as analog inputs to the on-chip comparators.

#### 7.2 Output Modes

Pins 2, 3, 10, 11, 12, and 13 can all be configured as digital output pins.

#### 7.3 Pull Up/Down Resistors

All I/O pins have the option for user selectable resistors connected to the input structure. The selectable values on these resistors are 10 k $\Omega$ , 100 k $\Omega$  and 1 M $\Omega$ . In the case of Pin 1, the resistors are fixed to a pull-down configuration. In the case of all other I/O pins, the internal resistors can be configured as either pull-up or pull-downs.



## 7.4 I/O Register Settings

### 7.4.1 PIN 1 Register Settings

Table 6. PIN 1 Register Settings

| Signal Function                          | Register Bit Address | Register Definition  |
|--|----------------------|--|
| PIN 1 Mode Control                       | reg <380:379>        | 00: Digital Input without Schmitt trigger<br>01: Digital Input with Schmitt trigger<br>10: Low voltage digital input<br>11: Reserved |
| PIN 1 Pull Down Resistor Value Selection | reg <382:381>        | 00: Floating<br>01: 10 kΩ Resistor<br>10: 100 kΩ Resistor<br>11: 1 MΩ Resistor   |

### 7.4.2 PIN 2 Register Settings

Table 7. PIN 2 Register Settings

| Signal Function                             | Register Bit Address | Register Definition  |
|---|----------------------|--|
| PIN 2 Mode Control                          | reg <385:383>        | 000: Digital Input without Schmitt trigger<br>001: Digital Input with Schmitt trigger<br>010: Low voltage digital input<br>011: Analog Input / Output<br>100: Push Pull<br>101: Open Drain NMOS<br>110: Open Drain PMOS<br>111: Analog Input / Output & Open drain |
| PIN 2 Pull Up/Down Resistor Value Selection | reg <387:386>        | 00: Floating<br>01: 10 kΩ Resistor<br>10: 100 kΩ Resistor<br>11: 1 MΩ Resistor   |
| PIN 2 Pull Up/Down Resistor Selection       | reg <388>            | 0: Pull Down Resistor<br>1: Pull Up Resistor   |
| PIN2 Driver Strength Selection              | reg <389>            | 0: 1X<br>1: 2X   |



### 7.4.3 PIN 3 Register Settings

Table 8. PIN 3 Register Settings

| Signal Function                             | Register Bit Address | Register Definition  |
|---|----------------------|--|
| PIN 3 Mode Control                          | reg <392:390>        | 000: Digital Input without Schmitt trigger<br>001: Digital Input with Schmitt trigger<br>010: Low voltage digital input<br>011: Analog Input / Output<br>100: Push Pull<br>101: Open Drain NMOS<br>110: Open Drain PMOS<br>111: Analog Input / Output & Open drain |
| PIN 3 Pull Up/Down Resistor Value Selection | reg <394:393>        | 00: Floating<br>01: 10 kΩ Resistor<br>10: 100 kΩ Resistor<br>11: 1 MΩ Resistor   |
| PIN 3 Pull Up/Down Resistor Selection       | reg <395>            | 0: Pull Down Resistor<br>1: Pull Up Resistor   |
| PIN 3 Driver Strength Selection             | reg <396>            | 0: 1X<br>1: 2X   |

### 7.4.4 PIN 10 Register Settings

Table 9. PIN 10 Register Settings

| Signal Function                              | Register Bit Address | Register Definition  |
|--|----------------------|--|
| PIN 10 Mode Control                          | reg <406:404>        | 000: Digital Input without Schmitt trigger<br>001: Digital Input with Schmitt trigger<br>010: Low voltage digital input<br>011: Analog Input / Output<br>100: Push Pull<br>101: Open Drain NMOS<br>110: Open Drain PMOS<br>111: Analog Input / Output & Open drain |
| PIN 10 Pull Up/Down Resistor Value Selection | reg <408:407>        | 00: Floating<br>01: 10 kΩ Resistor<br>10: 100 kΩ Resistor<br>11: 1 MΩ Resistor   |
| PIN 10 Pull Up/Down Resistor Selection       | reg <409>            | 0: Pull Down Resistor<br>1: Pull Up Resistor   |
| PIN 10 Driver Strength Selection             | reg <410>            | 0: 1X<br>1: 2X   |





### 7.4.5 PIN 11 Register Settings

Table 10. PIN 11 Register Settings

| Signal Function                              | Register Bit Address | Register Definition  |
|--|----------------------|--|
| PIN 11 Mode Control                          | reg <413:411>        | 000: Digital Input without Schmitt trigger<br>001: Digital Input with Schmitt trigger<br>010: Low voltage digital input<br>011: Analog Input / Output<br>100: Push Pull<br>101: Open Drain NMOS<br>110: Open Drain PMOS<br>111: Analog Input / Output & Open drain |
| PIN 11 Pull Up/Down Resistor Value Selection | reg <415:414>        | 00: Floating<br>01: 10 kΩ Resistor<br>10: 100 kΩ Resistor<br>11: 1 MΩ Resistor   |
| PIN 11 Pull Up/Down Resistor Selection       | reg <416>            | 0: Pull Down Resistor<br>1: Pull Up Resistor   |
| PIN 11 Driver Strength Selection             | reg <417>            | 0: 1X<br>1: 2X   |

### 7.4.6 PIN 12 Register Settings

Table 11. PIN 12 Register Settings

| Signal Function                              | Register Bit Address | Register Definition   |
|--|----------------------|---|
| PIN 12 Mode Control (sig_PIN12_oe =0)        | reg <419:418>        | 00: Digital Input without Schmitt trigger<br>01: Digital Input with Schmitt trigger<br>11: Low Voltage Digital Input<br>10: Analog Input / Output |
| PIN 12 Mode Control (sig_PIN12_oe =1)        | reg <421:420>        | 00: Push Pull 1X<br>01: Push Pull 2X<br>10: Open Drain NMOS 1X<br>11: Open Drain NMOS 2X  |
| PIN 12 Pull Up/Down Resistor Value Selection | reg <423:422>        | 00: Floating<br>01: 10 kΩ Resistor<br>10: 100 kΩ Resistor<br>11: 1 MΩ Resistor  |
| PIN 12 Pull Up/Down Resistor Selection       | reg <424>            | 0: Pull Down Resistor<br>1: Pull Up Resistor  |



## 7.4.7 PIN 13 Register Settings

Table 12. PIN 13 Register Settings

| Signal Function                              | Register Bit Address | Register Definition  |
|--|----------------------|--|
| PIN 13 Mode Control                          | reg <427:425>        | 000: Digital Input without Schmitt trigger<br>001: Digital Input with Schmitt trigger<br>010: Low voltage digital input<br>011: Analog Input / Output<br>100: Push Pull<br>101: Open Drain NMOS<br>110: Open Drain PMOS<br>111: Analog Input / Output & Open drain |
| PIN 13 Pull Up/Down Resistor Value Selection | reg <429:428>        | 00: Floating<br>01: 10 k $\Omega$ Resistor<br>10: 100 k $\Omega$ Resistor<br>11: 1 M $\Omega$ Resistor   |
| PIN 13 Pull Up/Down Resistor Selection       | reg <430>            | 0: Pull Down Resistor<br>1: Pull Up Resistor   |
| PIN 13 Driver Strength Selection             | reg <431>            | 0: 1X<br>1: 2X   |



## 7.5 GPI IO Structure

### 7.5.1 GPI IO Structure (for Pin 1)

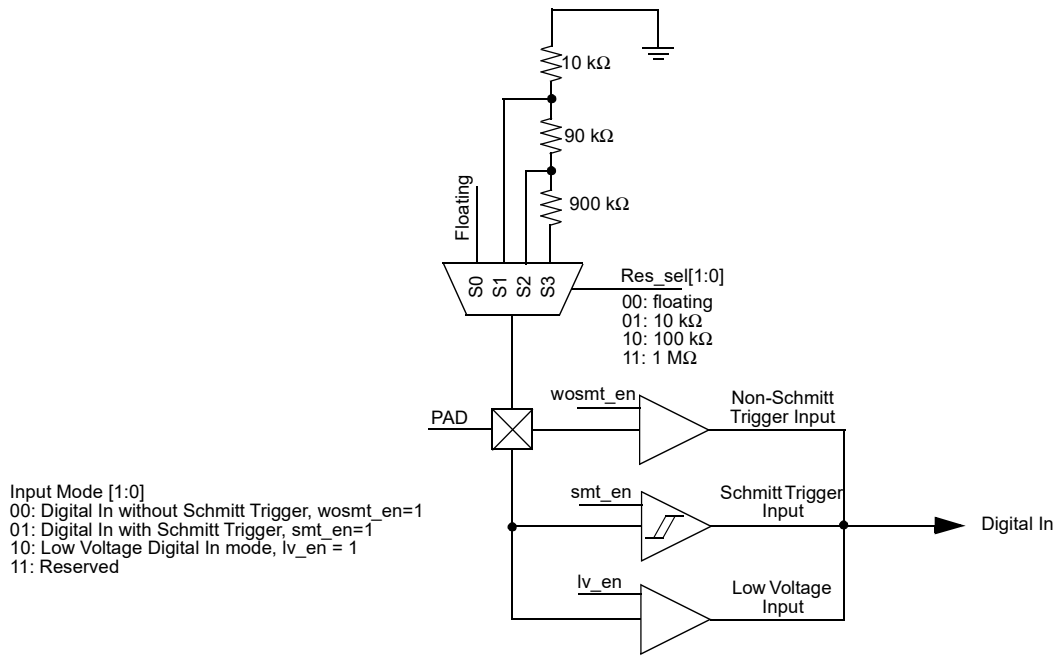


Figure 2. PIN 2 GPI IO Structure Diagram



## 7.6 Matrix OE IO Structure

### 7.6.1 Matrix OE IO Structure (for Pin 12)

Input Mode [1:0]  
 00: Digital In without Schmitt Trigger, *wosmt\_en*=1  
 01: Digital In with Schmitt Trigger, *smt\_en*=1  
 10: Low Voltage Digital In mode, *lv\_en*=1  
 11: analog IO mode

Output Mode [1:0]  
 00: 1x push-pull mode, *pp1x\_en*=1  
 01: 2x push-pull mode, *pp2x\_en*=1, *pp1x\_en*=1  
 10: 1x NMOS open drain mode, *od1x\_en*=1  
 11: 2x NMOS open drain mode, *od2x\_en*=1, *od1x\_en*=1

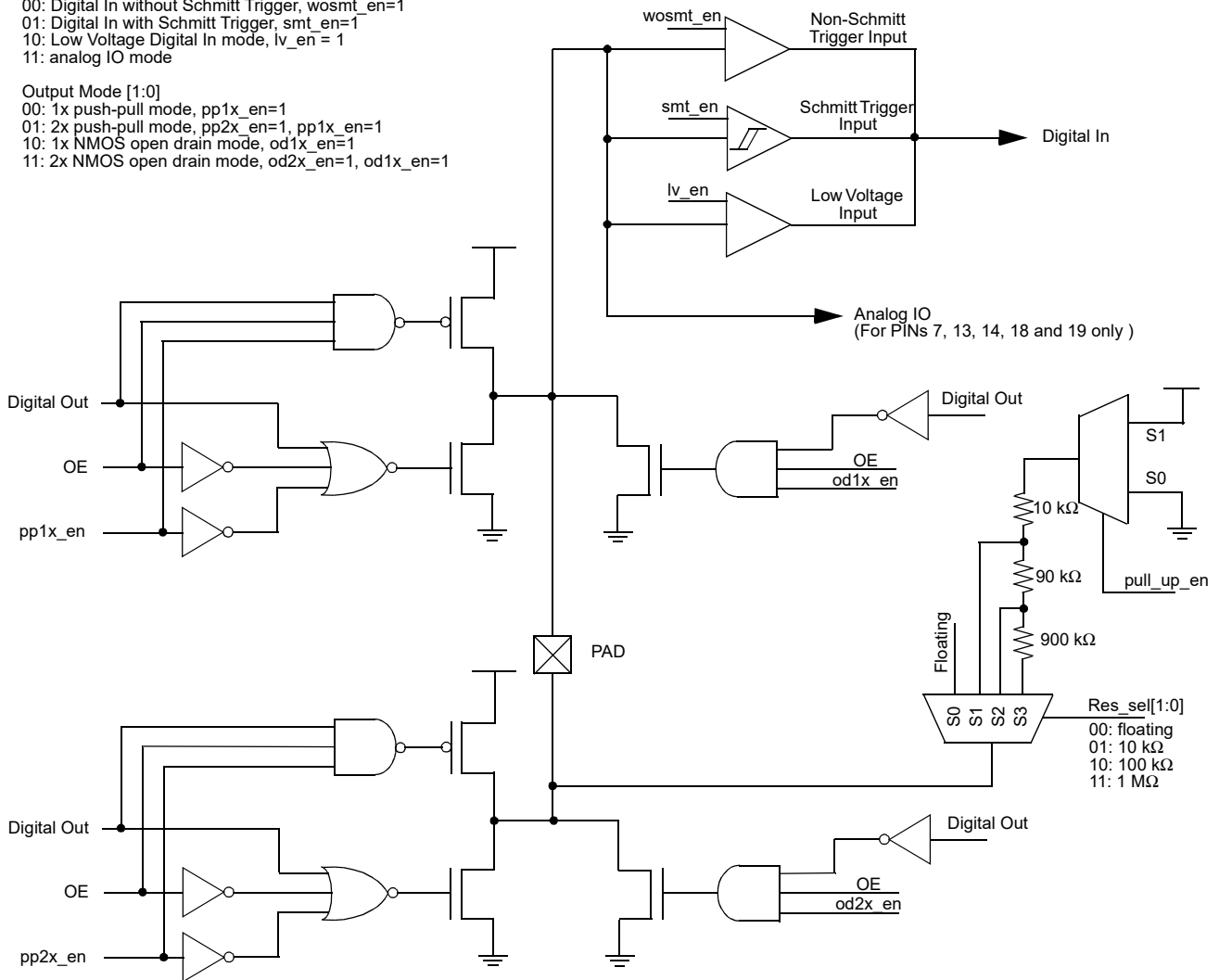


Figure 3. Matrix OE IO Structure Diagram



## 7.7 Register OE IO Structure

### 7.7.1 Register OE IO Structure (for Pins 2, 3, 10, 11, 13)

Mode [2:0]  
 000: Digital In without Schmitt Trigger, *wosmt\_en*=1, OE = 0  
 001: Digital In with Schmitt Trigger, *smt\_en*=1, OE = 0  
 010: Low Voltage Digital In mode, *lv\_en* = 1, OE = 0  
 011: analog IO mode  
 100: push-pull mode, *pp\_en*=1, OE = 1  
 101: NMOS open drain mode, *odn\_en*=1, OE = 1  
 110: PMOS open drain mode, *odp\_en*=1, OE = 1  
 111: analog IO and NMOS open-drain mode, *odn\_en*=1 and *AIO\_en*=1

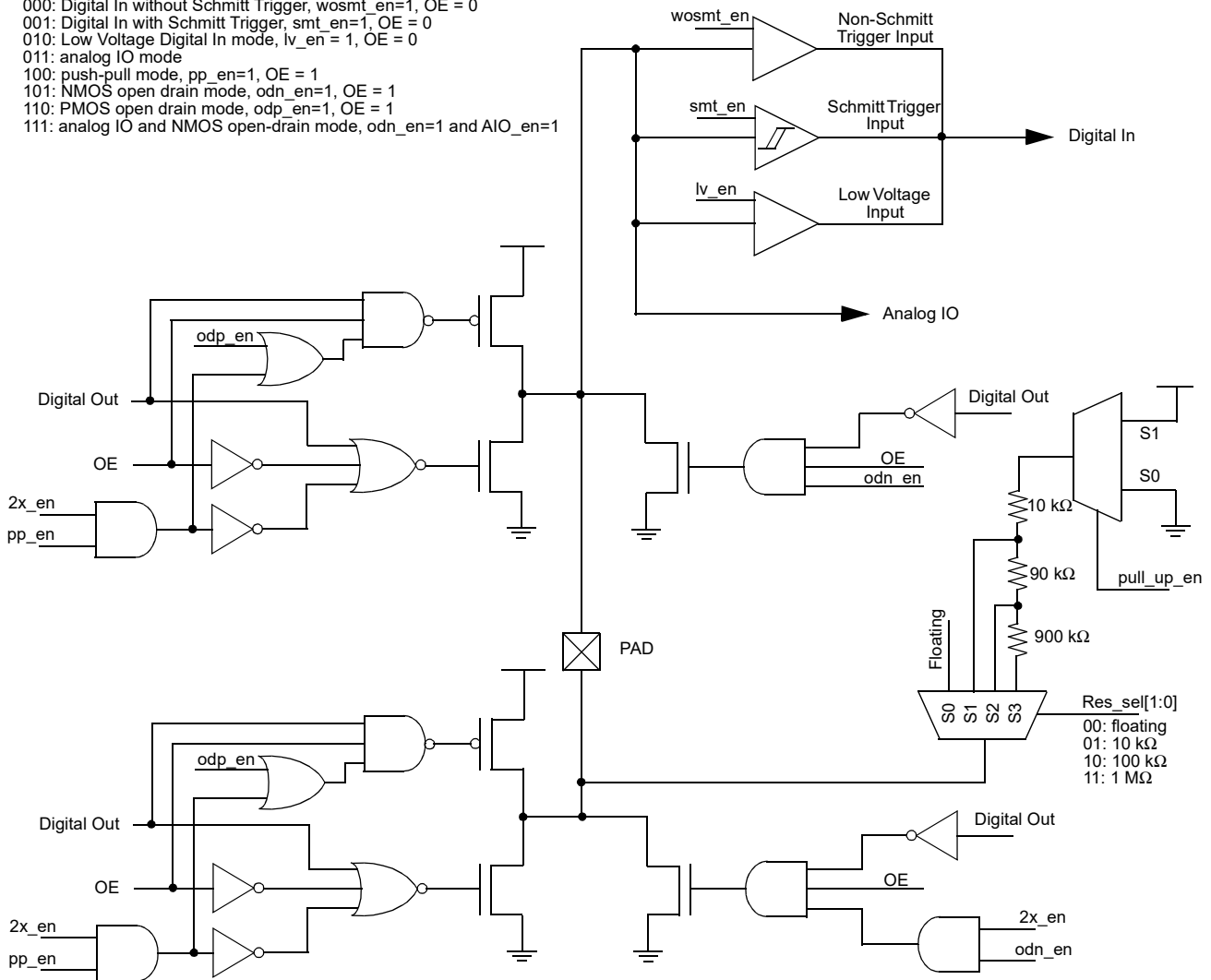


Figure 4. Register OE IO Structure Diagram



**8.0 Connection Matrix**

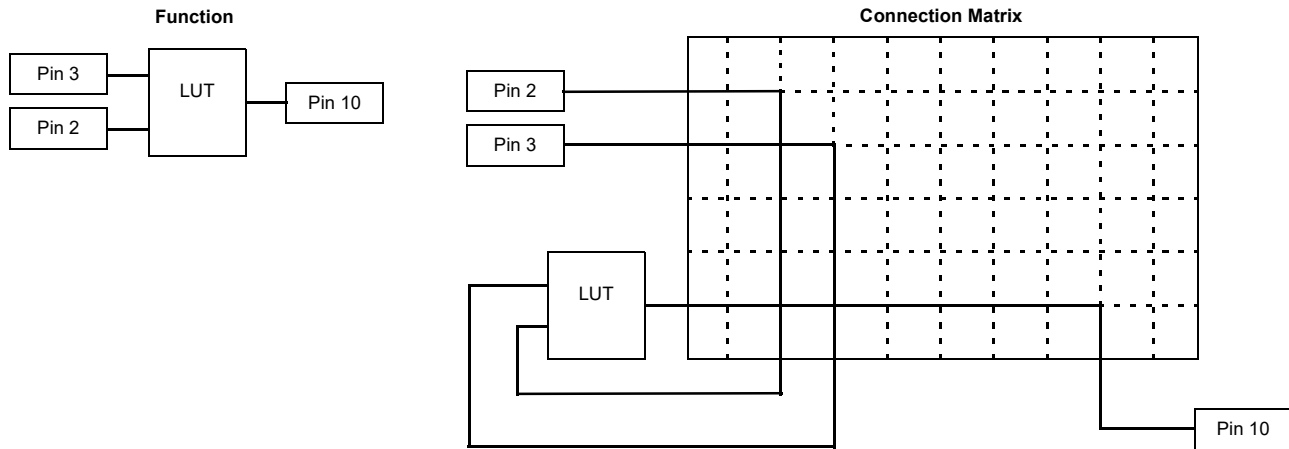
The Connection Matrix in the SLG46116 is used to create the internal routing for internal functions of the device once it is programmed. The registers are programmed from the one-time NVM cell during Test Mode Operation. All of the connection point for each logic cell within the SLG46116 has a specific digital bit code assigned to it that is either set to active “High” or inactive “Low” based on the design that is created. Once the 1024 register bits within the SLG46116 are programmed a fully custom circuit will be created.

The Connection Matrix has 32 inputs and 44 outputs. Each of the 32 inputs to the Connection Matrix is hard-wired to a particular source macrocell, including I/O pins, LUTs, analog comparators, other digital resources and V<sub>DD</sub> and V<sub>SS</sub>. The input to a digital macrocell uses a 5-bit register to select one of these 32 input lines.

For a complete list of the SLG46116’s register table, see Section 19.0 Appendix A - SLG46116 Register Definition.

| Matrix Input Signal Functions | N                |                             |                             |                             |          |                              |
|-------------------------------|------------------|-----------------------------|-----------------------------|-----------------------------|----------|------------------------------|
| VSS                           | 0                |                             |                             |                             |          |                              |
| PIN 1 Digital In              | 1                |                             |                             |                             |          |                              |
| PIN 2 Digital In              | 2                |                             |                             |                             |          |                              |
| PIN 3 Digital In              | 3                |                             |                             |                             |          |                              |
| ⋮                             | ⋮                |                             |                             |                             |          |                              |
| PIN 13 Digital In             | 30               |                             |                             |                             |          |                              |
| VDD                           | 31               |                             |                             |                             |          |                              |
| <b>Matrix Inputs</b>          | <b>N</b>         | <b>0</b>                    | <b>1</b>                    | <b>2</b>                    | <b>⋮</b> | <b>43</b>                    |
|                               | <b>Registers</b> | reg <4:0>                   | reg <9:5>                   | reg <14:10>                 | ⋮        | reg <219:215>                |
|                               | <b>Function</b>  | PIN 2 Digital Output Source | PIN 3 Digital Output Source | PIN 4 Digital Output Source | ⋮        | PIN 13 Digital Output Source |
| <b>Matrix Outputs</b>         |                  |                             |                             |                             |          |                              |

**Figure 5. Connection Matrix**



**Figure 6. Connection Matrix Example**



## 8.1 Matrix Input Table

Table 13. Matrix Input Table

| N  | Matrix Input Signal Function  | Matrix Decode |   |   |   |   |
|----|---|---------------|---|---|---|---|
|    |   | 4             | 3 | 2 | 1 | 0 |
| 0  | VSS   | 0             | 0 | 0 | 0 | 0 |
| 1  | PIN 1 digital Input   | 0             | 0 | 0 | 0 | 1 |
| 2  | PIN 2 digital Input   | 0             | 0 | 0 | 1 | 0 |
| 3  | PIN 3 digital Input   | 0             | 0 | 0 | 1 | 1 |
| 4  | PIN 4 digital Input   | 0             | 0 | 1 | 0 | 0 |
| 5  | LUT2_0 output (DFF/LATCH_0 output)  | 0             | 0 | 1 | 0 | 1 |
| 6  | LUT2_1 output (DFF/LATCH_1 output)  | 0             | 0 | 1 | 1 | 0 |
| 7  | LUT2_2 output   | 0             | 0 | 1 | 1 | 1 |
| 8  | LUT2_3 output   | 0             | 1 | 0 | 0 | 0 |
| 9  | LUT3_0 output (DFF/LATCH_2 output with resetb or seb)                           | 0             | 1 | 0 | 0 | 1 |
| 10 | LUT3_1 output (DFF/LATCH_3 output with resetb or seb)                           | 0             | 1 | 0 | 1 | 0 |
| 11 | LUT3_2 output   | 0             | 1 | 0 | 1 | 1 |
| 12 | LUT3_3 output   | 0             | 1 | 1 | 0 | 0 |
| 13 | LUT3_4 output(pipe delay output0)   | 0             | 1 | 1 | 0 | 1 |
| 14 | pipe delay output1  | 0             | 1 | 1 | 1 | 0 |
| 15 | LUT4_0 output (CNT_DLY2 output (8 bit w/ ext CK,reset))                         | 0             | 1 | 1 | 1 | 1 |
| 16 | CNT_DLY0 output (8 bit w/ ext CK (shared bottom delay/cnt),reset)               | 1             | 0 | 0 | 0 | 0 |
| 17 | CNT_DLY1 output (8 bit w/ ext CK (from dedicated matrix output),reset)          | 1             | 0 | 0 | 0 | 1 |
| 18 | CNT_DLY3 (8 bit) output   | 1             | 0 | 0 | 1 | 0 |
| 19 | ACMP_0 output   | 1             | 0 | 0 | 1 | 1 |
| 20 | ACMP_1 output   | 1             | 0 | 1 | 0 | 0 |
| 21 | Edge detect output  | 1             | 0 | 1 | 0 | 1 |
| 22 | Programmable delay with edge detector output (Deglitch filter output)           | 1             | 0 | 1 | 1 | 0 |
| 23 | internal oscillator output1 (one of /1,/2,/3,/4,/8,12/,24/,64/ selected by REG) | 1             | 0 | 1 | 1 | 1 |
| 24 | internal oscillator output2 (one of /1,/2,/3,/4,/8,12/,24/,64/ selected by REG) | 1             | 1 | 0 | 0 | 0 |
| 25 | Bandgap OK signal   | 1             | 1 | 0 | 0 | 1 |
| 26 | Resetb_core as matrix input   | 1             | 1 | 0 | 1 | 0 |
| 27 | PIN 10 digital Input  | 1             | 1 | 0 | 1 | 1 |
| 28 | PIN 11 digital Input  | 1             | 1 | 1 | 0 | 0 |
| 29 | PIN 12 digital Input  | 1             | 1 | 1 | 0 | 1 |
| 30 | PIN 13 digital Input  | 1             | 1 | 1 | 1 | 0 |
| 31 | VDD   | 1             | 1 | 1 | 1 | 1 |



## 8.2 Matrix Output Table

Table 14. Matrix Output Table

| Register Bit Address | Matrix Output Signal Function  | Matrix Output Number |
|----------------------|--|----------------------|
| reg <4:0>            | PIN 2 digital out source   | 0                    |
| reg <9:5>            | PIN 3 digital out source   | 1                    |
| reg <14:10>          | PIN 4 digital out source   | 2                    |
| reg <19:15>          | PIN 4 output enable and ON input of P-FET Power Switch                 | 3                    |
| reg <24:20>          | in0 of LUT2_0 (Clock Input of DFF0)                                    | 4                    |
| reg <29:25>          | in1 of LUT2_0 (Data Input of DFF0)                                     | 5                    |
| reg <34:30>          | in0 of LUT2_1 (Clock Input of DFF1)                                    | 6                    |
| reg <39:35>          | in1 of LUT2_1 (Data Input of DFF1)                                     | 7                    |
| reg <44:40>          | in0 of LUT2_2  | 8                    |
| reg <49:45>          | in1 of LUT2_2  | 9                    |
| reg <54:50>          | in0 of LUT2_3  | 10                   |
| reg <59:55>          | in1 of LUT2_3  | 11                   |
| reg <64:60>          | in0 of LUT3_0 (Clock Input of DFF2 with nReset/nSet)                   | 12                   |
| reg <69:60>          | in1 of LUT3_0 (Data input of DFF2 with nReset/nSet)                    | 13                   |
| reg <74:70>          | in2 of LUT3_0 (Resetb or Setb of DFF2 with nReset/nSet)                | 14                   |
| reg <79:75>          | in0 of LUT3_1 (Clock Input of DFF3 with nReset/nSet)                   | 15                   |
| reg <84:80>          | in1 of LUT3_1 (Data input of DFF3 with nReset/nSet)                    | 16                   |
| reg <89:85>          | in2 of LUT3_1 (Resetb or Setb of DFF3 with nReset/nSet)                | 17                   |
| reg <94:90>          | in0 of LUT3_2  | 18                   |
| reg <99:95>          | in1 of LUT3_2  | 19                   |
| reg <104:100>        | in2 of LUT3_2  | 20                   |
| reg <109:105>        | in0 of LUT3_3  | 21                   |
| reg <114:110>        | in1 of LUT3_3  | 22                   |
| reg <119:115>        | in2 of LUT3_3  | 23                   |
| reg <124:120>        | in0 of LUT3_4 (Input of pipe delay)                                    | 24                   |
| reg <129:125>        | in1 of LUT3_4 (Resetb of pipe delay)                                   | 25                   |
| reg <134:130>        | in2 of LUT3_4 (Clock of pipe delay)                                    | 26                   |
| reg <139:135>        | in0 of LUT4_0 (Input for Delay2 ext. clock or Counter2 external Clock) | 27                   |
| reg <144:140>        | in1 of LUT4_0 (Input for delay2 or counter2 reset input)               | 28                   |
| reg <149:145>        | in2 of LUT4_0  | 29                   |
| reg <154:150>        | in3 of LUT4_0  | 30                   |
| reg <159:155>        | Input for delay0 or counter0 reset input                               | 31                   |
| reg <164:160>        | Input for delay1 or counter1 reset input                               | 32                   |
| reg <169:165>        | Input for Delay0/1 ext. clock or Counter1 external Clock               | 33                   |
| reg <174:170>        | Input for delay3 or counter3 reset input                               | 34                   |
| reg <179:175>        | pdb for ACMP0  | 35                   |
| reg <184:180>        | pdb for ACMP1  | 36                   |
| reg <189:185>        | Input for programmable delay(deglitch filter input)                    | 37                   |





**Table 14. Matrix Output Table**

| Register Bit Address | Matrix Output Signal Function                              | Matrix Output Number |
|----------------------|--|----------------------|
| reg <194:190>        | Power down for osc. (higher priority) (high = power down). | 38                   |
| reg <199:195>        | PIN 10 digital out source                                  | 39                   |
| reg <204:200>        | PIN 11 digital out source                                  | 40                   |
| reg <209:205>        | PIN 12 digital out source                                  | 41                   |
| reg <214:210>        | PIN 12 output enable                                       | 42                   |
| reg <219:215>        | PIN 13 digital out source                                  | 43                   |



## 9.0 Combinatorial Logic

Combinatorial logic is supported via four Lookup Tables (LUTs) within the SLG46116. There are two 2-bit LUTs and two 3-bit LUTs. The device also includes six Combination Function Macrocells that can be used as LUTs. For more details, please see Section 10.0 Combination Function Macrocells.

Inputs/Outputs for the four LUTs are configured from the connection matrix with specific logic functions being defined by the state of NVM bits. The outputs of the LUTs can be configured to any user defined function, including the following standard digital logic devices (AND, NAND, OR, NOR, XOR, XNOR).

### 9.1 2-Bit LUT

The two 2-bit LUTs each take in two input signals from the connection matrix and produce a single output, which goes back into the connection matrix. ...

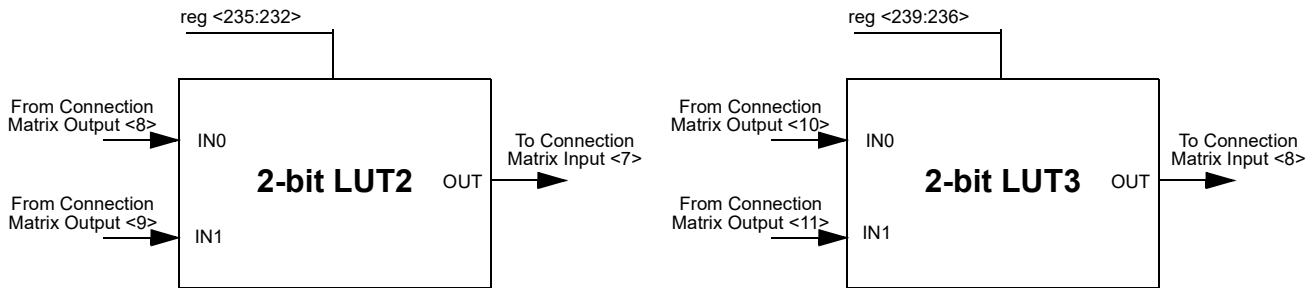


Figure 7. 2-bit LUTs

Table 15. 2-bit LUT2 Truth Table.

| IN1 | IN0 | OUT       |
|-----|-----|-----------|
| 0   | 0   | reg <232> |
| 0   | 1   | reg <233> |
| 1   | 0   | reg <234> |
| 1   | 1   | reg <235> |

Table 16. 2-bit LUT3 Truth Table.

| IN1 | IN0 | OUT       |
|-----|-----|-----------|
| 0   | 0   | reg <236> |
| 0   | 1   | reg <237> |
| 1   | 0   | reg <238> |
| 1   | 1   | reg <239> |

Each 2-bit LUT uses a 4-bit register signal to define their output functions;

*2-Bit LUT2 is defined by reg <235:232>*

*2-Bit LUT3 is defined by reg <239:236>*

The table below shows the register bits for the standard digital logic devices (AND, NAND, OR, NOR, XOR, XNOR) that can be created within each of the two 2-bit LUT logic cells.

Table 17. 2-bit LUT2/LUT3 Standard Digital Functions.

| Function | MSB |   |   | LSB |
|----------|-----|---|---|-----|
| AND-2    | 1   | 0 | 0 | 0   |
| NAND-2   | 0   | 1 | 1 | 1   |
| OR-2     | 1   | 1 | 1 | 0   |
| NOR-2    | 0   | 0 | 0 | 1   |
| XOR-2    | 0   | 1 | 1 | 0   |
| XNOR-2   | 1   | 0 | 0 | 1   |



## 9.2 3-Bit LUT

The two 3-bit LUTs each take in three input signals from the connection matrix and produce a single output, which goes back into the connection matrix.

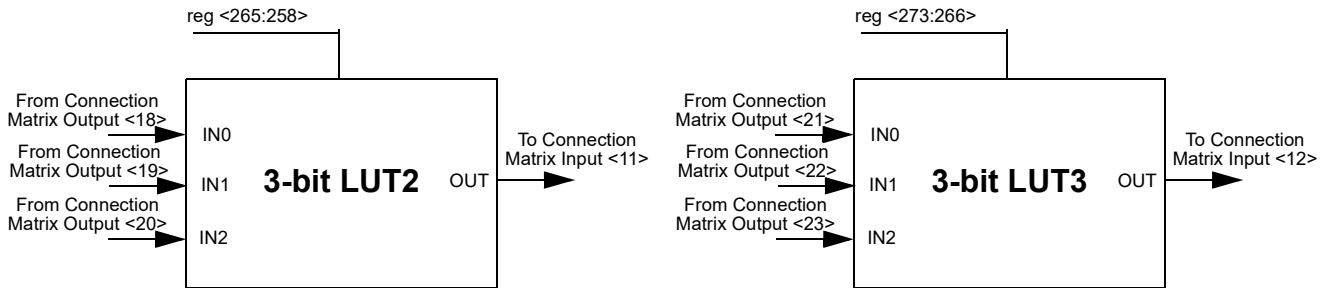


Figure 8. 3-bit LUTs

Table 18. 3-bit LUT2 Truth Table.

| IN2 | IN1 | IN0 | OUT       |
|-----|-----|-----|-----------|
| 0   | 0   | 0   | reg <258> |
| 0   | 0   | 1   | reg <259> |
| 0   | 1   | 0   | reg <260> |
| 0   | 1   | 1   | reg <261> |
| 1   | 0   | 0   | reg <262> |
| 1   | 0   | 1   | reg <263> |
| 1   | 1   | 0   | reg <264> |
| 1   | 1   | 1   | reg <265> |

Table 19. 3-bit LUT3 Truth Table.

| IN2 | IN1 | IN0 | OUT       |
|-----|-----|-----|-----------|
| 0   | 0   | 0   | reg <266> |
| 0   | 0   | 1   | reg <267> |
| 0   | 1   | 0   | reg <268> |
| 0   | 1   | 1   | reg <269> |
| 1   | 0   | 0   | reg <270> |
| 1   | 0   | 1   | reg <271> |
| 1   | 1   | 0   | reg <272> |
| 1   | 1   | 1   | reg <273> |

Each 3-bit LUT uses a 8-bit register signal to define their output functions;

*3-Bit LUT2 is defined by reg <265:258>*

*3-Bit LUT3 is defined by reg <273:266>*



The table below shows the register bits for the standard digital logic devices (AND, NAND, OR, NOR, XOR, XNOR) that can be created within each of the two 3-bit LUT logic cells.

**Table 20. 3-bit LUT2/LUT3 Standard Digital Functions.**

| Function | MSB |   |   |   |   |   |   | LSB |
|----------|-----|---|---|---|---|---|---|-----|
| AND-3    | 1   | 0 | 0 | 0 | 0 | 0 | 0 | 0   |
| NAND-3   | 0   | 1 | 1 | 1 | 1 | 1 | 1 | 1   |
| OR-3     | 1   | 1 | 1 | 1 | 1 | 1 | 1 | 0   |
| NOR-3    | 0   | 0 | 0 | 0 | 0 | 0 | 0 | 1   |
| XOR-3    | 0   | 1 | 1 | 1 | 1 | 1 | 1 | 0   |
| XNOR-3   | 1   | 0 | 0 | 0 | 0 | 0 | 0 | 1   |



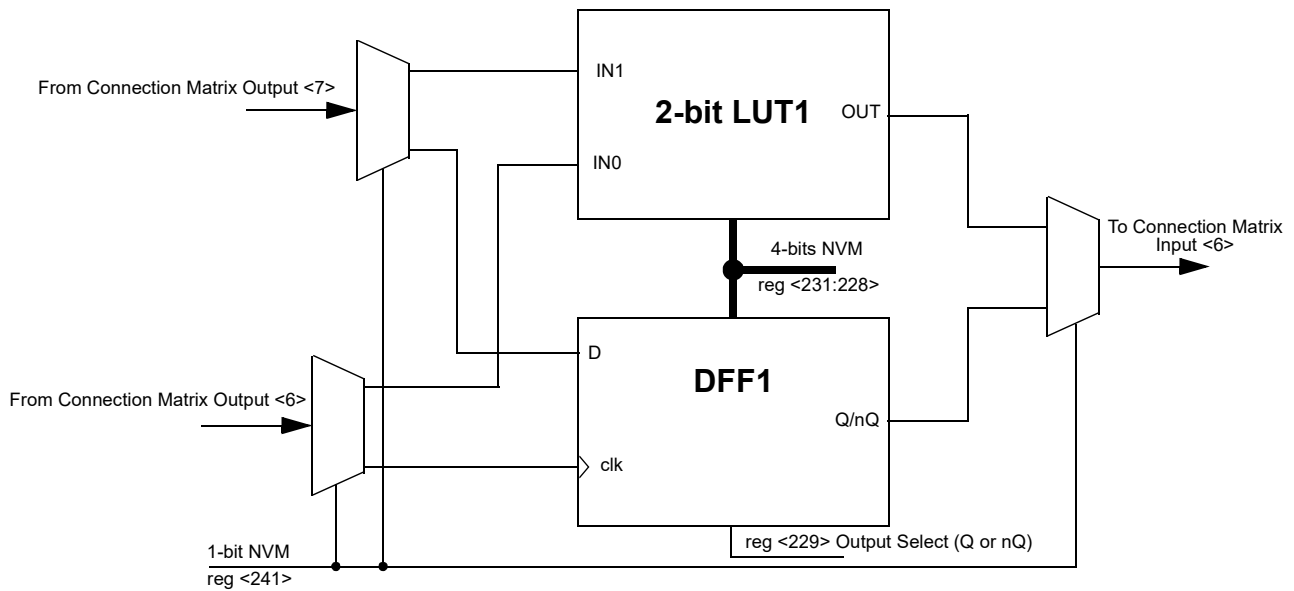


Figure 10. 2-bit LUT1 or DFF1

10.1.1 2-Bit LUT or D Flip-Flop Macrocells Used as 2-Bit LUTs

Table 21. 2-bit LUT0 Truth Table.

| IN1 | IN0 | OUT       |
|-----|-----|-----------|
| 0   | 0   | reg <224> |
| 0   | 1   | reg <225> |
| 1   | 0   | reg <226> |
| 1   | 1   | reg <227> |

Table 22. 2-bit LUT1 Truth Table.

| IN1 | IN0 | OUT       |
|-----|-----|-----------|
| 0   | 0   | reg <228> |
| 0   | 1   | reg <229> |
| 1   | 0   | reg <230> |
| 1   | 1   | reg <231> |

Each Macrocell, when programmed for a LUT function, uses a 4-bit register to define their output function:

*2-Bit LUT0 is defined by reg <227:224>*

*2-Bit LUT1 is defined by reg <231:228>*



## 10.1.2 2-Bit LUT or D Flip-Flop Macrocells Used as D Flip-Flop Register Settings

**Table 23. DFF0 Register Settings**

| Signal Function              | Register Bit Address | Register Definition                  |
|------------------------------|----------------------|--------------------------------------|
| DFF0 or Latch select         | reg <224>            | 0: DFF function<br>1: Latch function |
| DFF0 output select           | reg <225>            | 0: Q output<br>1: nQ output          |
| DFF0 initial polarity select | reg <226>            | 0: Low<br>1: High                    |
| LUT2_0 data                  | reg <235:232>        | LUT2_0 data                          |
| LUT2_0 or DFF0 select        | reg <240>            | 0: LUT2_0<br>1: DFF0                 |

**Table 24. DFF1 Register Settings**

| Signal Function              | Register Bit Address | Register Definition                  |
|------------------------------|----------------------|--------------------------------------|
| DFF1 or Latch select         | reg <228>            | 0: DFF function<br>1: Latch function |
| DFF1 output select           | reg <229>            | 0: Q output<br>1: nQ output          |
| DFF1 initial polarity select | reg <230>            | 0: Low<br>1: High                    |
| LUT2_1 data                  | reg <239:236>        | LUT2_1 data                          |
| LUT2_1 or DFF1 select        | reg <241>            | 0: LUT2_1<br>1: DFF1                 |







## 10.2.1 3-Bit LUT or D Flip-Flop Macrocells Used as 3-Bit LUTs

Table 25. 3-bit LUT0 Truth Table.

| IN2 | IN1 | IN0 | OUT       |
|-----|-----|-----|-----------|
| 0   | 0   | 0   | reg <242> |
| 0   | 0   | 1   | reg <243> |
| 0   | 1   | 0   | reg <244> |
| 0   | 1   | 1   | reg <245> |
| 1   | 0   | 0   | reg <246> |
| 1   | 0   | 1   | reg <247> |
| 1   | 1   | 0   | reg <248> |
| 1   | 1   | 1   | reg <249> |

Table 26. 3-bit LUT1 Truth Table.

| IN2 | IN1 | IN0 | OUT       |
|-----|-----|-----|-----------|
| 0   | 0   | 0   | reg <250> |
| 0   | 0   | 1   | reg <251> |
| 0   | 1   | 0   | reg <252> |
| 0   | 1   | 1   | reg <253> |
| 1   | 0   | 0   | reg <254> |
| 1   | 0   | 1   | reg <255> |
| 1   | 1   | 0   | reg <256> |
| 1   | 1   | 1   | reg <257> |

Each Macrocell, when programmed for a LUT function, uses a 8-bit register to define their output function:

*3-Bit LUT2 is defined by reg <249:242>*

*3-Bit LUT3 is defined by reg <257:250>*



## 10.2.2 3-Bit LUT or D Flip-Flop Macrocells Used as D Flip-Flop Register Settings

Table 27. DFF2 Register Settings

| Signal Function              | Register Bit Address | Register Definition                                  |
|------------------------------|----------------------|--|
| DFF2 or Latch select         | reg <242>            | 0: DFF function<br>1: Latch function                 |
| DFF2 output select           | reg <243>            | 0: Q output<br>1: nQ output                          |
| DFF2 initial polarity select | reg <244>            | 0: Low<br>1: High                                    |
| DFF2 rstb/setb Select        | reg <245>            | 1: setb from matrix out<br>0: resetb from matrix out |
| LUT3_0 data                  | reg <265:258>        | LUT3_0 data  |
| LUT3_0 or DFF2 select        | reg <282>            | 0: LUT3_0<br>1: DFF2                                 |

Table 28. DFF3 Register Settings

| Signal Function              | Register Bit Address | Register Definition                                  |
|------------------------------|----------------------|--|
| DFF3 or Latch Select         | reg <250>            | 0: DFF function<br>1: Latch function                 |
| DFF3 Output Select           | reg <251>            | 0: Q output<br>1: nQ output                          |
| DFF3 rstb/setb Select        | reg <252>            | 1: setb from matrix out<br>0: resetb from matrix out |
| DFF3 initial polarity select | reg <253>            | 0: Low<br>1: High                                    |
| LUT3_1 data                  | reg <273:266>        | LUT3_1 data  |
| LUT3_1 or DFF3 select        | reg <283>            | 0: LUT3_1<br>1: DFF3                                 |



### 10.3 3-Bit LUT or Pipe Delay Macrocell

There is one macrocell that can serve as either a 3-bit LUT or as a Pipe Delay.

When used to implement LUT functions, the 3-bit LUT take in three input signals from the connection matrix and produces a single output, which goes back into the connection matrix.

When used as an 8-stage pipe delay, there are three inputs signals from the matrix, Input (IN), Clock (CLK) and Reset (RST). The pipe delay cell is built from D Flip-Flop logic cells that provide the three delay options, two of which are user selectable. The DFF cells are tied in series where the output (Q) of each delay cell goes to the next DFF cell. The first delay option (OUT2) is fixed at the output of the first flip-flop stage. The other two outputs (OUT0 and OUT1) provide user selectable options for 1 to 8 stages of delay There are delay output points for each set of the OUT0 and OUT1 outputs to a 3-input mux that is controlled by reg <666:663> for OUT0 and reg <670:667> for OUT1. The 3-input mux is used to control the selection of the amount of delay.

The overall time of the delay is based on the clock used in the SLG46116 design. Each DFF cell has a time delay of the inverse of the clock time (either external clock or the RC Oscillator within the SLG46116). The sum of the number of DFF cells used will be the total time delay of the Pipe Delay logic cell.

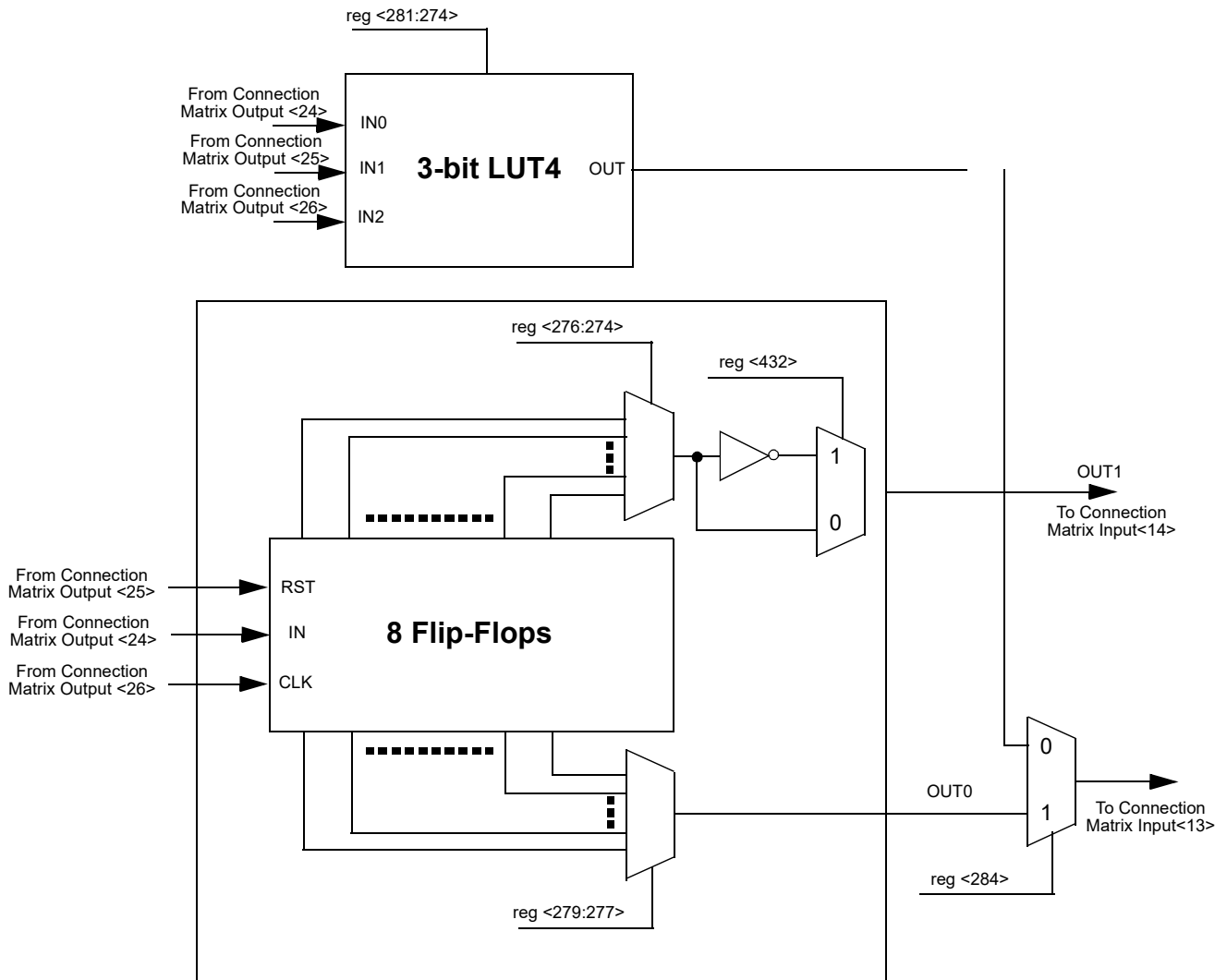


Figure 13. 3-bit LUT4 or Pipe Delay



### 10.3.1 3-Bit LUT or Pipe Delay Macrocells Used as 3-Bit LUTs

Table 29. 3-bit LUT4 Truth Table.

| IN2 | IN1 | IN0 | OUT       |
|-----|-----|-----|-----------|
| 0   | 0   | 0   | reg <274> |
| 0   | 0   | 1   | reg <275> |
| 0   | 1   | 0   | reg <276> |
| 0   | 1   | 1   | reg <277> |
| 1   | 0   | 0   | reg <278> |
| 1   | 0   | 1   | reg <279> |
| 1   | 1   | 0   | reg <280> |
| 1   | 1   | 1   | reg <281> |

Each Macrocell, when programmed for a LUT function, uses a 8-bit register to define their output function:

*3-Bit LUT4 is defined by reg <281:274>*

### 10.3.2 3-Bit LUT or Pipe Delay Macrocells Used as Pipe Delay Register Settings

Table 30. Pipe Delay Register Settings

| Signal Function                    | Register Bit Address | Register Definition        |
|------------------------------------|----------------------|----------------------------|
| OUT0 select                        | reg <276:274>        | data (pipe number)         |
| OUT1 select                        | reg <279:277>        | data (pipe number)         |
| LUT3_4 or pipe delay output select | reg <284>            | 0: LUT3_4<br>1: pipe delay |



## 10.4 4-Bit LUT or 8- Bit Counter / Delay Macrocells

There is one macrocell that can serve as either a 4-bit LUT or as a Counter / Delay. When used to implement LUT functions, the 4-bit LUT takes in four input signals from the connection matrix and produces a single output, which goes back into the connection matrix. When used to implement 8-Bit Counter / Delay function, two of the four input signals from the connection matrix go to the external clock (ext\_clk) and reset (DLY\_n/CNT\_Reset) for the counter/delay, with the output going back to the connection matrix.

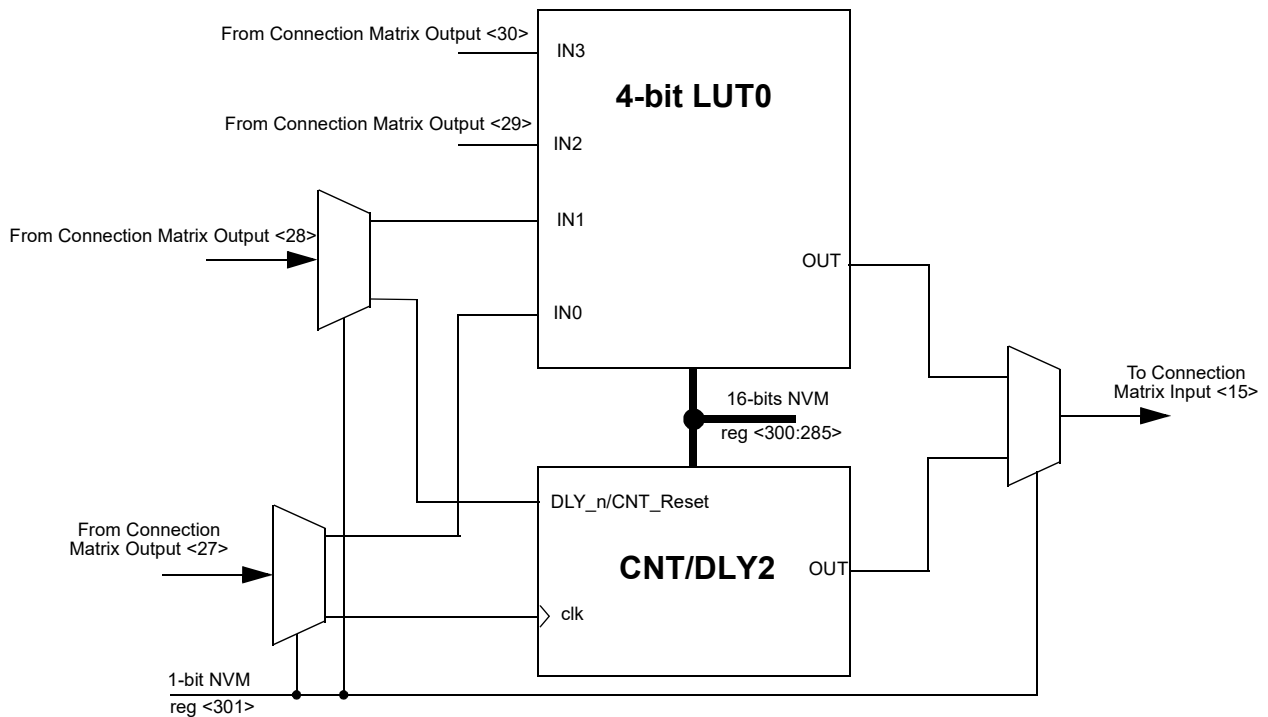


Figure 14. 4-bit LUT0 or CNT/DLY2



### 10.4.1 4-Bit LUT or 8-Bit Counter / Delay Macrocell Used as 4-Bit LUTs

Table 31. 4-bit LUT0 Truth Table.

| IN3 | IN2 | IN1 | IN0 | OUT       |
|-----|-----|-----|-----|-----------|
| 0   | 0   | 0   | 0   | reg <285> |
| 0   | 0   | 0   | 1   | reg <286> |
| 0   | 0   | 1   | 0   | reg <287> |
| 0   | 0   | 1   | 1   | reg <288> |
| 0   | 1   | 0   | 0   | reg <289> |
| 0   | 1   | 0   | 1   | reg <290> |
| 0   | 1   | 1   | 0   | reg <291> |
| 0   | 1   | 1   | 1   | reg <292> |
| 1   | 0   | 0   | 0   | reg <293> |
| 1   | 0   | 0   | 1   | reg <294> |
| 1   | 0   | 1   | 0   | reg <295> |
| 1   | 0   | 1   | 1   | reg <296> |
| 1   | 1   | 0   | 0   | reg <297> |
| 1   | 1   | 0   | 1   | reg <298> |
| 1   | 1   | 1   | 0   | reg <299> |
| 1   | 1   | 1   | 1   | reg <300> |

Each Macrocell, when programmed for a LUT function, uses a 16-bit register to define their output function:

*4-Bit LUT0 is defined by reg <300:285>*



## 10.4.2 4-Bit LUT or 8-Bit Counter / Delay Macrocells Used as 8-Bit Counter / Delay Register Settings

Table 32. CNT/DLY2 Register Settings

| Signal Function                                  | Register Bit Address | Register Definition   |
|--|----------------------|---|
| Counter/delay2 Mode Selection                    | reg <285>            | 0: Delay Mode<br>1: Counter Mode  |
| Counter/delay2 Clock Source Select               | reg <288:286>        | 000: Internal OSC Clock<br>001: OSC/4<br>010: OSC/12<br>011: OSC/24<br>100: OSC/64<br>101: External Clock<br>110: External Clock<br>111: Counter1 Overflow  |
| Counter/delay2 Control Data                      | reg <296:289>        | 1 – 256 (delay time = (counter control data +2) /freq)  |
| Delay2 Mode Select or asynchronous counter reset | reg <298:297>        | 00: Delay on both falling and rising edges (for delay & counter reset)<br>01: Delay on falling edge only (for delay & counter reset)<br>10: on rising edge only (for delay & counter reset)<br>11: No delay on either falling or rising edges / high level reset for counter mode |
| LUT4_0 or Counter2 select                        | reg <301>            | 0: LUT4_0<br>1: Counter2  |



## 11.0 Analog Comparators (ACMP)

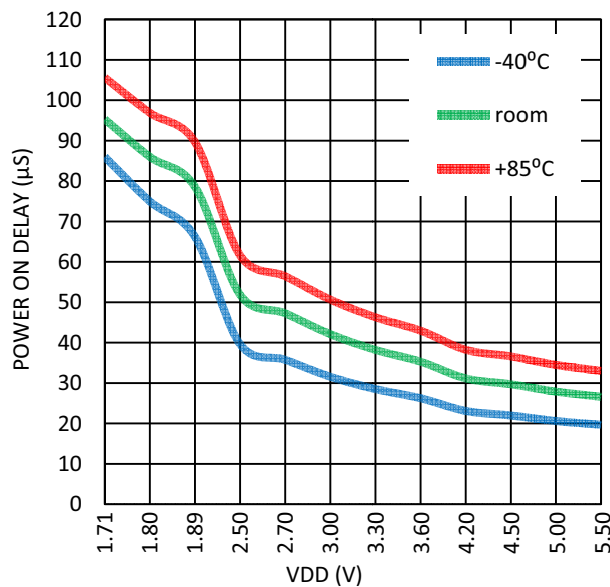
There are two Analog Comparator (ACMP) macrocells in the SLG46116. In order for the ACMP cells to be used in a GreenPAK design, the power up signals (ACMP0\_pdb and ACMP1\_pdb) need to be active. By connecting to signals coming from the Connection Matrix, it is possible to have each ACMP be on continuously, off continuously, or switched on periodically based on a digital signal coming from the Connection Matrix. When ACMP is powered down, output is low.

Each of the ACMP cells has a positive input signal that can be provided by a variety of external sources, and can also have a selectable gain stage before connection to the analog comparator. Each of the ACMP cells has a negative input signal that is either created from an internal VREF or provided by way of the external sources.

Each of the ACMP cells has a selection for the bandwidth of the input signal, which can be used to save power when low bandwidth signals are input into the analog comparator. And if input frequency > 200 kHz, the output will retain its previous value. Each cell also has a hysteresis selection, to offer hysteresis of 0 mV, 25 mV, 50 mV or 200 mV.

During powerup, the ACMP output will remain low, and then become valid 110  $\mu$ s (max) after POR signal goes high, see *Figure 15*.

*Note: Regulator and Charge Pump set to automatic ON/OFF.*



**Figure 15. Maximum Power On Delay vs. VDD.**

Each of the ACMP cells has a positive input signal that can be provided by a variety of external sources, and can also have a selectable gain stage (1X, 0.5X, 0.33X, 0.25X) before connection to the analog comparator. The Gain divider is unbuffered and consists of 250 K $\Omega$  (typ.) resistors, see *Table 33*. For gain divider accuracy refer to *Table 34*. IN- voltage range: 0 - 1.2 V. Can use Vref selection VDD/4 and VDD/3 to maintain this input range.

**Table 33. Gain Divider Input Resistance (typ).**

| Gain             | 1X   | 0.5X | 0.33X | 0.25X |
|------------------|------|------|-------|-------|
| Input Resistance | 100M | 1M   | 0.75M | 1M    |

**Table 34. Gain Divider Accuracy.**

| Gain     | 0.5X        | 0.33X       | 0.25X       |
|----------|-------------|-------------|-------------|
| Accuracy | $\pm 0.6\%$ | $\pm 0.9\%$ | $\pm 2.8\%$ |





Each of the ACMP cells has a negative input signal that is either created from an internal VREF or provided by the external reference/source. Internal Vref accuracy is optimized near 1000 mV selection.

*Note: Power supply control options have influence on the ACMP operation.*

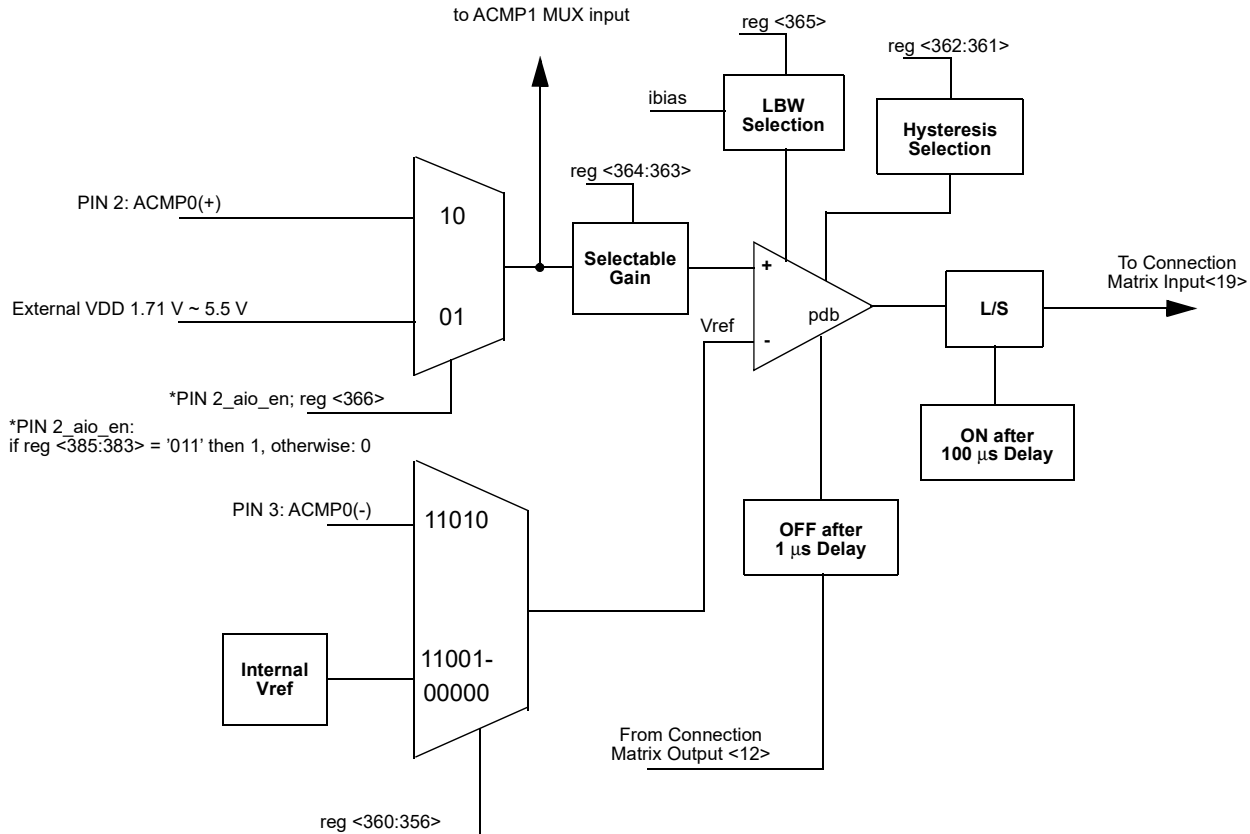
*Note: Any ACMP powered on enables the BandGap internal circuit as well. An analog voltage will appear on Vref (even when the Force BandGap option is set as Disabled).*

Analog comparators have the following configurable options:

- Hysteresis: Input signal hysteresis options are Disable, 25 mV, 50 mV, 200 mV.
- Low Bandwidth: Enable, Disable;
- IN+ Gain: 1X, 0.5X, 0.33X, 0.25X;
- IN+ source:
  - ACMP0 IN+ options are PIN 3, VDD;
  - ACMP1 IN+ options are PIN 6, ACMP0 IN+;
- IN- source:
  - ACMP0 IN- options are 24 internal reference sources (50 mV – 1200 mV) and VDD/3, VDD/4, PIN 4;
  - PWR UP=0 – ACMP is powered down; PWR UP=1 – ACMP is powered up.

All ACMPs can have a common negative input. This can be achieved by configuring ACMP0 PIN 4 analog I/O connection.

### 11.1 ACMP0 Block Diagram





## 11.2 ACMP0 Register Settings

Table 35. ACMP0 Register Settings

| Signal Function                                  | Register Bit Address | Register Definition   |
|--|----------------------|---|
| ACMP0 In Voltage Select                          | reg <360:356>        | 00000: 50 mV    00001: 100 mV<br>00010: 150 mV    00011: 200 mV<br>00100: 250 mV    00101: 300 mV<br>00110: 350 mV    00111: 400 mV<br>01000: 450 mV    01001: 500 mV<br>01010: 550 mV    01011: 600 mV<br>01100: 650 mV    01101: 700 mV<br>01110: 750 mV    01111: 800 mV<br>10000: 850 mV    10001: 900 mV<br>10010: 950 mV    10011: 1 V<br>10100: 1.05 V    10101: 1.1 V<br>10110: 1.15 V    10111: 1.2 V<br>11000: VDD/3    11001: VDD/4<br>11010: EXT_VREF (PIN 3) |
| ACMP0 Hysteresis Enable                          | reg <362:361>        | 00: Disabled (0 mV)<br>01: Enabled (25 mV)<br>10: Enabled (50 mV)<br>11: Enabled (200 mV)   |
| ACMP0 Positive Input Divider                     | reg <364:363>        | 00: 1.00X<br>01: 0.50X<br>10: 0.33X<br>11: 0.25X  |
| ACMP0 Low Bandwidth (Max: 1 MHz) Enable          | reg <365>            | 0: Off<br>1: On   |
| ACMP0 positive input source select PIN 2 and VDD | reg <366>            | 0: PIN 2<br>1: VDD  |



11.3 ACMP1 Block Diagram

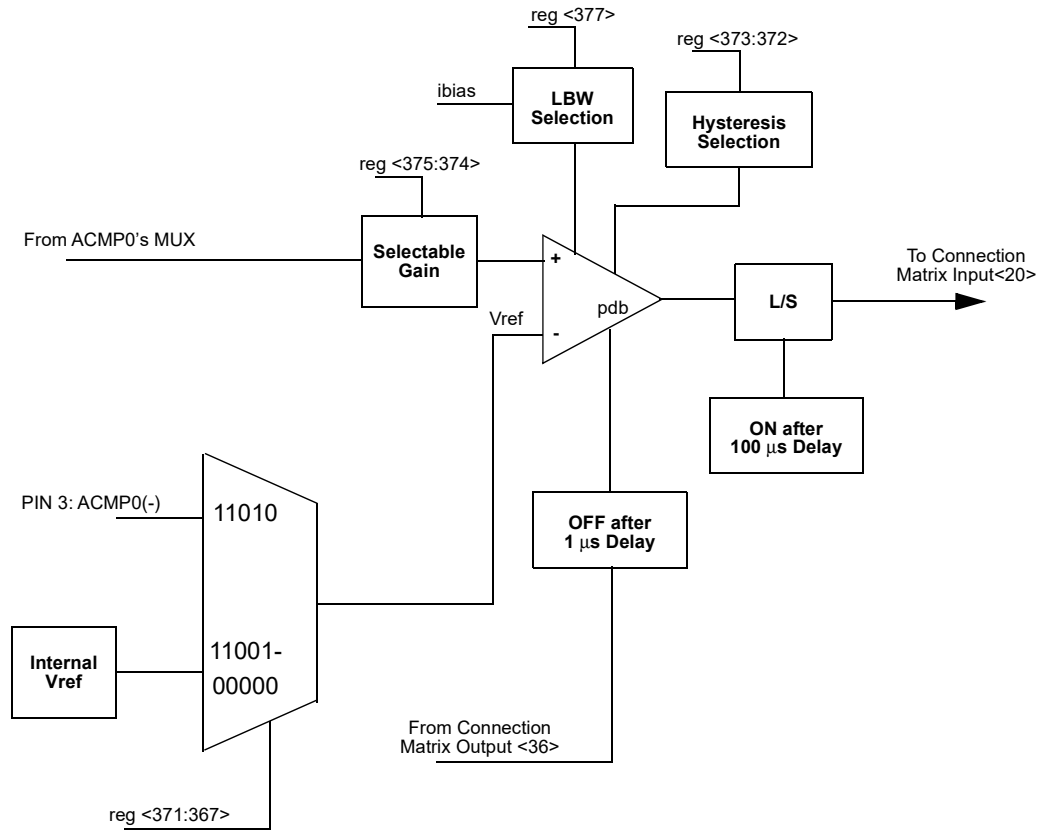


Figure 17. ACMP1 Block Diagram



## 11.4 ACMP1 Register Settings

Table 36. ACMP1 Register Settings

| Signal Function                         | Register Bit Address | Register Definition   |
|---|----------------------|---|
| ACMP1 In Voltage Select                 | reg <371:367>        | 00000: 50 mV    00001: 100 mV<br>00010: 150 mV    00011: 200 mV<br>00100: 250 mV    00101: 300 mV<br>00110: 350 mV    00111: 400 mV<br>01000: 450 mV    01001: 500 mV<br>01010: 550 mV    01011: 600 mV<br>01100: 650 mV    01101: 700 mV<br>01110: 750 mV    01111: 800 mV<br>10000: 850 mV    10001: 900 mV<br>10010: 950 mV    10011: 1 V<br>10100: 1.05 V    10101: 1.1 V<br>10110: 1.15 V    10111: 1.2 V<br>11000: VDD/3    11001: VDD/4<br>11010: EXT_VREF (PIN 3) |
| ACMP1 Hysteresis Enable                 | reg <373:372>        | 00: Disabled (0 mV)<br>01: Enabled (25 mV)<br>10: Enabled (50 mV)<br>11: Enabled (200 mV)   |
| ACMP1 Positive Input Divider            | reg <375:374>        | 00: 1.00X<br>01: 0.50X<br>10: 0.33X<br>11: 0.25X  |
| ACMP1 Low Bandwidth (Max: 1 MHz) Enable | reg <377>            | 1: On<br>0: Off   |



## 11.5 Typical Performance Characteristics

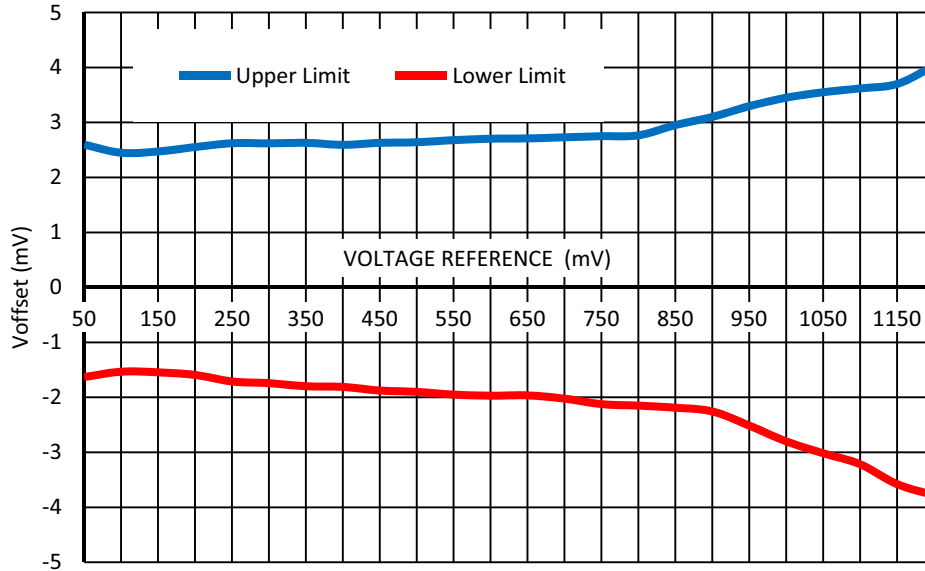


Figure 18. Typical Input Voltage Offset vs. Voltage Reference at room temperature, LBW Mode – Disable,  $V_{hys}=0$  mV,  $VDD=(1.7 - 5.5)$  V.

Note: when  $VDD < 1.8V$  voltage reference should not exceed 1100 mV.

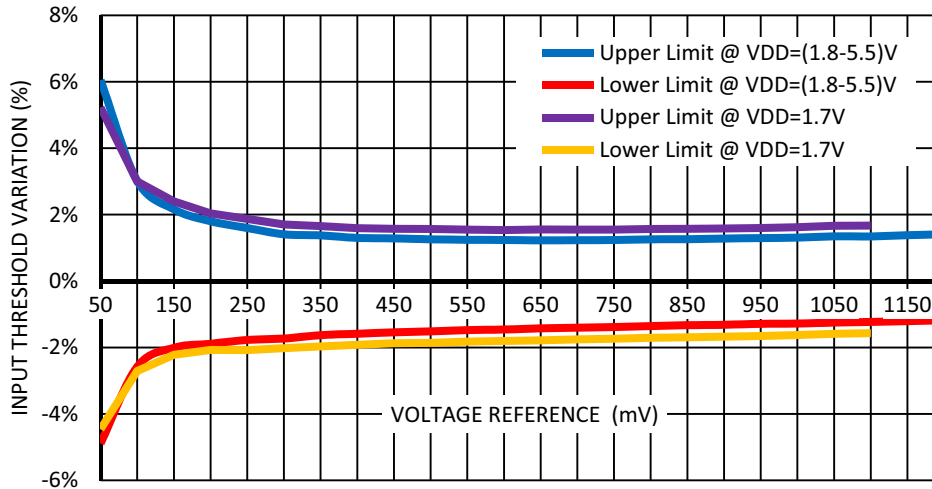


Figure 19. Typical Input Threshold Variation (including  $V_{ref}$  variation, ACMP offset) vs. Voltage reference at room temperature, LBW Mode – Disable,  $V_{hys}=0$  mV.

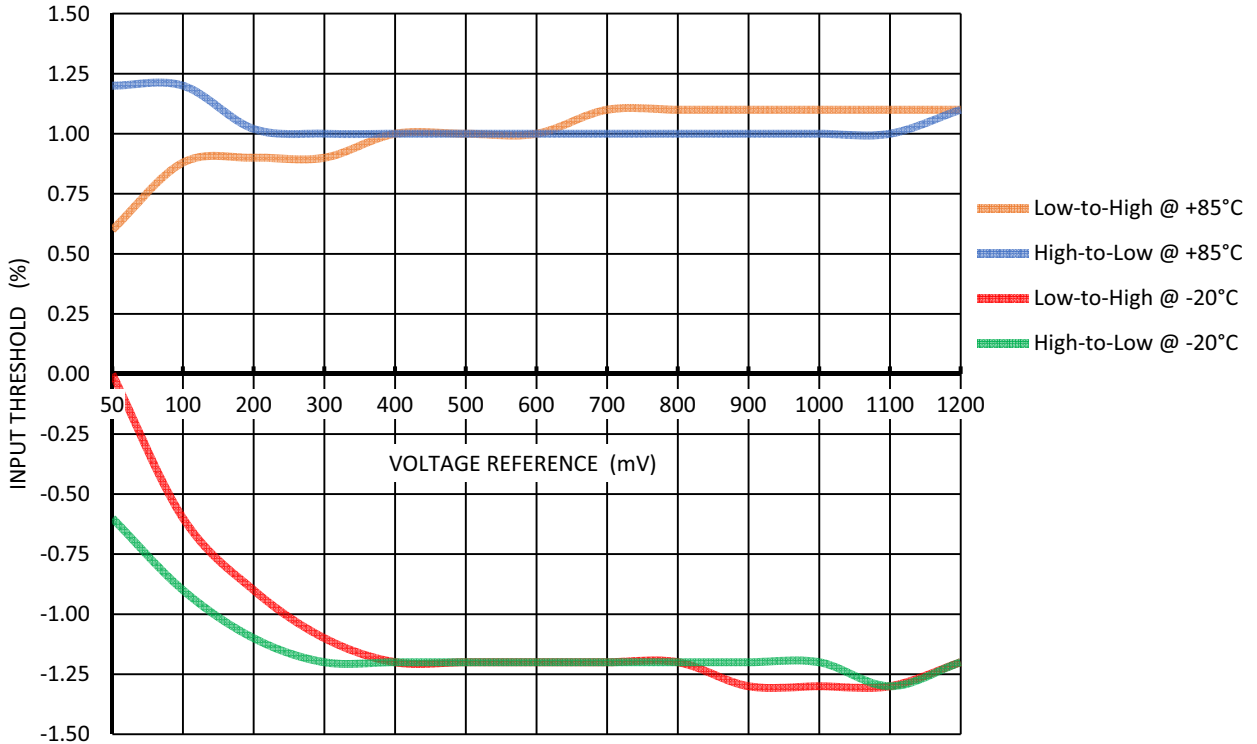


Figure 20. Input Threshold Ratio vs. Voltage Reference at VDD = (1.71 - 5.5) V, V<sub>hys</sub> = 0, Gain = 1

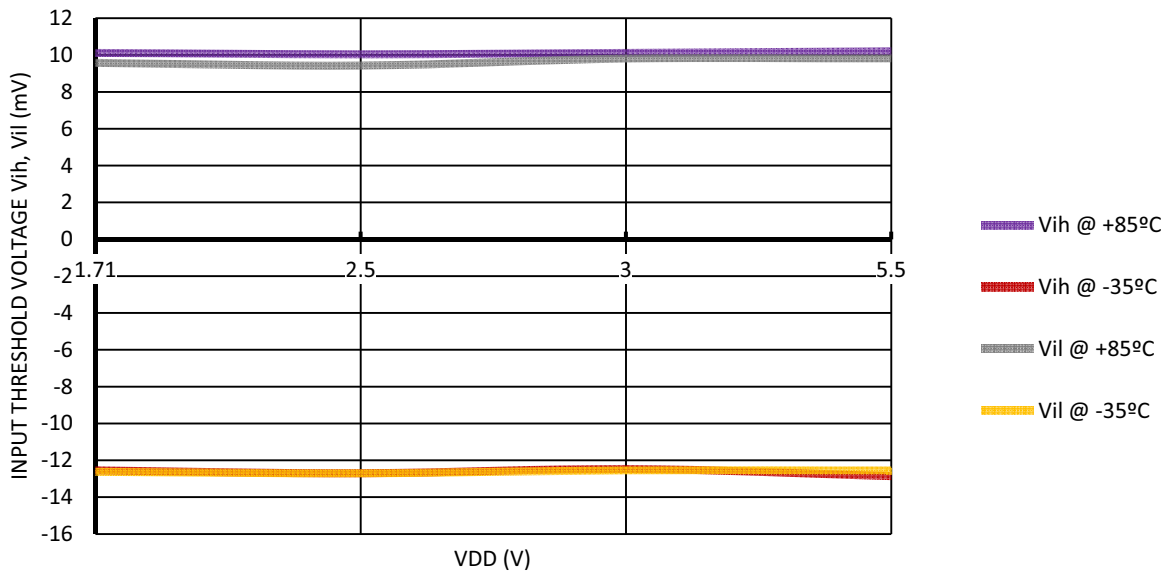


Figure 21. Input Threshold Voltage V<sub>ih</sub>, V<sub>il</sub> vs. VDD at V<sub>ref</sub> = 1000 mV, Gain = 1

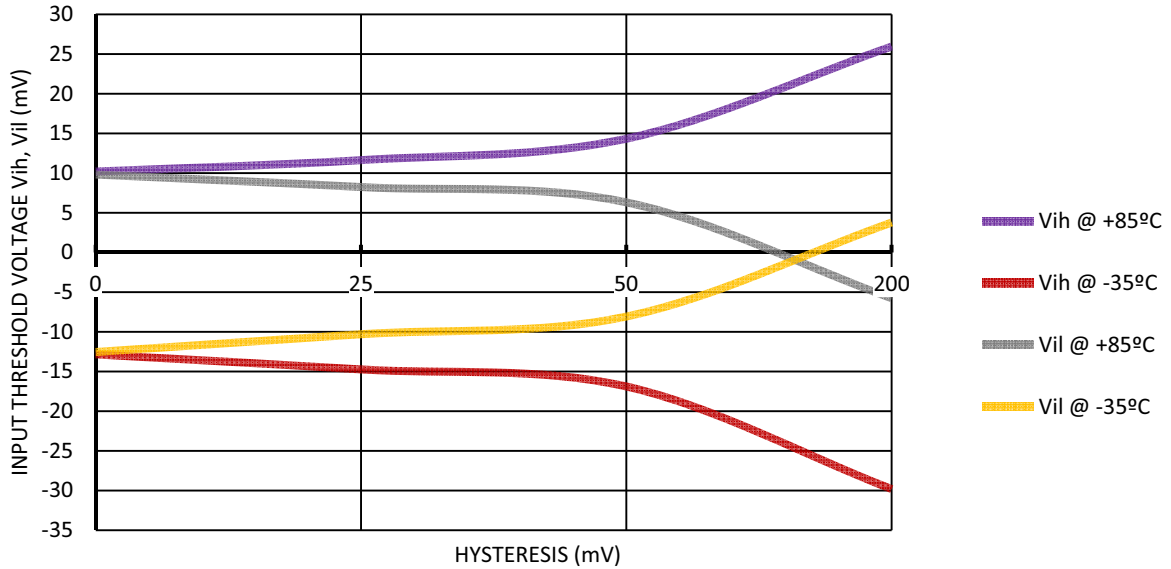


Figure 22. Input Threshold Voltage  $V_{ih}$ ,  $V_{il}$  vs. Hysteresis at  $V_{DD} = 5.5\text{ V}$ ,  $V_{ref} = 1000\text{ mV}$ . Gain = 1

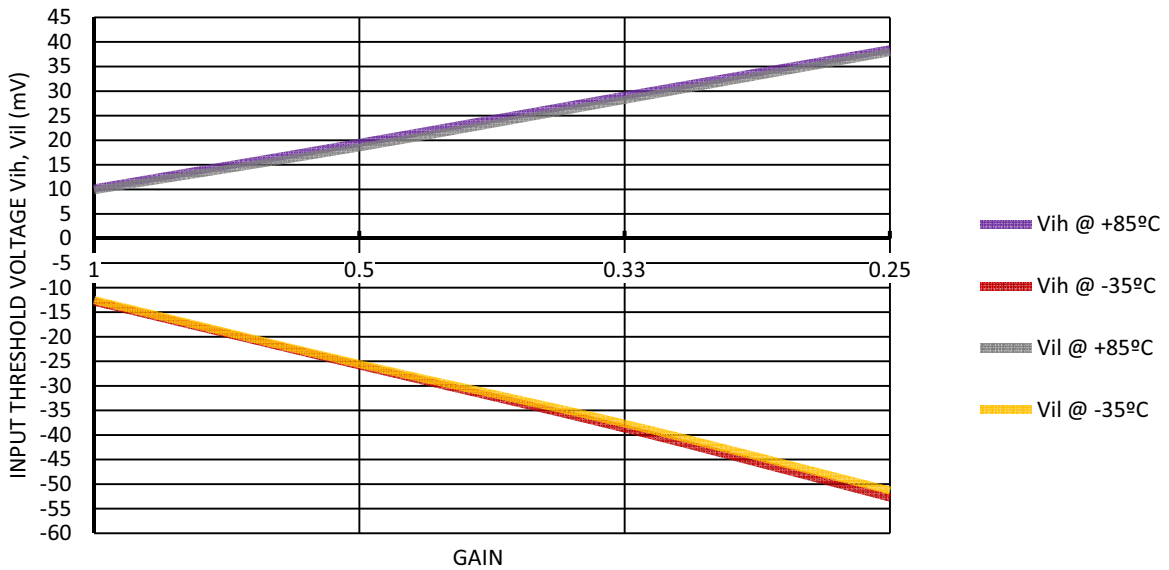


Figure 23. Input Threshold Voltage  $V_{ih}$ ,  $V_{il}$  vs. Gain at Hysteresis = 0,  $V_{DD} = 5.5\text{ V}$ ,  $V_{ref} = 1000\text{ mV}$

Table 37. Built-in Hysteresis Tolerance.

| V <sub>hys</sub> (mV) | V <sub>DD</sub> =(1.7-1.8) V   |       |                                  |       |                                   |       | V <sub>DD</sub> =(1.89-5.5) V  |       |                                  |       |                                   |       |
|-----------------------|--------------------------------|-------|----------------------------------|-------|-----------------------------------|-------|--------------------------------|-------|----------------------------------|-------|-----------------------------------|-------|
|                       | V <sub>ref</sub> = (50-500) mV |       | V <sub>ref</sub> = (550-1000) mV |       | V <sub>ref</sub> = (1050-1200) mV |       | V <sub>ref</sub> = (50-500) mV |       | V <sub>ref</sub> = (550-1000) mV |       | V <sub>ref</sub> = (1050-1200) mV |       |
|                       | min                            | max   | min                              | max   | min                               | max   | min                            | max   | min                              | max   | min                               | max   |
| 25                    | 18.9                           | 26.4  | 17.3                             | 26.1  | 13.0                              | 24.6  | 18.8                           | 26.5  | 17.8                             | 26.1  | 15.6                              | 25.5  |
| 50                    | 40.3                           | 50.4  | 37.9                             | 50.1  | 28.9                              | 47.7  | 40.3                           | 50.5  | 39.5                             | 50.1  | 34.5                              | 49.5  |
| 200                   | 180.5                          | 208.4 | 172.9                            | 210.7 | 153.5                             | 217.2 | 180.6                          | 207.7 | 180.2                            | 210.8 | 166.5                             | 211.9 |



## 11.6 Timing Characteristics

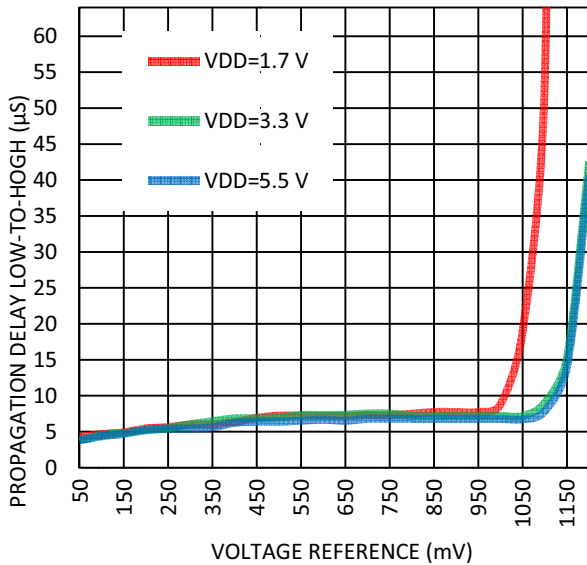


Figure 24. Maximum Propagation Delay Low-to-High vs. Voltage Reference at Room Temperature, Vod = 2 mV.

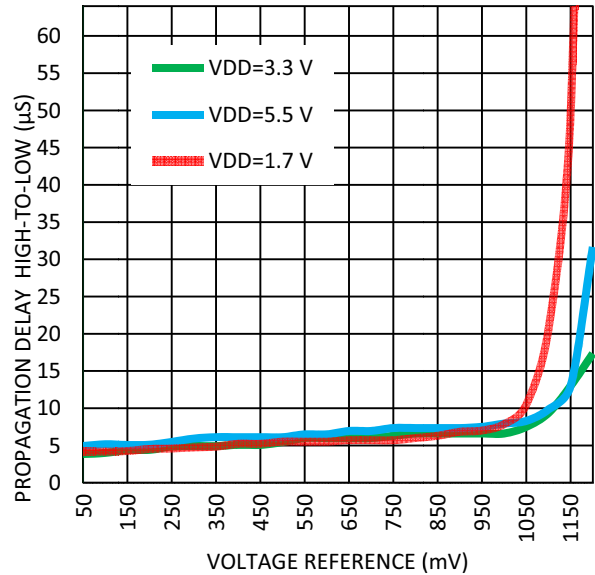


Figure 26. Maximum Propagation Delay High-to-Low vs. Voltage Reference at Room Temperature, Vod = 2 mV.

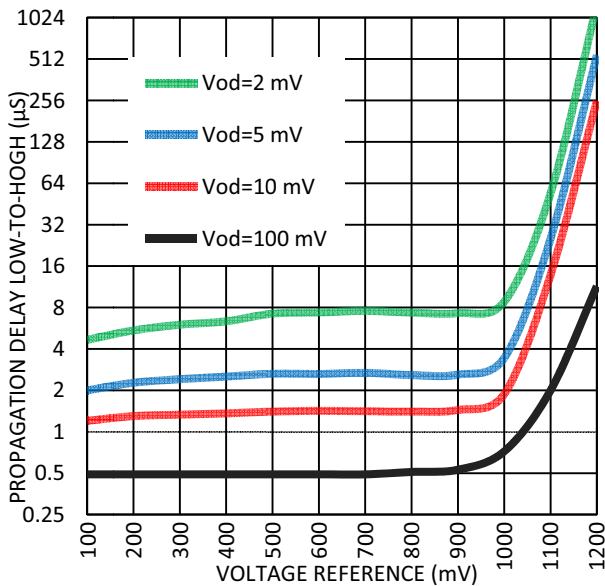


Figure 25. Maximum Propagation Delay Low-to-High vs. Voltage Reference at Room Temperature, VDD=(1.71 - 1.89) V.

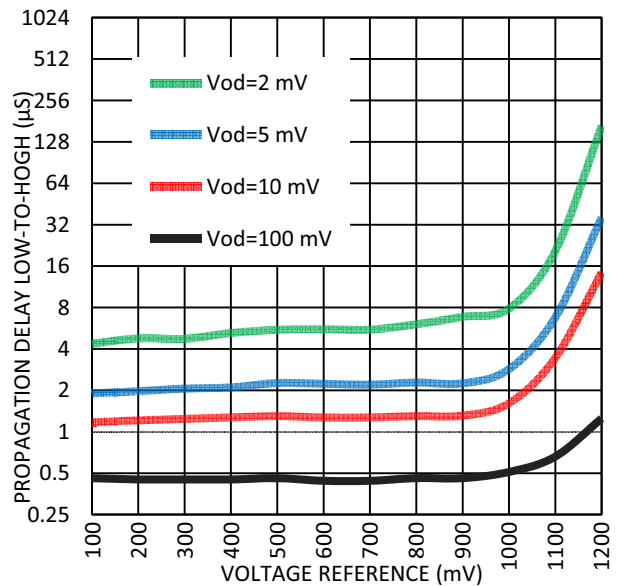


Figure 27. Maximum Propagation Delay High-to-Low vs. Voltage Reference at Room Temperature, VDD=(1.71 - 1.89) V.



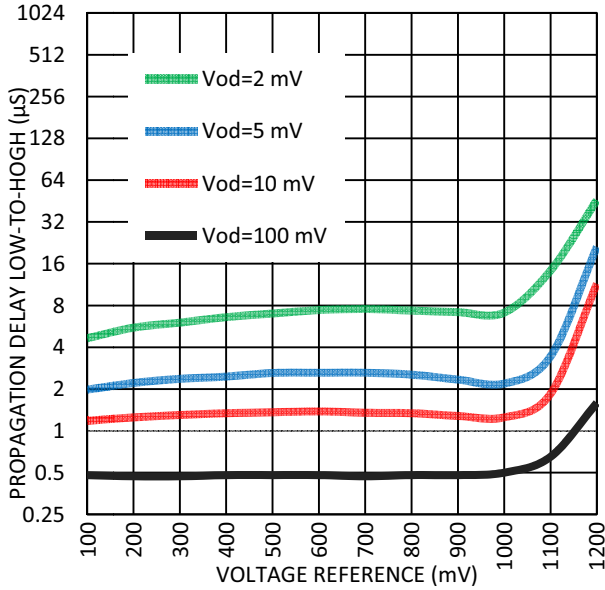


Figure 28. Maximum Propagation Delay Low-to-High vs. Voltage Reference at Room Temperature, VDD = (1.89 – 3.6) V.

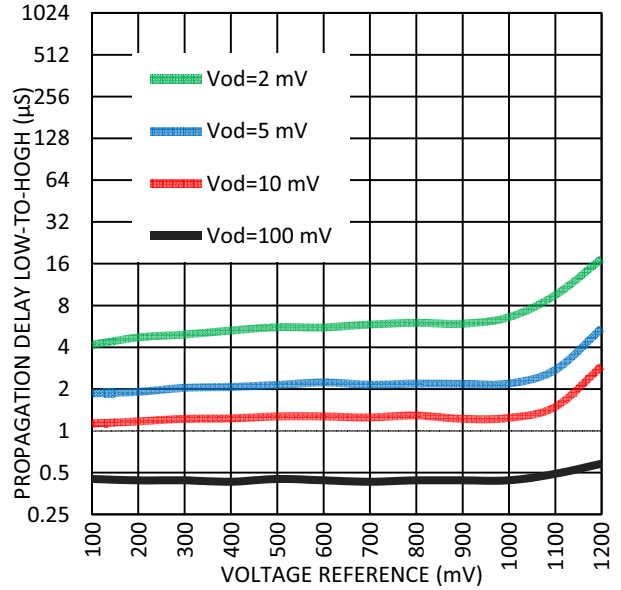


Figure 30. Maximum Propagation Delay High-to-Low vs. Voltage Reference at Room Temperature, VDD = (1.89 – 3.6) V.

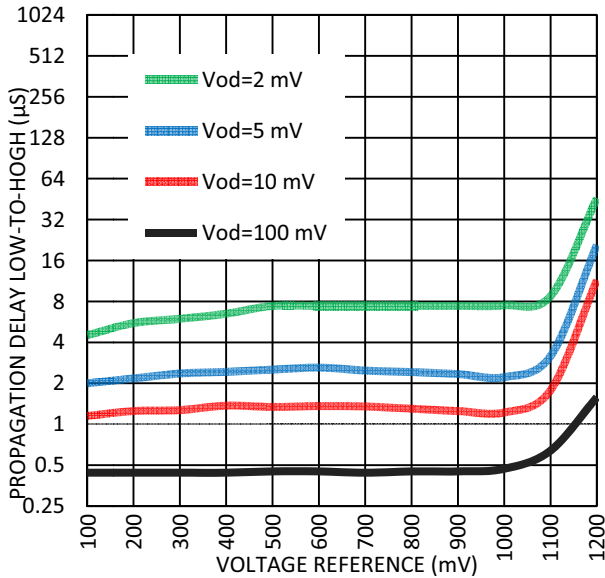


Figure 29. Maximum Propagation Delay Low-to-High vs. Voltage Reference at Room Temperature, VDD = (3.6 – 5.5) V.

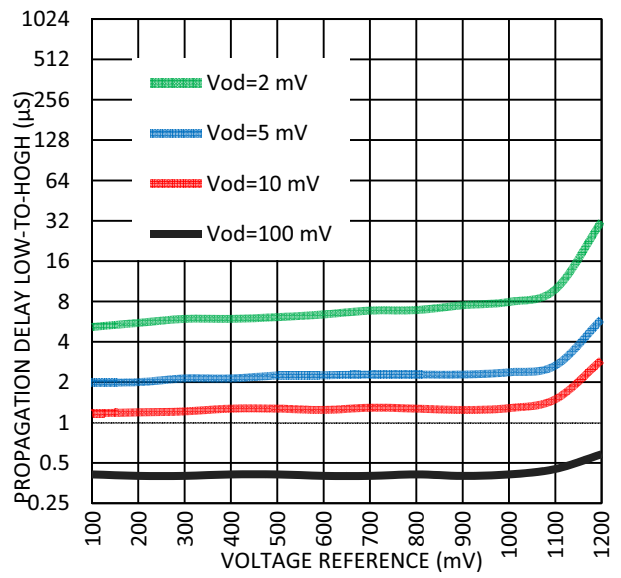


Figure 31. Maximum Propagation Delay High-to-Low vs. Voltage Reference at Room Temperature, VDD = (3.6 – 5.5) V.



## 12.0 Counters/Delay Generators (CNT/DLY)

There are three configurable counters/delay generators in the SLG46116. The three counters/delay generators (CNT/DLY 0, 1, 3) are 8-bit. For flexibility, each of these macrocells has a large selection of internal and external clock sources, as well as the option to chain from the output of the previous (N-1) CNT/DLY macrocell, to implement longer count / delay circuits.

Two of the counter/delay generator macrocells (CNT/DLY0 and CNT/DLY1) have two inputs from the connection matrix, one for Delay Input/Reset Input (Delay\_In/Reset\_In), and one for an external counter/clock source. One of the counter/delay generator macrocells (CNT/DLY3) has one input from the connection matrix, which has a shared function of either a Delay Input or an external clock input.

Note that there is also one Combination Function Macrocells that can implement either 4-bit LUTs or 8-bit counter / delays, For more information please see Section 10.4 4-Bit LUT or 8- Bit Counter / Delay Macrocells.

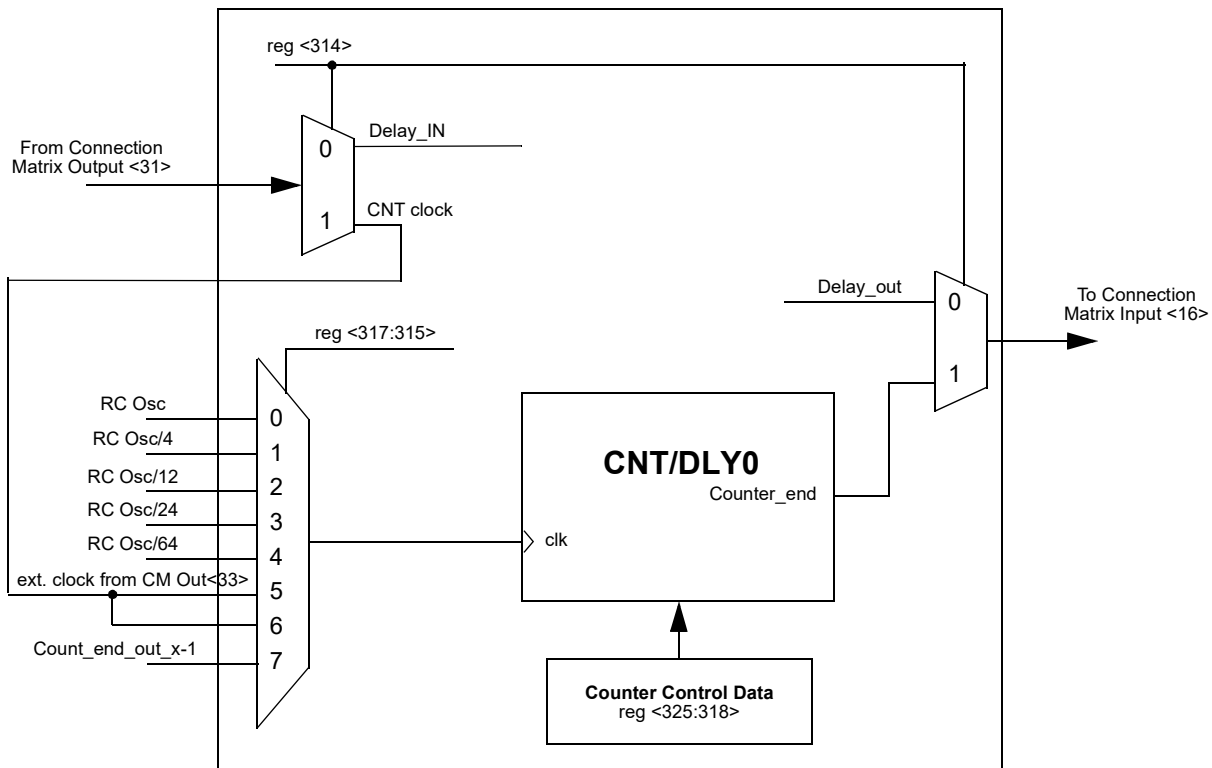


Figure 32. CNT/DLY0

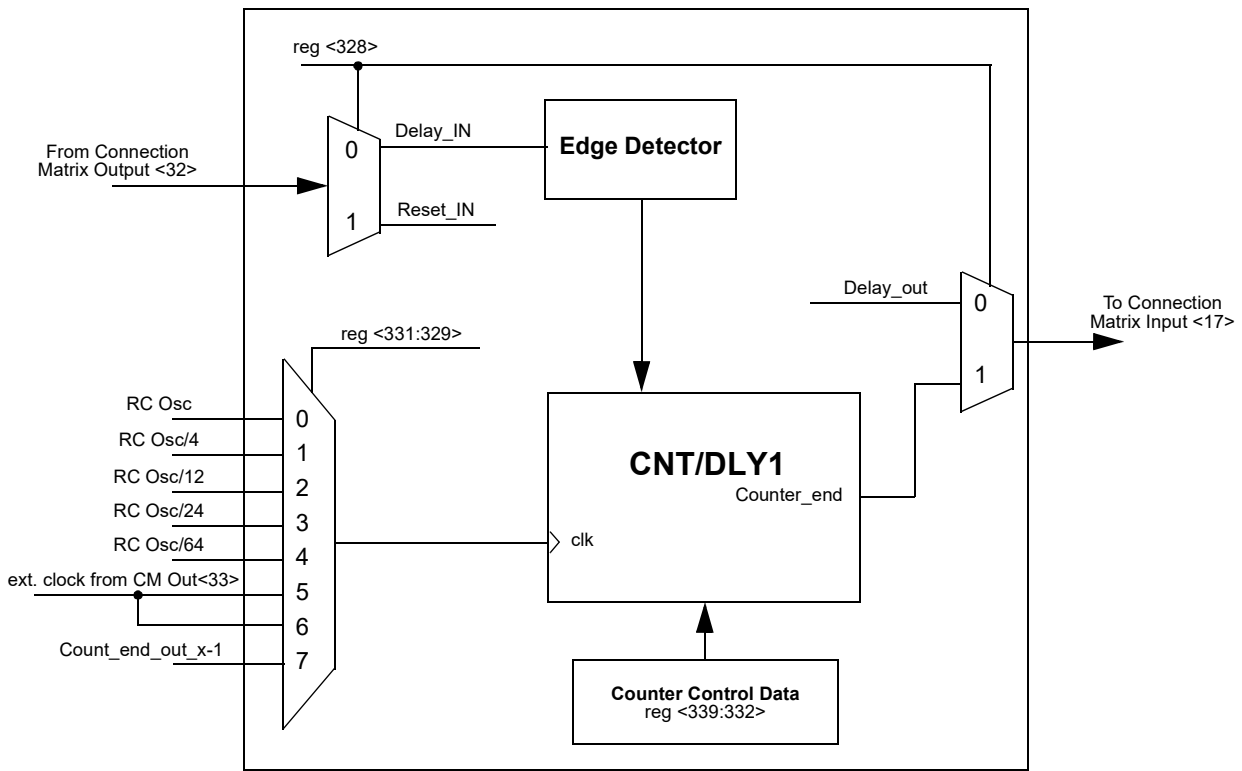


Figure 33. CNT/DLY1

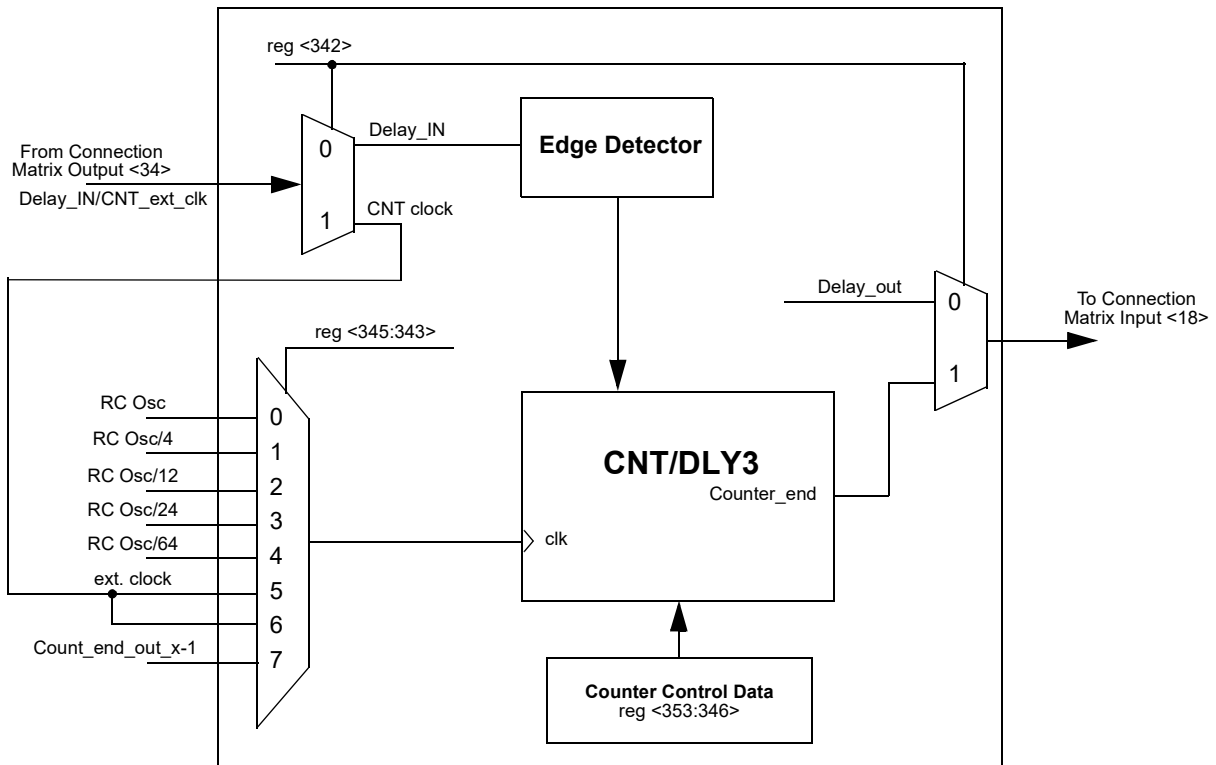


Figure 34. CNT/DLY3



## 12.1 CNT/DLY0 Register Settings

Table 38. CNT/DLY0 Register Settings

| Signal Function  | Register Bit Address | Register Definition  |
|--|----------------------|--|
| Counter/Delay0 Mode Select   | reg <314>            | 0: Delay Mode<br>1: Counter Mode   |
| Counter/Delay0 Clock Source Select (external clock is only for counter mode) | reg <317:315>        | 000: Internal OSC Clock<br>001: OSC/4<br>010: OSC/12<br>011: OSC/24<br>100: OSC/64<br>101: External Clock<br>110: Reserved<br>111: Counter3 Overflow   |
| Counter0 Control Data/Delay0 Time Control                                    | reg <325:318>        | 1-256: (delay time = (counter control data +2) /freq)  |
| Delay0 Mode Select or asynchronous counter reset                             | reg <327:326>        | 00: Delay on both falling and rising edges(for delay & counter reset)<br>01: Delay on falling edge only (for delay & counter reset)<br>10: Delay on rising edge only (for delay & counter reset)<br>11: No delay on either falling or rising edges / high level reset for counter mode |

## 12.2 CNT/DLY1 Register Settings

Table 39. CNT/DLY1 Register Settings

| Signal Function  | Register Bit Address | Register Definition  |
|--|----------------------|--|
| Counter/Delay1 Mode Select   | reg <328>            | 0: Delay Mode<br>1: Counter Mode   |
| Counter/Delay1 Clock Source Select (external clock is only for counter mode) | reg <331:329>        | 000: Internal OSC Clock<br>001: OSC/4<br>010: OSC/12<br>011: OSC/24<br>100: OSC/64<br>101: External Clock<br>110: Reserved<br>111: Counter0 Overflow   |
| Counter1 Control Data/Delay1 Time Control                                    | reg <339:332>        | 1-256: (delay time = (counter control data +2) /freq)  |
| Delay1 Mode Select or asynchronous counter reset                             | reg <341:340>        | 00: Delay on both falling and rising edges(for delay & counter reset)<br>01: Delay on falling edge only (for delay & counter reset)<br>10: Delay on rising edge only (for delay & counter reset)<br>11: No delay on either falling or rising edges / high level reset for counter mode |



## 12.3 CNT/DLY3 Register Settings

Table 40. CNT/DLY3 Register Settings

| Signal Function  | Register Bit Address | Register Definition   |
|--|----------------------|---|
| Counter/Delay3 Mode Select   | reg <342>            | 0: Delay Mode<br>1: Counter Mode  |
| Counter/Delay3 Clock Source Select (external clock is only for counter mode) | reg <345:343>        | 000: Internal OSC Clock<br>001: OSC/4<br>010: OSC/12<br>011: OSC/24<br>100: OSC/64<br>101: External Clock<br>110: Reserved<br>111: Reserved                     |
| Counter3 Control Data/Delay3 Time Control                                    | reg <353:346         | 1-256: (delay time = (counter control data +2) /freq)   |
| Delay3 Mode Select   | reg <355:354>        | 00: Delay on both falling and rising edges<br>01: Delay on falling edge only<br>10: Delay on rising edge only<br>11: No delay on either falling or rising edges |



### 13.0 Programmable Delay / Edge Detector

The SLG46116 has a programmable time delay logic cell available that can generate a delay that is selectable from one of four timings (time1) configured in the GreenPAK Designer. The programmable time delay cell can generate one of four different delay patterns, rising edge detection, falling edge detection, both edge detection and both edge delay. These four patterns can be further modified with the addition of delayed edge detection, which adds an extra unit of delay as well as glitch rejection during the delay period. See the timing diagrams below for further information.

Note: The input signal must be longer than the delay, otherwise it will be filtered out.

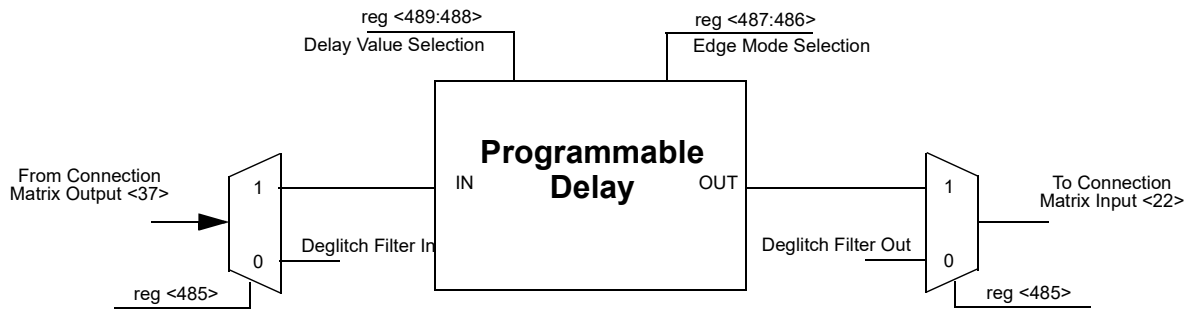


Figure 35. Programmable Delay

#### 13.1 Programmable Delay Timing Diagram - Edge Detector Output

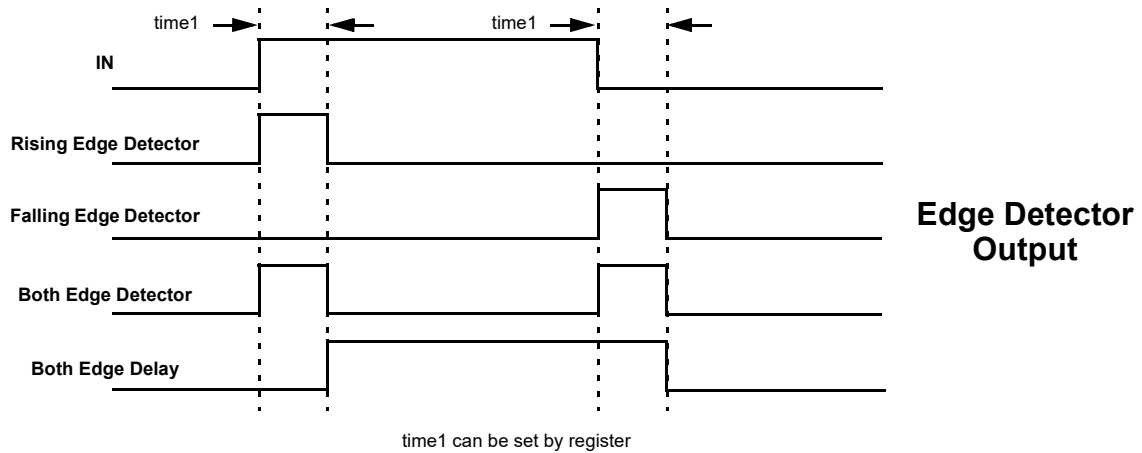


Figure 36. Edge Detector Output

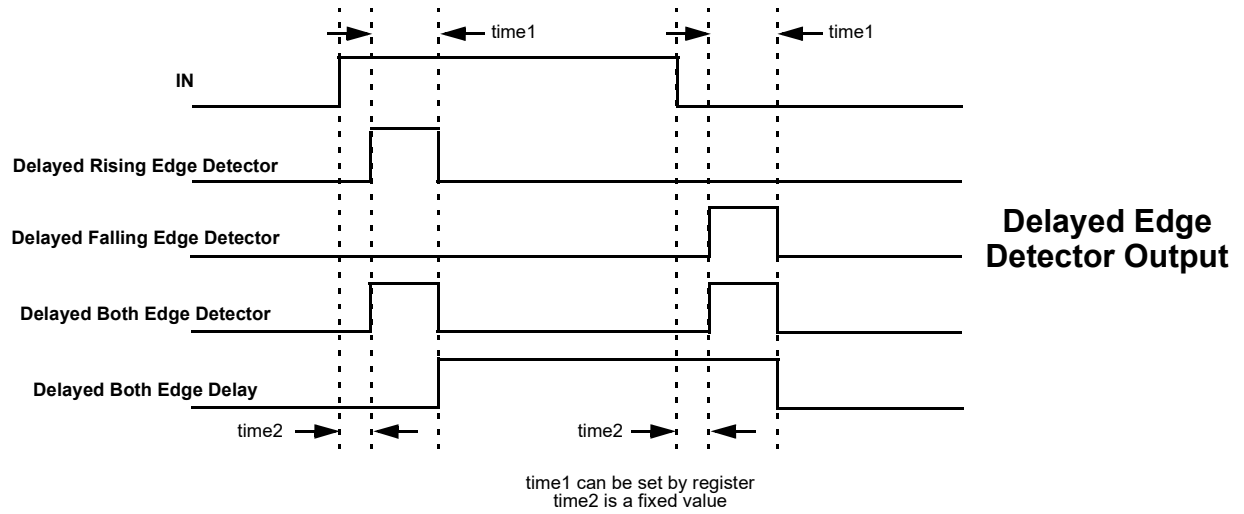


Figure 37. Delayed Edge Detector Output

Note: For delays and widths refer to *Table 4*.



## 13.2 Programmable Delay Register Settings

Table 41. Programmable Delay Register Settings

| Signal Function   | Register Bit Address | Register Definition  |
|---|----------------------|--|
| Programmable delay or filter output select  | reg <485>            | 0: programmable delay output<br>1: filter output   |
| Select the edge mode of programmable delay & edge detector                                | reg <487:486>        | 00: Rising Edge Detector<br>01: Falling Edge Detector<br>10: Both Edge Detector<br>11: Both Edge Delay |
| Delay value select for programmable delay & edge detector (VDD = 3.3V, typical condition) | reg <489:488>        | 00: 125 ns<br>01: 250 ns<br>10: 375 ns<br>11: 500 ns   |





### 14.0 Additional Logic Functions

The SLG46116 has an additional logic function that is connected directly to the Connection Matrix inputs and outputs. There is one deglitch filter.

#### 14.1 Deglitch Filter

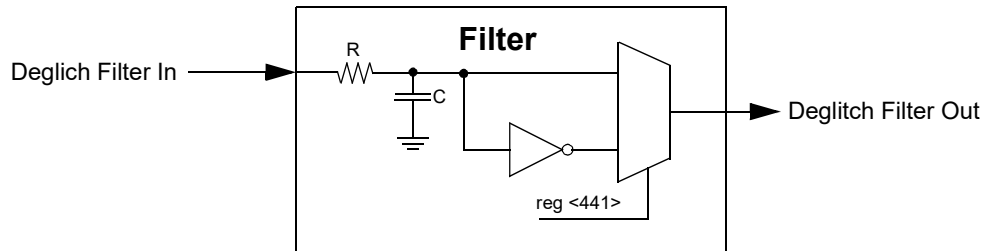


Figure 38. Deglitch Filter



## 15.0 Voltage Reference (VREF)

### 15.1 Voltage Reference Overview

The SLG46116 has a Voltage Reference Macrocell to provide references to the four analog comparators. This macrocell can supply a user selection of fixed voltage references,  $/3$  and  $/4$  reference off of the  $V_{DD}$  power supply to the device, and externally supplied voltage references from PIN 3. The macrocell also has the option to output reference voltages on PIN 12. See table below for the available selections for each analog comparator. Also see *Figure 39* below, which shows the reference output structure.

### 15.2 VREF Selection Table

Table 42. VREF Selection Table.

| SEL<4:0> | CMP0_VREF         | CMP1_VREF         |
|----------|-------------------|-------------------|
| 11010    | ext. Vref (PIN 3) | ext. Vref (PIN 3) |
| 11001    | VDD / 4           | VDD / 4           |
| 11000    | VDD / 3           | VDD / 3           |
| 10111    | 1.20              | 1.20              |
| 10110    | 1.15              | 1.15              |
| 10101    | 1.10              | 1.10              |
| 10100    | 1.05              | 1.05              |
| 10011    | 1.00              | 1.00              |
| 10010    | 0.95              | 0.95              |
| 10001    | 0.90              | 0.90              |
| 10000    | 0.85              | 0.85              |
| 01111    | 0.80              | 0.80              |
| 01110    | 0.75              | 0.75              |
| 01101    | 0.70              | 0.70              |
| 01100    | 0.65              | 0.65              |
| 01011    | 0.60              | 0.60              |
| 01010    | 0.55              | 0.55              |
| 01001    | 0.50              | 0.50              |
| 01000    | 0.45              | 0.45              |
| 00111    | 0.40              | 0.40              |
| 00110    | 0.35              | 0.35              |
| 00101    | 0.30              | 0.30              |
| 00100    | 0.25              | 0.25              |
| 00011    | 0.20              | 0.20              |
| 00010    | 0.15              | 0.15              |
| 00001    | 0.10              | 0.10              |
| 00000    | 0.05              | 0.05              |

| VDD           | Practical VREF Range | Note   |
|---------------|----------------------|--|
| 2.0 V - 5.5 V | 50 mV ~1.2 V         |  |
| 1.7 V - 2.0V  | 50 mV ~1.1 V         | Higher than 1.1 V negative input, the comparator may show wrong result |



## 15.3 VREF Block Diagram

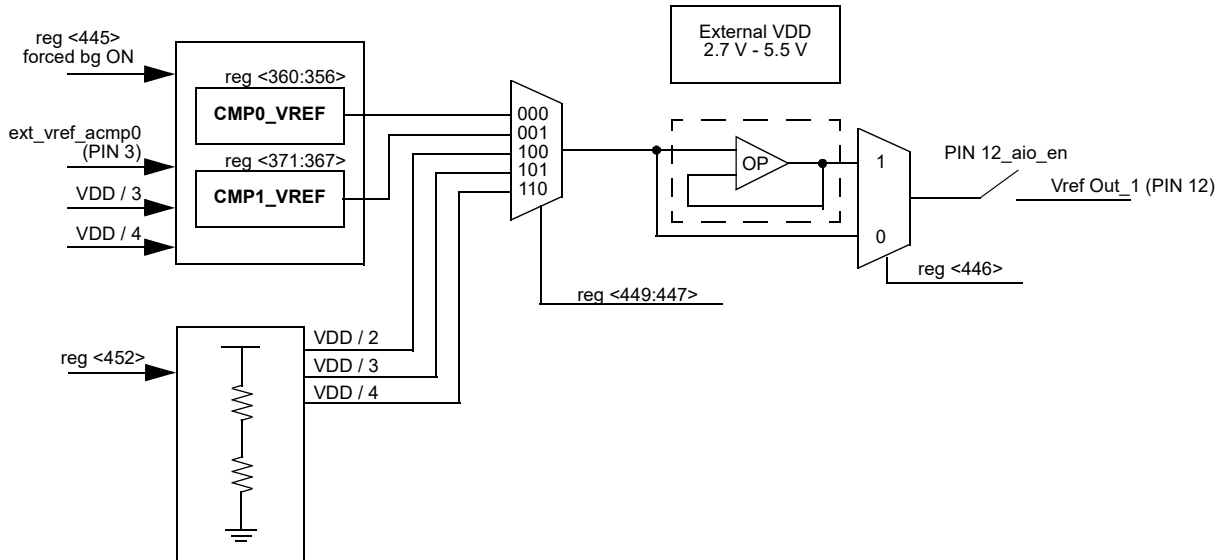


Figure 39. Voltage Reference Block Diagram



## 16.0 RC Oscillator (RC Osc)

### 16.1 RC Oscillator Overview

The SLG46116 has two internal RC oscillators, one that runs at 25 kHz and one that runs at 2 MHz. When using the chip internal RC OSC, a choice is available to “Force Power On”, meaning that the RC OSC will always run, or “Auto Power On”, meaning that the RC OSC will have an associated startup and settling time associated with it (offset). *Figure 40* and *Figure 41* show maximum power on delay vs. VDD.

*Note: RC OSC power setting: "Auto Power On".*

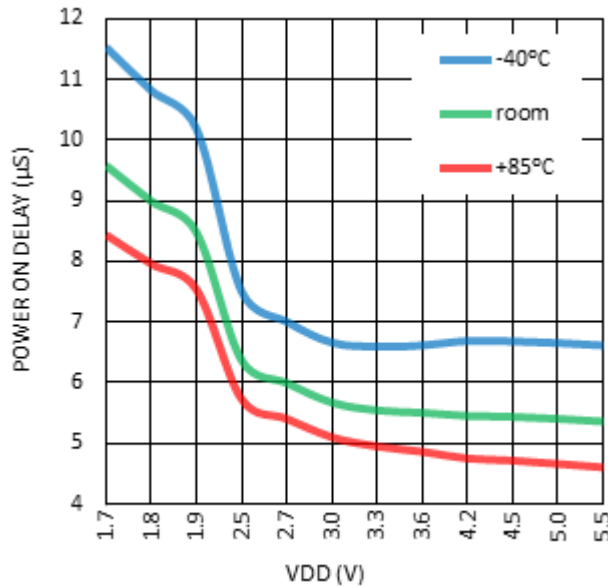


Figure 40. Maximum Power On Delay vs. VDD, RC OSC = 2 MHz.

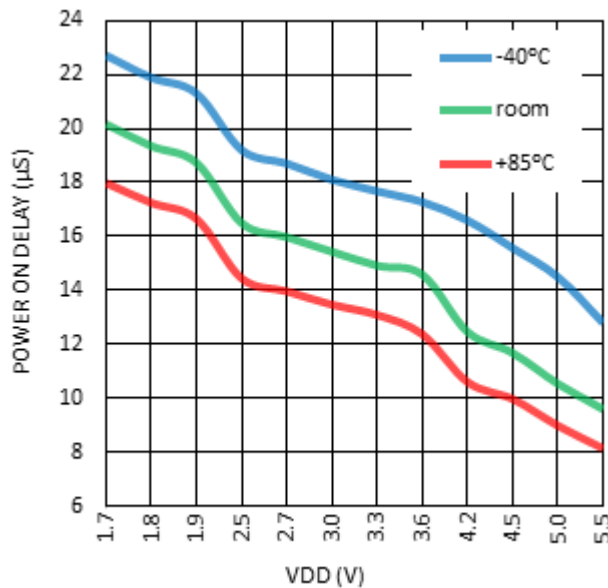


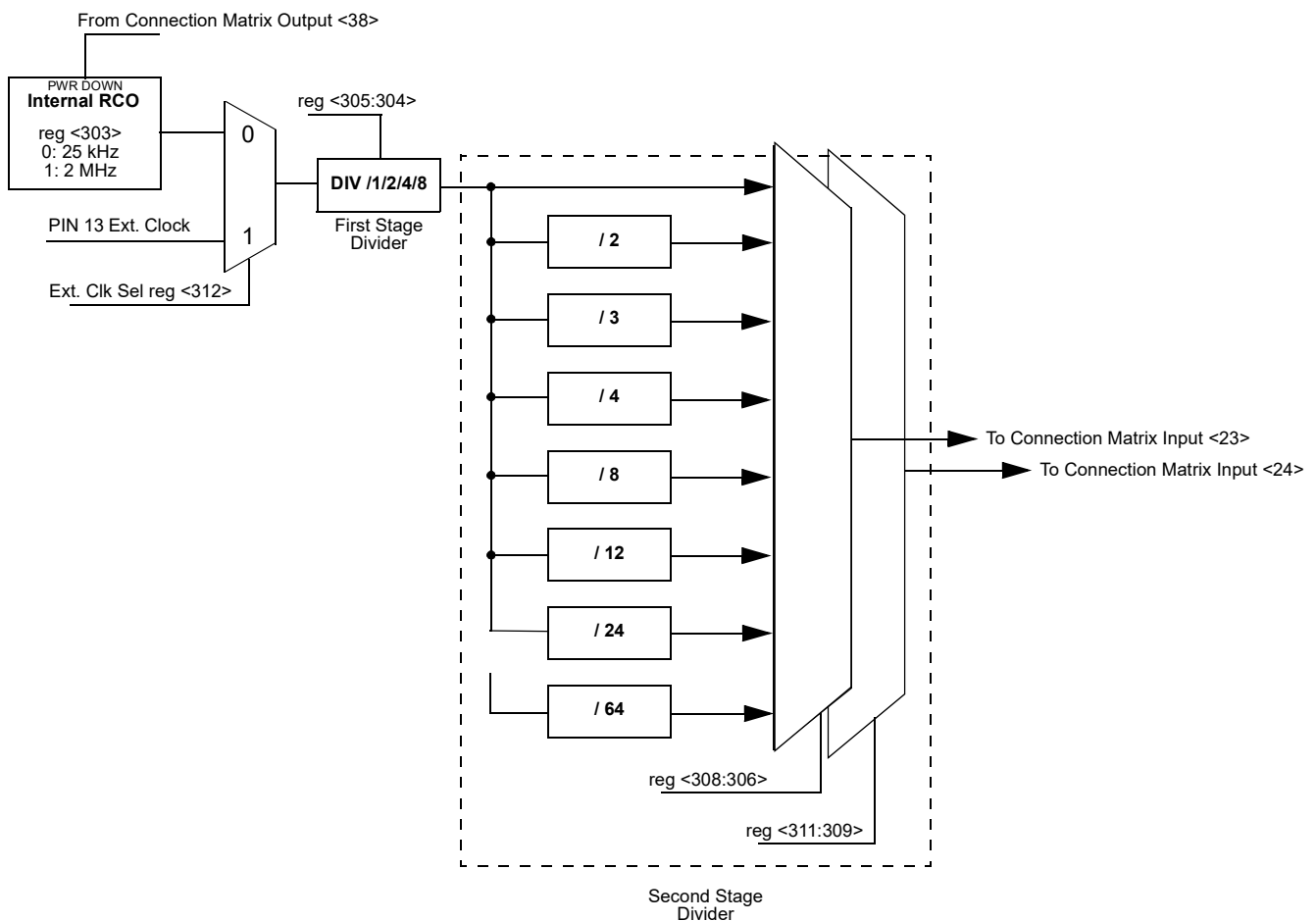
Figure 41. Maximum Power On Delay vs. VDD, RC OSC = 25 kHz.



The user can select one of these fundamental frequencies for the RC OSC Macrocell, or the fundamental frequency can also come from an external clock input (Pin 12). There are two divider stages that allow the user flexibility for introducing clock signals on various Connection Matrix Input lines. The first stage divider (also known as the clock pre-divider) allows the selection of /1, /2, /4 or /8 divide down frequency from the fundamental. There are two second stage divider controls (OUT0 and OUT1). Each has its own input of one frequency from the first stage divider, and outputs five different frequencies on Connection Matrix Input lines <45>, <46>, <47>, <48>, and <49>. See *Figure 42* below for details of the frequencies for each of these five Connection Matrix Inputs.

If PWR DOWN input of oscillator is LOW, the oscillator will be turned on. If PWR DOWN input of oscillator is HIGH the oscillator will be turned off. The PWR DOWN signal has the highest priority.

## 16.2 RC OSC Block Diagram



**Figure 42. RC OSC Block Diagram**



## 17.0 Power On Rest (POR)

The SLG46116 has a power-on reset (POR) macrocell to ensure correct device initialization and operation of all macrocells in the device. The purpose of the POR circuit is to have consistent behavior and predictable results when the VDD power is first ramping to the device, and also while the VDD is falling during power-down. To accomplish this goal, the POR drives a defined sequence of internal events that trigger changes to the states of different macrocells inside the device, and finally to the state of the I/O pins. This application note is created to explain the whole process of POR operation and GreenPAK chip behavior during the time while it is powering up and powering down.

### 17.1 General Operation

The SLG46116 is guaranteed to be powered down and nonoperational when the VDD voltage (on PIN14) is less than 0.6V, but not less than -0.6 V. Another essential condition for the chip to be powered down is that no voltage higher (see Note 1) than the VDD voltage is applied to any other PIN. For example, if VDD voltage is 0.3V, applying a voltage higher than 0.3 V to any other PIN is incorrect, and can lead to incorrect or unexpected device behavior.

*Note 1. There is a 0.6V margin due to forward drop voltage of the ESD protection diodes.*

To start the POR sequence in the SLG46116, the voltage applied on the VDD should be higher than the Power\_ON threshold (see Note 2). The full operational VDD range for the SLG46116 is 1.71V – 5.5V (1.8V  $\pm$ 5% - 5V $\pm$ 10%). This means that the VDD voltage must ramp up to the operational voltage value, but the POR sequence will start earlier, as soon as the VDD voltage rises to the Power\_ON threshold. After the POR sequence has started, the SLG46116 will have a typical period of time to go through all the steps in the sequence (noted in the datasheet for that device), and will be ready and completely operational after the POR sequence is complete.

*Note 2. The Power\_ON threshold can vary by PVT, but typically it is 1.6V.*

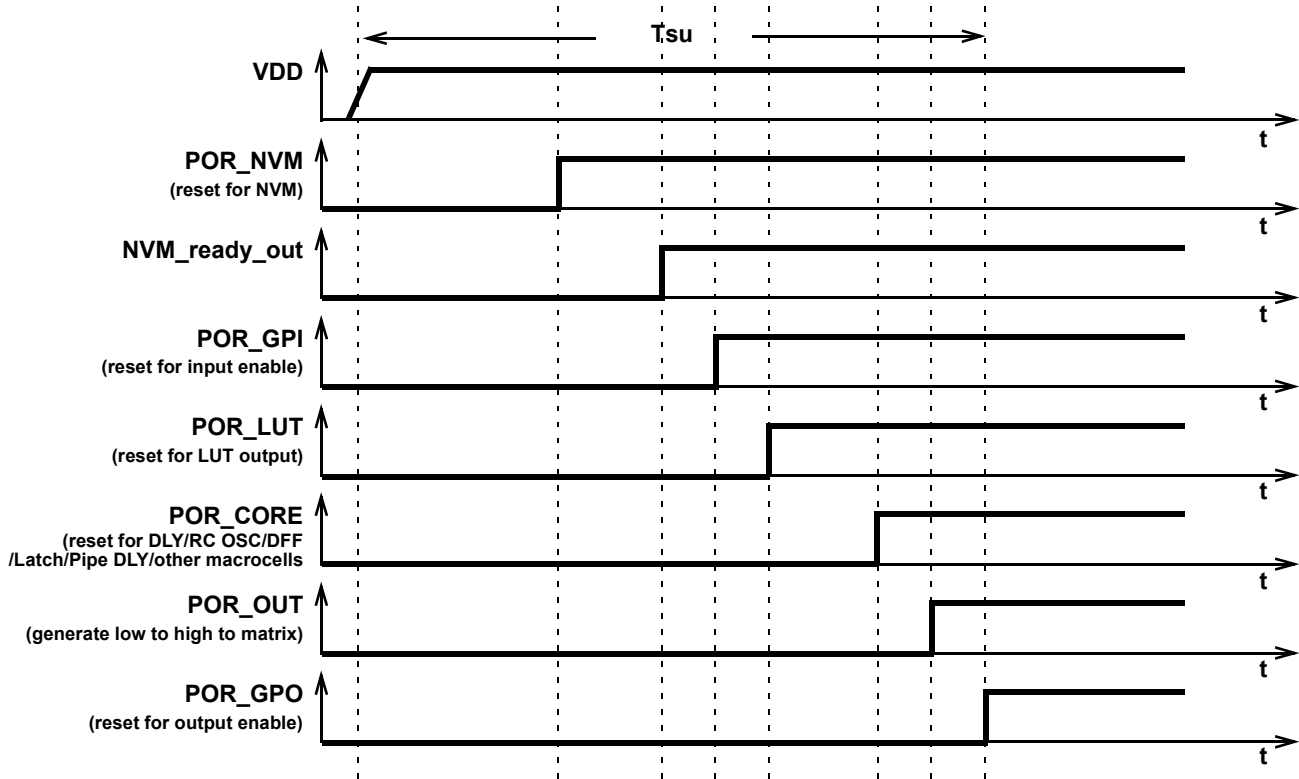
To power down the chip the VDD voltage should be lower than the operational and to guarantee that chip is powered down it should be less than 0.6V.

All PINs are in high impedance state when the chip is powered down and while the POR sequence is taking place. The last step in the POR sequence releases the I/O structures from the high impedance state, at which time the device is operational. The pin configuration at this point in time is defined by the design programmed into the chip. Also as it was mentioned before the voltage on PINs can't be bigger than the VDD, this rule also applies to the case when the chip is powered on.



## 17.2 POR Sequence

The POR system generates a sequence of signals that enable certain macrocells. The sequence is shown in *Figure 43*.



**Figure 43. POR sequence**

As can be seen from *Figure 43* after the VDD has start ramping up and crosses the Power\_ON threshold, first, the on-chip NVM memory is reset. Next the chip reads the data from NVM, and transfers this information to SRAM registers that serve to configure each macrocell, and the Connection Matrix which routes signals between macrocells. The third stage causes the reset of the input pins, and then to enable them. After that, the LUTs are reset and become active. After LUTs the Delay cells, RC OSC, DFFs, Latches and Pipe Delay are initialized. Only after all macrocells are initialized internal POR signal (POR macrocell output) goes from LOW to HIGH. The last portion of the device to be initialized are the output PINs, which transition from high impedance to active at this point.

The typical time that takes to complete the POR sequence varies by device type in the GreenPAK family. It also depends on many environmental factors, such as: slew rate, VDD value, temperature and even will vary from chip to chip (process influence).



### 17.3 Macrocells Output States During POR Sequence

To have a full picture of SLG46116 operation during powering and POR sequence, review the overview the macrocell output states during the POR sequence (*Figure 44* describes the output signals states).

First, before the NVM has been reset, all macrocells have their output set to logic LOW (except the output PINs which are in high impedance state). Before the NVM is ready, all macrocell outputs are unpredictable (except the output PINs). On the next step, some of the macrocells start initialization: input pins output state becomes LOW; LUTs also output LOW. Only P DLY macrocell configured as edge detector becomes active at this time. After that input PINs are enabled. Next, only LUTs are configured. Next, all other macrocells are initialized. After macrocells are initialized, internal POR matrix signal switches from LOW to HIGH. The last are output PINs that become active and determined by the input signals.

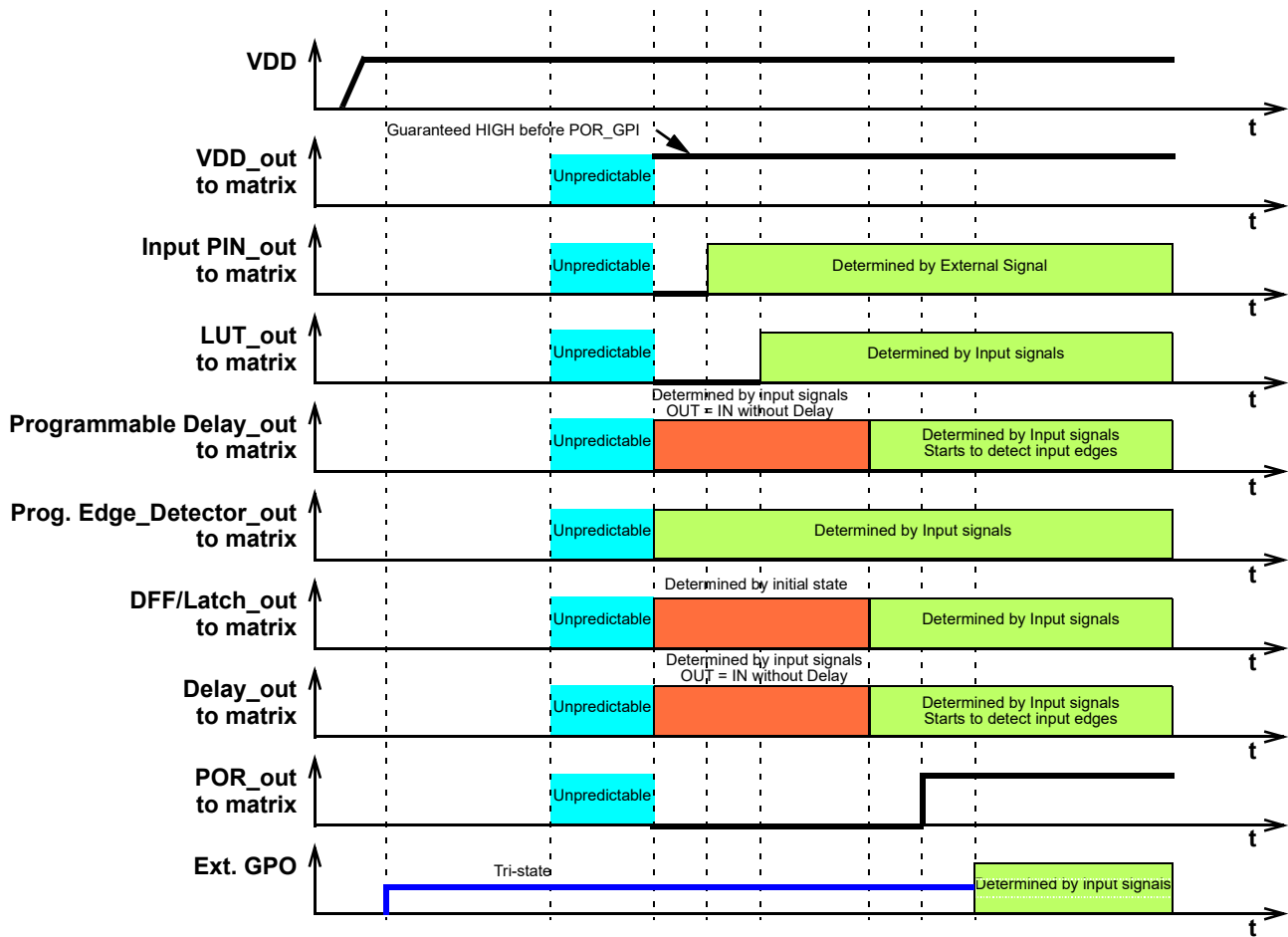


Figure 44. Internal Macrocell States during POR sequence





## 18.0 Soft-Start P-FET Power Switch with Fixed Slew Rate Control

The SLG46116 includes a Soft-Start P-FET Power Switch designed for load switching applications. The P-FET Power Switch contains a 28.5 mΩ R<sub>DS(on)</sub>, 1.25 A P-ch MOSFET with fixed slew rate control. The P-FET Power Switch can be controlled internally via the ON digital input of the P-FET Power Switch component in GreenPAK Designer, allowing the user to generate integrated mixed-signal control circuits, or externally via PWR\_SW\_ON (PIN 4).

When configured to be controlled internally, PWR\_SW\_ON (PIN 4) is configured as a Push-Pull output.

When configured for external control, PWR\_SW\_ON (PIN 4) is configured as a Low Voltage Digital Input (LVDI) and can be used as an input to other integrated components.

The P-FET Power Switch need not be used in the same voltage domain as VDD. However, when VIN is not tied to VDD, using a large pull-down resistor on PWR\_SW\_ON (PIN 4) is recommended to prevent current from flowing through the P-FET Power Switch while the device is not powered.

Note: To prevent glitches at the output, it is recommended to connect at least 0.1 μF capacitor from VOUT pin to the GND.

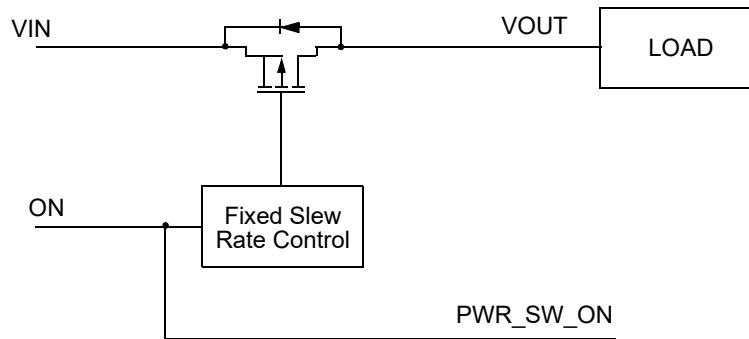


Figure 45. P-FET Power Switch with Slew Rate Control



## 19.0 Appendix A - SLG46116 Register Definition

| Register Bit Address | Signal Function   | Register Bit Definition |
|----------------------|---|-------------------------|
| reg <4:0>            | Matrix Out: PIN 2 Digital Output Source                                 |                         |
| reg <9:5>            | Matrix Out: PIN 3 Digital Output Source                                 |                         |
| reg <14:10>          | Matrix Out: PIN 4 Digital Output Source                                 |                         |
| reg <19:15>          | Matrix Out: Output Enable of PIN 4 and ON input of P-FET Power Switch   |                         |
| reg <24:20>          | Matrix Out: In0 of LUT2_0 or Clock Input of DFF0                        |                         |
| reg <29:25>          | Matrix Out: In1 of LUT2_0 or Data Input of DFF0                         |                         |
| reg <34:30>          | Matrix Out: In0 of LUT2_1 or Clock Input of DFF1                        |                         |
| reg <39:35>          | Matrix Out: In1 of LUT2_1 or Data Input of DFF1                         |                         |
| reg <44:40>          | Matrix Out: In0 of LUT2_2   |                         |
| reg <49:45>          | Matrix Out: In1 of LUT2_2   |                         |
| reg <54:50>          | Matrix Out: In0 of LUT2_3   |                         |
| reg <59:55>          | Matrix Out: In1 of LUT2_3   |                         |
| reg <64:60>          | Matrix Out: In0 of LUT3_0 or Clock Input of DFF2                        |                         |
| reg <69:65>          | Matrix Out: In1 of LUT3_0 or Data Input of DFF2                         |                         |
| reg <74:70>          | Matrix Out: In2 of LUT3_0 or Resetb Input of DFF2                       |                         |
| reg <79:75>          | Matrix Out: In0 of LUT3_1 or Clock Input of DFF3                        |                         |
| reg <84:80>          | Matrix Out: In1 of LUT3_1 or Data Input of DFF3                         |                         |
| reg <89:85>          | Matrix Out: In2 of LUT3_1 or Resetb(Setb) of DFF3                       |                         |
| reg <94:90>          | Matrix Out: In0 of LUT3_2   |                         |
| reg <99:95>          | Matrix Out: In1 of LUT3_2   |                         |
| reg <104:100>        | Matrix Out: In2 of LUT3_2   |                         |
| reg <109:105>        | Matrix Out: In0 of LUT3_3   |                         |
| reg <114:110>        | Matrix Out: In1 of LUT3_3   |                         |
| reg <119:115>        | Matrix Out: In2 of LUT3_3   |                         |
| reg <124:120>        | Matrix Out: In0 of LUT3_4 or Input of Pipe delay                        |                         |
| reg <129:125>        | Matrix Out: In1 of LUT3_4 or Resetb of Pipe delay                       |                         |
| reg <134:130>        | Matrix Out: In2 of LUT3_4 or Clock of Pipe delay                        |                         |
| reg <139:135>        | Matrix Out: In0 of LUT4_0 or Input for delay2 (Counter2) external clock |                         |
| reg <144:140>        | Matrix Out: In1 of LUT4_0 or Input for delay2 data (counter2 reset)     |                         |
| reg <149:145>        | Matrix Out: In2 of LUT4_0   |                         |
| reg <154:150>        | Matrix Out: In3 of LUT4_0   |                         |
| reg <159:155>        | Matrix Out: Input for delay0 data (counter0 reset)                      |                         |
| reg <164:160>        | Matrix Out: Input for delay1 data (counter1 reset)                      |                         |
| reg <169:165>        | Matrix Out: Input for delay0/1 (Counter0/1) external clock              |                         |
| reg <174:170>        | Matrix Out: Input for delay3 (Counter3) external clock                  |                         |
| reg <179:175>        | Matrix Out: pdb(power down) for ACMP0                                   |                         |
| reg <184:180>        | Matrix Out: pdb(power down) for ACMP1                                   |                         |
| reg <189:185>        | Matrix Out: Input for programmable delay (deglitch filter input)        |                         |



| Register Bit Address        | Signal Function                            | Register Bit Definition                                  |
|-----------------------------|--|--|
| reg <194:190>               | Matrix Out: Power down for osc             |  |
| reg <199:195>               | Matrix Out: PIN 10 Digital Output Source   |  |
| reg <204:200>               | Matrix Out: PIN 11 Digital Output Source   |  |
| reg <209:205>               | Matrix Out: PIN 12 Digital Output Source   |  |
| reg <214:210>               | Matrix Out: Output Enable of PIN 12        |  |
| reg <219:215>               | Matrix Out: PIN 13 Digital Output Source   |  |
| reg <223:220>               | Reserved                                   | Reserved   |
| <b>DFF0/Latch</b>           |  |  |
| reg <227:224>               | reg <224> DFF0 or Latch select             | 0: DFF function<br>1: Latch function                     |
|                             | reg <225> DFF0 output select               | 0: Q output<br>1: nQ output                              |
|                             | reg <226> DFF0 initial polarity select     | 0: Low<br>1: High  |
|                             | reg <227> Unused if DFF/Latch selected     | Unused   |
| <b>DFF1/Latch</b>           |  |  |
| reg <231:228>               | reg <228> DFF1 or Latch select             | 0: DFF function<br>1: Latch function                     |
|                             | reg <229> DFF1 output select               | 0: Q output<br>1: nQ output                              |
|                             | reg <230> DFF1 initial polarity select     | 0: Low<br>1: High  |
|                             | reg <231> Unused if DFF/Latch selected     | Unused   |
| <b>LUT2_0 data</b>          |  |  |
| reg <235:232>               | LUT2_0 data                                | LUT2_0 data  |
| <b>LUT2_1 data</b>          |  |  |
| reg <239:236>               | LUT2_1 data                                | LUT2_1 data  |
| <b>LUT2_0/DFF0</b>          |  |  |
| reg <240>                   | LUT2_0 or DFF0 select                      | 0: LUT2_0<br>1: DFF0                                     |
| <b>LUT2_1/DFF1</b>          |  |  |
| reg <241>                   | LUT2_1 or DFF1 select                      | 0: LUT2_1<br>1: DFF1                                     |
| <b>LUT3_0 or DFF2/Latch</b> |  |  |
| reg <249:242>               | reg <242> DFF2 or Latch select             | 0: DFF function<br>1: Latch function                     |
|                             | reg <243> DFF2 output select               | 0: Q output<br>1: nQ output                              |
|                             | reg <244> DFF2 rstb/setb select            | 0: rstb from matrix output<br>1: setb from matrix output |
|                             | reg <245> DFF2 initial polarity select     | 0: Low<br>1: High  |
|                             | reg <249:246> Unused if DFF/Latch selected | Unused   |



| Register Bit Address                           | Signal Function  | Register Bit Definition   |
|--|--|---|
| <b>DFF3/Latch</b>                              |  |   |
| reg <257:250>                                  | reg <250> DFF3 or Latch select                                 | 0: DFF function<br>1: Latch function  |
|  | reg <251> DFF3 output select 0: Q output 1: nQ output          | 0: Q output<br>1: nQ output   |
|  | reg <252> DFF3 rstb/setb select                                | 0: resetb from matrix output<br>1: setb from matrix output  |
|  | reg <253> DFF3 initial polarity select                         | 0: Low<br>1: High   |
|  | reg <257:254> Unused if DFF/Latch selected                     | Unused  |
| <b>LUT3_2 data</b>                             |  |   |
| reg <265:258>                                  | LUT3_2 data  | LUT3_2 data   |
| <b>LUT3_3 data</b>                             |  |   |
| reg <273:266>                                  | LUT3_3 data  | LUT3_3 data   |
| <b>LUT3_4 or pipe number select</b>            |  |   |
| reg <281:274>                                  | reg <276:274>: OUT0 select                                     | data (pipe number)  |
|  | reg <279:277>: OUT1 select                                     | data (pipe number)  |
|  | reg <281:280>: Unused if Pipe Delay selected                   | Unused  |
| <b>LUT3/DFF Select</b>                         |  |   |
| reg <282>                                      | LUT3_0 or DFF2 select  | 0: LUT3_0<br>1: DFF2  |
| reg <283>                                      | LUT3_1 or DFF3 select  | 0: LUT3_1<br>1: DFF3  |
| reg <284>                                      | LUT3_4 or pipe delay output select                             | 0: LUT3_4<br>1: pipe delay  |
| <b>LUT4_0 or Counter/delay2 mode selection</b> |  |   |
| reg <300:285>                                  | reg <285> Counter/delay2 mode selection                        | 0: Delay Mode<br>1: Counter Mode  |
|  | reg <288:286> Counter/delay2 Clock Source select               | 000: Internal OSC Clock<br>001: OSC/4<br>010: OSC/12<br>011: OSC/24<br>100: OSC/64<br>101: External Clock<br>110: External Clock<br>111: Counter1 Overflow  |
|  | reg <296:289> Counter/delay2 Control Data                      | 1 – 256 (delay time = (counter control data +2) /freq)  |
|  | reg <298:297> Delay2 Mode Select or asynchronous counter reset | 00: Delayon both falling and rising edges(for delay & counter reset)<br>01: Delayon falling edge only (for delay & counter reseDelayt)<br>10: on rising edge only (for delay & counter reset)<br>11: No delay on either falling or rising edges / high level reset for counter mode |
|  | reg <300:299> Unused is Counter/Delay2 selected                | Unused  |
| reg <301>                                      | LUT4_0 or Counter2 select 0: LUT4_0, 1: Counter2               | 0: LUT4_0<br>1: Counter2  |
| reg <302>                                      | Force RC oscillator on   | 0: Auto Power on<br>1: Force Power on   |



| Register Bit Address   | Signal Function  | Register Bit Definition   |
|------------------------|--|---|
| reg <303>              | RC Oscillator frequency control  | 0: 25k<br>1: 2M   |
| reg <305:304>          | Osc clock pre-divider  | 00: div1<br>01: div2<br>10: div4<br>11: div8  |
| reg <308:306>          | Internal Oscillator frequency divider control 0 for Matrix Input                           | 000: OSC/1<br>001: OSC/2<br>010: OSC/3<br>011: OSC/4<br>100: OSC/8<br>101: OSC/12<br>110: OSC/24<br>111: OSC/64   |
| reg <311:309>          | Internal Oscillator frequency divider control 1 for Matrix Input                           | 000: OSC/1<br>001: OSC/2<br>010: OSC/3<br>011: OSC/4<br>100: OSC/8<br>101: OSC/12<br>110: OSC/24<br>111: OSC/64   |
| reg <312>              | External Clock Source Select   | 0: Internal Oscillator<br>1: External Clock from PIN 13   |
| reg <313>              | Reserved   | Reserved  |
| <b>Counter/Delay 0</b> |  |   |
| reg <327:314>          | reg <314>Counter/delay0 mode selection   | 0: Delay Mode<br>1: Counter Mode  |
|                        | reg <317:315> Counter/delay0 Clock Source select (external clock is only for counter mode) | 000: Internal OSC Clock<br>001: OSC/4<br>010: OSC/12<br>011: OSC/24<br>100: OSC/64<br>101: External Clock<br>110: External Clock<br>111: Counter3 Overflow  |
|                        | reg <325:318> Counter0 Control Data/Delay0 Time Control                                    | 1-256: (delay time = (counter control data +2) /freq)   |
|                        | reg <327:326> Delay0 Mode Select or asynchronous counter reset                             | 00: Delayon both falling and rising edges(for delay & counter reset)<br>01: Delayon falling edge only (for delay & counter reset)<br>10: Delayon rising edge only (for delay & counter reset)<br>11: No delay on either falling or rising edges / high level reset for counter mode |



| Register Bit Address   | Signal Function  | Register Bit Definition  |
|------------------------|--|--|
| <b>Counter/Delay 1</b> |  |  |
| reg <341:328>          | reg <328> Counter/delay1 mode selection  | 0: Delay Mode<br>1: Counter Mode   |
|                        | reg <331:329> Counter/delay1 Clock Source select (external clock is only for counter mode) | 000: Internal OSC Clock<br>001: OSC/4<br>010: OSC/12<br>011: OSC/24<br>100: OSC/64<br>101: External Clock<br>110: External Clock<br>111: Counter0 Overflow   |
|                        | reg <339:332> Counter1 Control Data/Delay1 Time Control                                    | 1-256: (delay time = (counter control data +2) /freq)  |
|                        | reg <341:340> Delay1 Mode Select or asynchronous counter reset                             | 00: Delay on both falling and rising edges(for delay & counter reset)<br>01: Delay on falling edge only (for delay & counter reset)<br>10: Delay on rising edge only (for delay & counter reset)<br>11: No delay on either falling or rising edges / high level reset for counter mode |
| <b>Counter/Delay 3</b> |  |  |
| reg <355:342>          | reg <342> Counter/delay3 mode selection  | 0: Delay Mode<br>1: Counter Mode   |
|                        | reg <345:343> Counter/delay3 Clock Source select (external clock is only for counter mode) | 000: Internal OSC Clock<br>001: OSC/4<br>010: OSC/12<br>011: OSC/24<br>100: OSC/64<br>101: External Clock<br>110: External Clock<br>111: Counter2 Overflow   |
|                        | reg <353:346> Counter3 Control Data/Delay4 Time Control                                    | 1-256: (delay time = (counter control data +2) /freq)  |
|                        | reg <355:354> Delay3 Mode Select   | 00: Delay on both falling and rising edges<br>01: Delay on falling edge only<br>10: Delay on rising edge only<br>11: No delay on either falling or rising edges  |



| Register Bit Address | Signal Function  | Register Bit Definition  |
|----------------------|--|--|
| <b>ACMP0</b>         |  |  |
| reg <366:356>        | reg <360:356> ACMP0 IN voltage select                      | 00000: 50 mV    00001: 100 mV<br>00010: 150 mV    00011: 200 mV<br>00100: 250 mV    00101: 300 mV<br>00110: 350 mV    00111: 400 mV<br>01000: 450 mV    01001: 500 mV<br>01010: 550 mV    01011: 600 mV<br>01100: 650 mV    01101: 700 mV<br>01110: 750 mV    01111: 800 mV<br>10000: 850 mV    10001: 900 mV<br>10010: 950 mV    10011: 1 V<br>10100: 1.05 V    10101: 1.1 V<br>10110: 1.15 V    10111: 1.2 V<br>11000: VDD/3    11001: VDD/4<br>11010: EXT_VREF(PIN 3) |
|                      | reg <362:361> ACMP0 hysteresis Enable                      | 00: Disabled (0 mV)<br>01: Enabled (25 mV)<br>10: Enabled (50 mV)<br>11: Enabled (200 mV)  |
|                      | reg <364:363> ACMP0 positive Input divider                 | 00: 1.0x<br>01: 0.5x<br>10: 0.33x<br>11: 0.25x   |
|                      | reg <365> ACMP0 low bandwidth (typ: Max.1Mhz) enable.      | 0: off<br>1: on  |
|                      | reg <366> ACMP0 positive input source select PIN 2 and VDD | 0: PIN 2<br>1: VDD   |
| <b>ACMP1</b>         |  |  |
| reg <378:367>        | reg <371:367> ACMP1 IN voltage select                      | 00000: 50 mV    00001: 100 mV<br>00010: 150 mV    00011: 200 mV<br>00100: 250 mV    00101: 300 mV<br>00110: 350 mV    00111: 400 mV<br>01000: 450 mV    01001: 500 mV<br>01010: 550 mV    01011: 600 mV<br>01100: 650 mV    01101: 700 mV<br>01110: 750 mV    01111: 800 mV<br>10000: 850 mV    10001: 900 mV<br>10010: 950 mV    10011: 1 V<br>10100: 1.05 V    10101: 1.1 V<br>10110: 1.15 V    10111: 1.2 V<br>11000: VDD/3    11001: VDD/4<br>11010: EXT_VREF(PIN 3) |
|                      | reg <373:372> ACMP1 hysteresis Enable                      | 00: Disabled (0 mV)<br>01: Enabled (25 mV)<br>10: Enabled (50 mV)<br>11: Enabled (200 mV)  |
|                      | reg <375:374> ACMP1 positive Input divider                 | 00: 1.0x<br>01: 0.5x<br>10: 0.33x<br>11: 0.25x   |
|                      | reg <376> ACMP1 100uA current source option                | 0: disable<br>1: enable  |
|                      | reg <377> ACMP1 low bandwidth (typ: Max.1 MHz) enable.     | 0: off<br>1: on  |
|                      | Reserved   |  |



| Register Bit Address | Signal Function   | Register Bit Definition  |
|----------------------|---|--|
| <b>PIN 1</b>         |   |  |
| reg <382:379>        | reg <380:379> PIN 1 mode control                          | 00: Digital Input without Schmitt trigger<br>01: Digital Input with Schmitt trigger<br>10: Low voltage digital input<br>11: Reserved   |
|                      | reg <382:381> PIN 1 pull down resistor value selection    | 00: floating<br>01: 10K<br>10: 100K<br>11: 1M  |
| <b>PIN 2</b>         |   |  |
| reg <389:383>        | reg <385:383> PIN 2 mode control                          | 000: Digital Input without Schmitt trigger<br>001: Digital Input with Schmitt trigger<br>010: Low voltage digital input<br>011: Analog Input / Output<br>100: Push Pull<br>101: Open Drain NMOS<br>110: Open Drain PMOS<br>111: Analog Input / Output & Open drain |
|                      | reg <387:386> PIN 2 pull up/down resistor value selection | 00: floating<br>01: 10K<br>10: 100K<br>11: 1M  |
|                      | reg <388> PIN 2 pull up/down resistor select              | 0: pull down resistor enable<br>1: pull up resistor enable   |
|                      | reg <389> PIN 2 driver strength selection                 | 0: 1X<br>1: 2X   |
| <b>PIN 3</b>         |   |  |
| reg <396:390>        | reg <392:390> PIN 3 mode control                          | 000: Digital Input without Schmitt trigger<br>001: Digital Input with Schmitt trigger<br>010: Low voltage digital input<br>011: Analog Input / Output<br>100: Push Pull<br>101: Open Drain NMOS<br>110: Open Drain PMOS<br>111: Analog Input / Output & Open drain |
|                      | reg <394:393> PIN 3 pull up/down resistor value selection | 00: floating<br>01: 10K<br>10: 100K<br>11: 1M  |
|                      | reg <395> PIN 3 pull up/down resistor select              | 0: pull down resistor enable<br>1: pull up resistor enable   |
|                      | reg <396> PIN 3 driver strength selection                 | 0: 1X<br>1: 2X   |





| Register Bit Address | Signal Function  | Register Bit Definition  |
|----------------------|--|--|
| <b>PIN 4</b>         |  |  |
| reg <403:397>        | reg <398:397> PIN 4 mode control (sig_PIN 4_oe =0)         | 00: Digital Input without Schmitt trigger<br>01: Digital Input with Schmitt trigger<br>11: Low Voltage Digital Input<br>10: Analog Input / Output  |
|                      | reg <400:399> PIN 4 mode control (sig_PIN 4_oe =1)         | 00: Push Pull 1X<br>01: Push Pull 2X<br>10: Open Drain NMOS 1X<br>11: Open Drain NMOS 2X   |
|                      | reg <402:401> PIN 4 pull up/down resistor value selection  | 00: floating<br>01: 10K<br>10: 100K<br>11: 1M  |
|                      | reg <403> PIN 4 pull up/down resistor select               | 0: pull down resistor enable<br>1: pull up resistor enable   |
| <b>PIN 10</b>        |  |  |
| reg <410:404>        | reg <406:404> PIN 10 mode control                          | 000: Digital Input without Schmitt trigger<br>001: Digital Input with Schmitt trigger<br>010: Low voltage digital input<br>011: Analog Input / Output<br>100: Push Pull<br>101: Open Drain NMOS<br>110: Open Drain PMOS<br>111: Analog Input / Output & Open drain |
|                      | reg <408:407> PIN 10 pull up/down resistor value selection | 00: floating<br>01: 10K<br>10: 100K<br>11: 1M  |
|                      | reg <409> PIN 10 pull up/down resistor select              | 0: pull down resistor enable<br>1: pull up resistor enable   |
|                      | reg <410> PIN 10 driver strength selection                 | 0: 1X<br>1: 2X   |
| <b>PIN 11</b>        |  |  |
| reg <417:411>        | reg <413:411> PIN 11 mode control                          | 000: Digital Input without Schmitt trigger<br>001: Digital Input with Schmitt trigger<br>010: Low voltage digital input<br>011: Analog Input / Output<br>100: Push Pull<br>101: Open Drain NMOS<br>110: Open Drain PMOS<br>111: Analog Input / Output & Open drain |
|                      | reg <415:414> PIN 11 pull down resistor value selection    | 00: floating<br>01: 10K<br>10: 100K<br>11: 1M  |
|                      | reg <416> PIN 11 pull up/down resistor select              | 0: pull down resistor enable<br>1: pull up resistor enable   |
|                      | reg <417> PIN 11 driver strength selection                 | 0: 1X<br>1: 2X   |



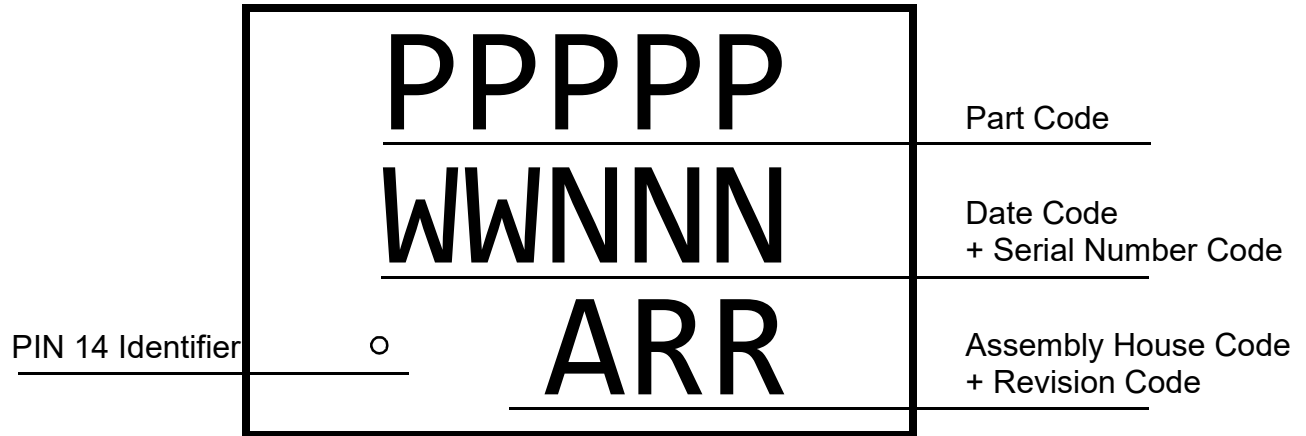
| Register Bit Address | Signal Function  | Register Bit Definition  |
|----------------------|--|--|
| <b>PIN 12</b>        |  |  |
| reg <424:418>        | reg <419:418> PIN 12 mode control (sig_PIN 12_oe =0)       | 00: Digital Input without Schmitt trigger<br>01: Digital Input with Schmitt trigger<br>11: Low Voltage Digital Input<br>10: Analog Input / Output  |
|                      | reg <421:420> PIN 12 mode control (sig_PIN 12_oe =1)       | 00: Push Pull 1X<br>01: Push Pull 2X<br>10: Open Drain NMOS 1X<br>11: Open Drain NMOS 2X   |
|                      | reg <423:422> PIN 12 pull up/down resistor value selection | 00: floating<br>01: 10K<br>10: 100K<br>11: 1M  |
|                      | reg <424> PIN 12 pull up/down resistor select              | 0: pull down resistor enable<br>1: pull up resistor enable   |
| <b>PIN 13</b>        |  |  |
| reg <431:425>        | reg <427:425> PIN 13 mode control                          | 000: Digital Input without Schmitt trigger<br>001: Digital Input with Schmitt trigger<br>010: Low voltage digital input<br>011: Analog Input / Output<br>100: Push Pull<br>101: Open Drain NMOS<br>110: Open Drain PMOS<br>111: Analog Input / Output & Open drain |
|                      | reg <429:428> PIN 13 pull up/down resistor value selection | 00: floating<br>01: 10K<br>10: 100K<br>11: 1M  |
|                      | reg <430> PIN 13 pull up/down resistor select              | 0: pull down resistor enable<br>1: pull up resistor enable   |
|                      | reg <431> PIN 13 driver strength selection                 | 0: 1X<br>1: 2X   |
| reg <432>            | Pipe delay OUT1 polarity select bit                        | 0: non-inverting<br>1: inverting   |
| reg <440:433>        | 8-bit pattern id   | 8-bit pattern id   |
| reg <441>            | filter0 output polarity select                             | 0: non-inverting<br>1: inverting   |
| reg <443:442>        | Reserved   | Reserved   |
| reg <444>            | GPIO quick charge enable                                   | 0: Disable<br>1: Enable  |
| reg <445>            | Force bandgap on   | 0: Auto-mode<br>1: Enable  |
| reg <446>            | VREF1 Output Active Buffer Control                         | 0: Disabled<br>1: Enabled  |
| reg <449:447>        | VREF1 Output Source Select                                 | 000: ACMP0 reference voltage<br>001: ACMP1 reference voltage<br>100: VDD/2<br>101: VDD/3<br>110: VDD/4<br>101: Reserved<br>110: Reserved<br>111: Reserved  |



| Register Bit Address | Signal Function  | Register Bit Definition  |
|----------------------|--|--|
| reg <450>            | NVM data read disable  | 0: Disable (read enable)<br>1: Enable (read disable)   |
| reg <451>            | NVM power down (or NVM data programming disable)   | 0: None (or programming enable)<br>1: Power Down (or programming disable)                              |
| reg <452>            | Power Divider Power  | 0: Power down<br>1: Power On   |
| reg <453>            | POR Auto Power detect  | 0: Enable<br>1: Disable  |
| reg <454>            | Charge pump for analog macrocell enable (when VDD <= 2.7 V turn on)                        | 0: Disable (automatic on/off control)<br>1: Enable (always on)   |
| reg <455>            | VDD bypass enable  | 0: Regulator auto on<br>1: Regulator off (VDD bypass)  |
| reg <471:456>        | Reserved   | Reserved   |
| reg <479:472>        | Reserved   | Reserved   |
| reg <481:480>        | Reserved   | Reserved   |
| reg <482>            | PIN 1 edge detect mode   | 0: rising edge<br>1: falling edge  |
| reg <483>            | Bypass the PIN 1   | 0: PIN 1 edge active<br>1: PIN 1 high active   |
| reg <484>            | PIN 1 reset enable   | 0: Disable<br>1: Enable  |
| reg <485>            | programmable delay or filter output select   | 0: programmable delay output<br>1: filter output   |
| reg <487:486>        | Select the edge mode of programmable delay & edge detector                                 | 00: rising edge detector<br>01: falling edge detector<br>10: both edge detector<br>11: both edge delay |
| reg <489:488>        | Delay value select for programmable delay & edge detector (VDD = 3.3 V, typical condition) | 00: 125 ns<br>01: 250 ns<br>10: 375 ns<br>11: 500 ns   |
| reg <490>            | Reserved   | Reserved   |
| reg <495:491>        | Reserved   | Reserved   |
| reg <501:496>        | Reserved   | Reserved   |
| reg <502>            | Reserved   | Reserved   |
| reg <503>            | Reserved   | Reserved   |
| reg <511:504>        | Reserved   | Reserved   |



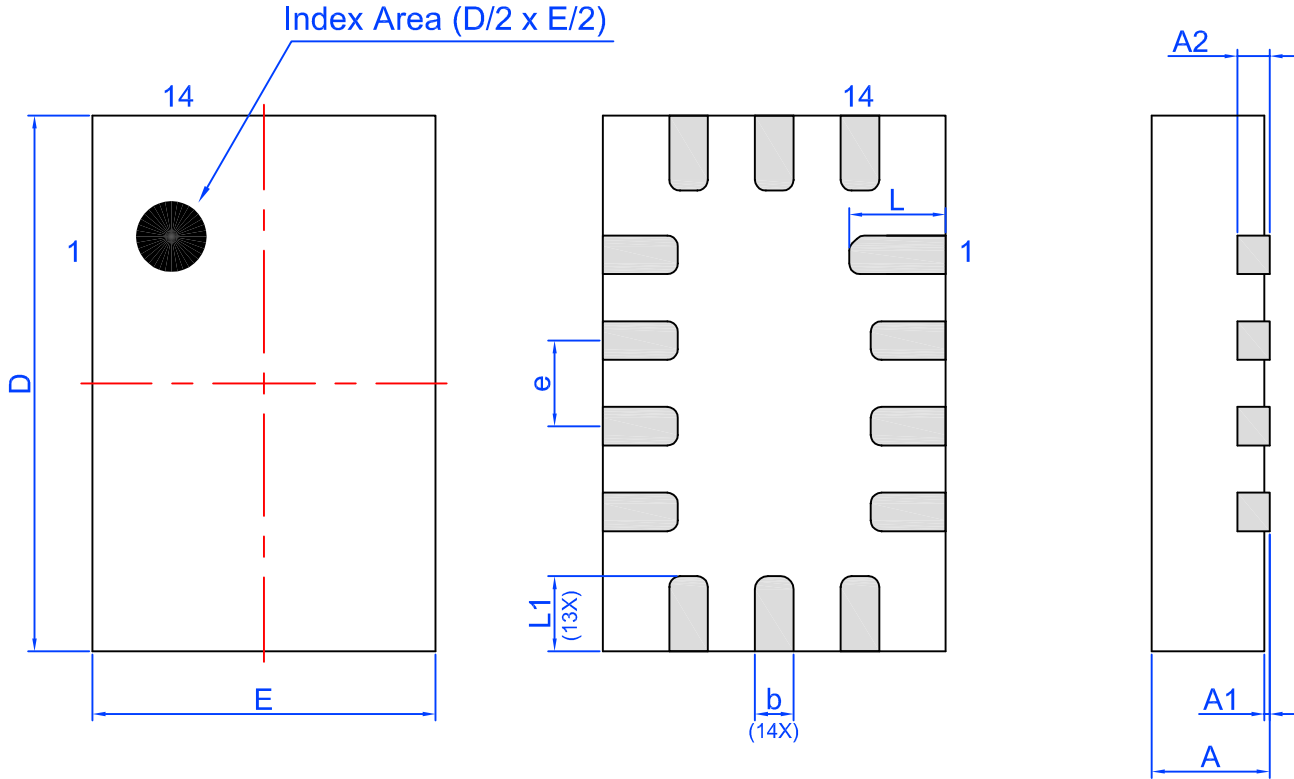
**20.0 Package Top Marking System Definition**





## 21.0 Package Drawing and Dimensions

14 Lead STQFN Package 1.6 x 2.5 mm  
 JEDEC MO-252  
 IC Net Weight: 0.059 g



Unit: mm

| Symbol | Min      | Nom. | Max   | Symbol | Min  | Nom. | Max  |
|--------|----------|------|-------|--------|------|------|------|
| A      | 0.50     | 0.55 | 0.60  | D      | 2.45 | 2.50 | 2.55 |
| A1     | 0.005    | -    | 0.050 | E      | 1.55 | 1.60 | 1.65 |
| A2     | 0.10     | 0.15 | 0.20  | L      | 0.40 | 0.45 | 0.50 |
| b      | 0.13     | 0.18 | 0.23  | L1     | 0.30 | 0.35 | 0.40 |
| e      | 0.40 BSC |      |       |        |      |      |      |

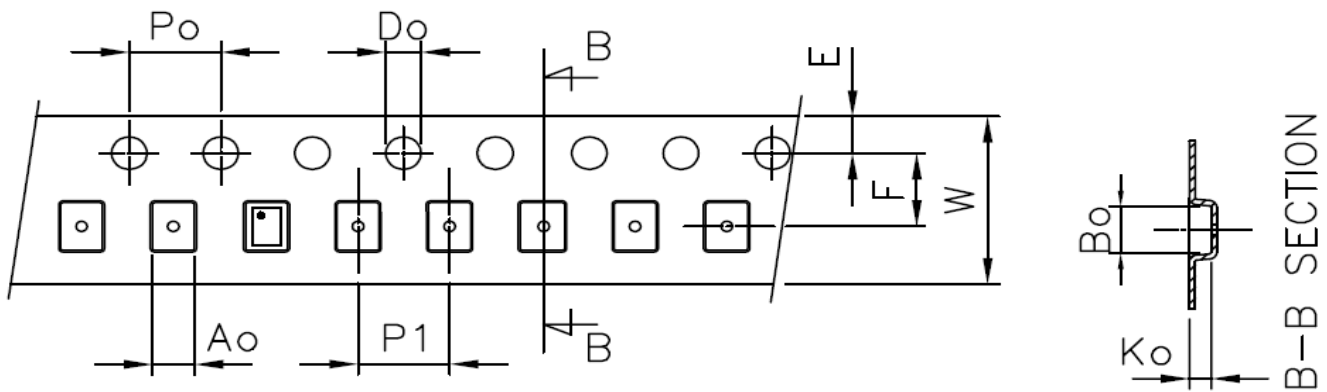


**22.0 Tape and Reel Specifications**

| Package Type                               | # of Pins | Nominal Package Size [mm] | Max Units |         | Reel & Hub Size [mm] | Leader (min) |             | Trailer (min) |             | Tape Width [mm] | Part Pitch [mm] |
|--|-----------|---------------------------|-----------|---------|----------------------|--------------|-------------|---------------|-------------|-----------------|-----------------|
|  |           |                           | per Reel  | per Box |                      | Pockets      | Length [mm] | Pockets       | Length [mm] |                 |                 |
| STQFN 14L<br>1.6x2.5mm<br>FC 0.4P<br>Green | 14        | 1.6x2.5x0.55              | 3000      | 3000    | 178/60               | 100          | 400         | 100           | 400         | 8               | 4               |

**23.0 Carrier Tape Drawing and Dimensions**

| Package Type                               | PocketBTM Length [mm] | PocketBTM Width [mm] | Pocket Depth [mm] | Index Hole Pitch [mm] | Pocket Pitch [mm] | Index Hole Diameter [mm] | Index Hole to Tape Edge [mm] | Index Hole to Pocket Center [mm] | Tape Width [mm] |
|--|-----------------------|----------------------|-------------------|-----------------------|-------------------|--------------------------|------------------------------|----------------------------------|-----------------|
|  | A0                    | B0                   | K0                | P0                    | P1                | D0                       | E                            | F                                | W               |
| STQFN 14L<br>1.6x2.5mm<br>FC 0.4P<br>Green | 1.8                   | 2.8                  | 0.7               | 4                     | 4                 | 1.55                     | 1.75                         | 3.5                              | 8               |

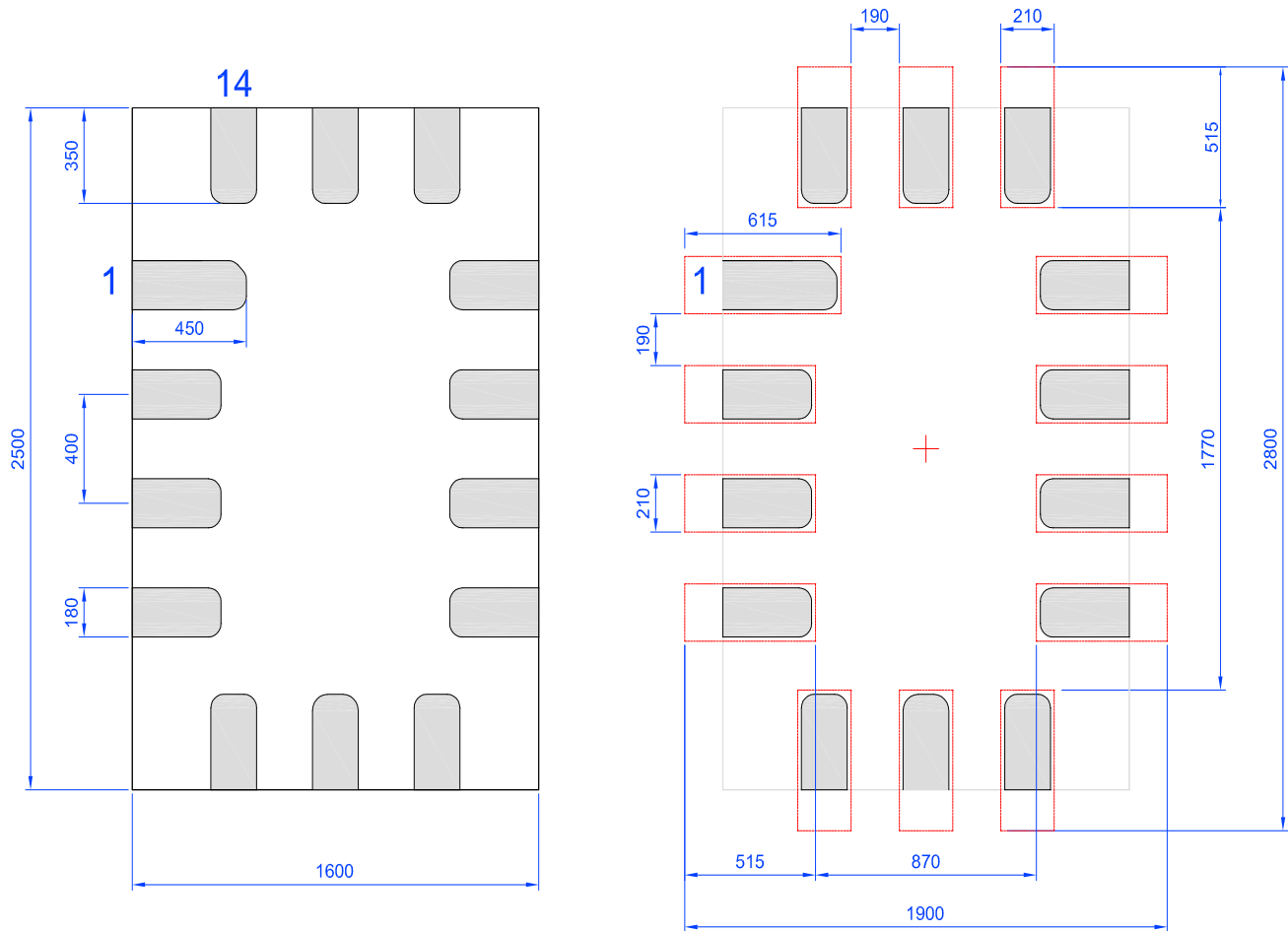




## 24.0 Recommended Landing Pattern

 Exposed Pad  
(PKG face down)

 Recommended Land Pattern  
(PKG face down)



Unit:  $\mu\text{m}$

## 25.0 Recommended Reflow Soldering Profile

Please see IPC/JEDEC J-STD-020: latest revision for reflow profile based on package volume of  $2.2 \text{ mm}^3$  (nominal). More information can be found at [www.jedec.org](http://www.jedec.org).



## 26.0 Revision History

| Date       | Version | Change   |
|------------|---------|--|
| 10/29/2019 | 1.10    | Updated last page with disclaimer and contacts<br>Added pre front page   |
| 10/10/2017 | 1.09    | Updated Electrical Spec<br>Fixed typos<br>Updated POR sequence   |
| 7/5/2017   | 1.08    | Updated Electrical Spec  |
| 6/21/2017  | 1.07    | Fixed typos<br>Updated Silego Website & Support<br>Updated Section Programmable Delay / Edge Detector<br>Updated Recommended Landing Pattern |
| 10/20/2016 | 1.06    | Fixed typos<br>Removed references to GPAK families   |
| 6/22/2016  | 1.05    | Updated P-FET section  |
| 5/27/2016  | 1.04    | Added $PON_{THR}$ and $POFF_{THR}$ in Electrical Spec<br>Updated Silego Website & Support<br>Updated Programmable Delay information          |
| 12/1/2015  | 1.03    | Corrected Appendix A   |
| 10/29/2015 | 1.02    | Updated text for clarity<br>Fixed typos<br>Updated Absolute maximum conditions   |
| 6/17/2015  | 1.01    | Increased to support 1.25 A  |
| 5/26/2016  | 1.0     | Production Release   |
| 5/21/2015  | 0.62    | Updated ACMP Diagrams and added Timing Characteristics Diagrams  |
| 4/28/2015  | 0.61    | Updated RC Oscillator section  |
| 4/24/2015  | 0.60    | Updated ACMP section   |
| 4/9/2015   | 0.59    | Updated Tsu condition and value  |
| 3/10/2015  | 0.58    | Added Connection Matrix Example  |
| 3/9/2015   | 0.57    | Added POR section  |
| 2/10/2015  | 0.56    | Updated General Description  |
| 1/14/2015  | 0.55    | Added IDD Estimator, Timing Estimator, Expected Delays sections  |
| 12/3/2014  | 0.54    | Updated Electrical Characteristics VIH/VIL/VOH/VOL values  |
| 10/14/2014 | 0.53    | Updated ACMP1 Block to remove PIN 4 as analog input  |
| 9/3/2014   | 0.52    | Updated Electrical Characteristics VIH/VIL/VOH/VOL values  |
| 7/29/2014  | 0.51    | Fixed Programming Pin Descriptions and Pin 8 name  |
| 7/23/2014  | 0.5     | Added ESD information<br>Preliminary Release   |
| 7/18/2014  | 0.25    | Added Soft-Start to describe P-FET   |
| 6/19/2014  | 0.24    | Added Load to P-FET Power Switch diagram   |
| 6/2/2014   | 0.23    | Updated P-FET Power Switch diagram   |
| 4/18/2014  | 0.22    | Updated P-FET Power Switch section   |
| 4/15/2014  | 0.21    | Added P-FET Power Switch section   |
| 4/7/2014   | 0.2     | Updated Pinout<br>Updated Diagrams<br>Updated Register Table<br>Added Tape and Reel Spec<br>Corrected typos and formatting for clarity       |
| 2/3/2014   | 0.1     | Initial release  |





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